

Module

FOR B-1 LEVEL CERTIFICATION

05

DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

Aviation Maintenance Technician Certification Series



- Electronic Instrument Systems
- Numbering Systems
- Data Conversion
- Data Buses
- Logic Circuits
- Basic Computer Structure
- Microprocessors
- Integrated Circuits

- Multiplexing
- Fiber Optics
- Electronic Displays
- Electrostatic Sensitive Devices
- Software Management Control
- Electromagnetic Environment
- Typical Electronic/Digital Aircraft Systems



MODULE 05

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Aviation Maintenance Technician Certification Series



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AVIATION MAINTENANCE TECHNICIAN CERTIFICATION SERIES

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We wish you good luck and success in your studies and in your aviation career!

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1	Mathematics	X	X	X	X	X
2	Physics	X	X	X	X	X
3	Electrical Fundamentals	X	X	X	X	X
4	Electronic Fundamentals		X	X	X	X
5	Digital Techniques / Electronic Instrument Systems	X	X	X	X	X
6	Materials and Hardware	X	X	X	X	X
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8	Basic Aerodynamics	X	X	X	X	X
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15	Gas Turbine Engine	X	X		X	
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FORWARD

PART-66 and the Acceptable Means of Compliance (AMC) and Guidance Material (GM) of the European Aviation Safety Agency (EASA) Regulation (EC) No. 1321/2014, Appendix 1 to the Implementing Rules establishes the Basic Knowledge Requirements for those seeking an aircraft maintenance license. The information in this Module (05) of the Aviation Maintenance Technical Certification Series published by the Aircraft Technical Book Company meets or exceeds the breadth and depth of knowledge subject matter referenced in Appendix 1 of the Implementing Rules. However, the order of the material presented is at the discretion of the editor in an effort to convey the required knowledge in the most sequential and comprehensible manner. Knowledge levels required for Category A1, B1, B2, and B3 aircraft maintenance licenses remain unchanged from those listed in Appendix 1 Basic Knowledge Requirements. Tables from Appendix 1 Basic Knowledge Requirements are reproduced at the beginning of each module in the series and again at the beginning of each Sub-Module.

How numbers are written in this book:

This book uses the International Civil Aviation Organization (ICAO) standard of writing numbers. This method displays large numbers by adding a space between each group of 3 digits. This is opposed to the American method which uses commas and the European method which uses periods. For example, the number one million is expressed as so:

ICAO Standard	1 000 000
European Standard	1.000.000
American Standard	1,000,000

SI Units:

The International System of Units (SI) developed and maintained by the General Conference of Weights and Measures (CGPM) shall be used as the standard system of units of measurement for all aspects of international civil aviation air and ground operations.

Prefixes:

The prefixes and symbols listed in the table below shall be used to form names and symbols of the decimal multiples and submultiples of International System of Units (SI) units.

MULTIPLICATION FACTOR	PREFIX	SYMBOL
1 000 000 000 000 000 000 = 10^{18}	exa	E
1 000 000 000 000 000 = 10^{15}	peta	P
1 000 000 000 000 = 10^{12}	tera	T
1 000 000 000 = 10^9	giga	G
1 000 000 = 10^6	mega	M
1 000 = 10^3	kilo	k
100 = 10^2	hecto	h
10 = 10^1	deca	da
0.1 = 10^{-1}	deci	d
0.01 = 10^{-2}	centi	c
0.001 = 10^{-3}	milli	m
0.000 001 = 10^{-6}	micro	μ
0.000 000 001 = 10^{-9}	nano	n
0.000 000 000 001 = 10^{-12}	pico	p
0.000 000 000 000 001 = 10^{-15}	femto	f
0.000 000 000 000 000 001 = 10^{-18}	atto	a

International System of Units (SI) Prefixes

Today's aircraft increasingly rely on digital technology and complex electronic systems, not just for instrumentation, navigation, and communications, but today even for flight controls, system monitoring, maintenance planning, and more and more. Fiber optics and fly-by-wire is no longer the exception, but the rule. It is no longer limited to military, but now the basis of private and commercial aircraft both large and small. This module presents the B1 or A&P mechanical technician with what he or she needs to know for both a general understanding of these systems and the ability to work around them in an efficient and safe manner. An advanced version of this book, Module 05 B2 is also available from Aircraft Technical Book Company which covers these topics to the greater depth required for the B2 or SpaceTEC/CertTEC rated avionics and electronics specialist.

Module 05 Syllabus as outlined in PART-66, Appendix 1.

CERTIFICATION CATEGORY →	LEVELS	
	A	B1
Sub-Module 01 - Electronic Instrument Systems Typical systems arrangements and cockpit layout of electronic instrument systems	1	2
Sub-Module 02 - Numbering Systems Numbering systems: binary, octal and hexadecimal; Demonstration of conversions between the decimal and binary, octal and hexadecimal systems and vice versa.	-	1
Sub-Module 03 - Data Conversion Analog Data, Digital Data; Operation and application of analog to digital, and digital to analogue converters, inputs and outputs, limitations of various types.	-	1
Sub-Module 04 - Data Buses Operation of data buses in aircraft systems, including knowledge of ARINC and other specifications. Aircraft Network / Ethernet.	-	2
Sub-Module 05 - Logic Circuits (a) Identification of common logic gate symbols, tables and equivalent circuits; Applications used for aircraft systems, schematic diagrams. (b) Interpretation of logic diagrams.	- -	2 -
Sub-Module 06 - Basic Computer Structure (a) Computer terminology (including bit, byte, software, hardware, CPU, IC, and various memory devices such as RAM, ROM, PROM); Computer technology (as applied in aircraft systems).	1	2

CERTIFICATION CATEGORY →

LEVELS

	A	B1
<p>(b) Computer related terminology; Operation, layout and interface of the major components in a micro computer including their associated bus systems; Information contained in single and multiaddress instruction words; Memory associated terms; Operation of typical memory devices; Operation, advantages and disadvantages of the various data storage systems.</p>	-	-
<p>Sub-Module 07 - Microprocessors Functions performed and overall operation of a microprocessor; Basic operation of each of the following microprocessor elements: control and processing unit, clock, register, arithmetic logic unit.</p>	-	-
<p>Sub-Module 08 - Integrated Circuits Operation and use of encoders and decoders; Function of encoder types; Uses of medium, large and very large scale integration.</p>	-	-
<p>Sub-Module 09 - Multiplexing Operation, application and identification in logic diagrams of multiplexers and demultiplexers.</p>	-	-
<p>Sub-Module 10 - Fiber Optics Advantages and disadvantages of fiber optic data transmission over electrical wire propagation; Fiber optic data bus; Fiber optic related terms; Terminations; Couplers, control terminals, remote terminals; Application of fiber optics in aircraft systems.</p>	-	1
<p>Sub-Module 11 - Electronic Displays Principles of operation of common types of displays used in modern aircraft, including Cathode Ray Tubes, Light Emitting Diodes and Liquid Crystal Display.</p>	-	2
<p>Sub-Module 12 - Electrostatic Sensitive Devices Special handling of components sensitive to electrostatic discharges; Awareness of risks and possible damage, component and personnel anti-static protection devices.</p>	1	2
<p>Sub-Module 13 - Software Management Control Awareness of restrictions, airworthiness requirements and possible catastrophic effects of unapproved changes to software programmes.</p>	-	2

CERTIFICATION CATEGORY →	LEVELS	
	A	B1
Sub-Module 14 - Electromagnetic Environment Influence of the following phenomena on maintenance practices for electronic system: EMC-Electromagnetic Compatibility EMI-Electromagnetic Interference HIRF-High Intensity Radiated Field Lightning/lightning protection	-	2
Sub-Module 15 - Typical Electronic/Digital Aircraft Systems General arrangement of typical electronic/digital aircraft systems and associated BITE (Built In Test Equipment) such as: For B1 and B2 only: ACARS-Aircraft Communication and Addressing and Reporting System EICAS-Engine Indication and Crew Alerting System FBW-Fly by Wire FMS-Flight Management System IRS-Inertial Reference System For B1, B2 and B3: ECAM-Electronic Centralised Aircraft Monitoring EFIS-Electronic Flight Instrument System GPS-Global Positioning System TCAS-Traffic Alert Collision Avoidance System Integrated Modular Avionics Cabin Systems Information Systems	-	2

REVISION LOG

VERSION	ISSUE DATE	DESCRIPTION OF CHANGE	MODIFICATION DATE
001	2015 10	Module Creation and Release	
002	2016 01	Module Revisions and Release	2016.01.01

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DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

ELECTRONIC INSTRUMENT SYSTEMS

SUB-MODULE 01

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A **B1**

Sub-Module 01

ELECTRONIC INSTRUMENT SYSTEMS

Knowledge Requirements

5.1 - Electronic Instrument Systems

Typical systems arrangements and cockpit layout of electronic instrument systems.

1

2

Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

ELECTRONIC INSTRUMENT SYSTEMS

ANALOG INSTRUMENTS

Instruments that aid the pilot in controlling the altitude, attitude, airspeed and heading of the aircraft are known as flight instruments. Since the early days of flight there have been four basic flight instruments that have formed the well-known "T" arrangement located in the center of the instrument panel, as shown in *Figure 1-1*. These four basic instruments are 1) the airspeed indicator, located on the top left, that measures the aircraft's speed in nautical miles per hour; 2) the attitude indicator, located on top center, that shows the aircraft's attitude relative to the earth's horizon; 3) the altimeter, on the top right, that displays the barometric altitude as measured in feet; and 4) the gyro-slaved heading indicator, in the bottom center, which shows which direction the aircraft is flying. These 4 basic flight instruments are typically augmented with a turn-and-bank indicator that displays the rate of turn in the roll axis and amount of bank in the yaw axis, and a vertical speed indicator that displays the rate of ascent or descent in feet per minute.

Assuming that the aircraft has radio navigation aids, it will also come equipped with a Radio Magnetic Indicator (RMI) coupled to an Automatic Direction Finder (ADF), and a Course Deviation Indicator (CDI) driven by VHF Omnidirectional Range (VOR) and Instrument Landing System (ILS) receivers. The ILS receiver drives the glide scope needle to set the glide path on an instrument approach and localizer needle provides lateral guidance to the center of the runway. A VHF Marker Beacon may be used in conjunction with the ILS to indicate position along the approach to the runway.



Figure 1-1. Basic Analog Cockpit Flight Instruments.

These early flight instruments were analog meaning that they contained either mechanical or electro-mechanical rotating mechanisms to drive the pointer dials on the instruments. For example, an analog airspeed indicator receives air pressure from the pitot tube, which expands a bellows that turns the dial on the indicator. With a digital system, the pitot air pressure enters an air data computer that converts the analog information into a digital data stream. Digital data is then sent to the airspeed indicator via an aircraft data bus where the data is converted back into analog signals to drive a pointer dial and/or is displayed digitally in numbers.

DIGITAL INSTRUMENTS

With the advent of digital electronics in the early 1970's, Electronic Instrument Systems, also known as "glass cockpits", evolved that were more much more reliable than mechanical or electro-mechanical analog instruments, and had the advantage of combining several flight and navigation functions into one display to provide the crew with greater situational awareness.

The first commercial transport aircraft to employ an Electronic Instrument System (EIS) was the McDonnell Douglas MD-80 in 1979. The EIS on the MD-80 used Cathode Ray Tube (CRT) technology. However, during the next 10 years, Liquid Crystal Display (LCD) technology matured thereby replacing CRTs. Flat-panel LCDs are lighter than CRT displays, require less volume, and consume less electrical power, thereby generating less cockpit heat. Glass cockpit configurations vary widely between aircraft models from a single flight and navigation display in a small private aircraft to five or more LCD displays in a commercial transport aircraft. (*Figure 1-2*)



Figure 1-2. Airbus A380 EIS with 8 Large LCD Displays.

ELECTRONIC DISPLAYS

The early EIS displays mimicked the analog display formats for ease in pilot training as the crew transitioned from older analog displays to digital displays that were driven by aircraft data computers, known as display processors or symbol generators.

Figure 1-3 depicts an early model Boeing 737 instrument panel with an analog Attitude Direction Indicator (ADI) and analog Horizontal Situation Display (HSI) in the left picture, and a later model B737 instrument panel with electronic ADI (EADI) and electronic HSI (EHSI) displays shown in the right picture.

The ADI or EADI is an artificial horizon with lateral bars superimposed to display computer-generated pitch, roll and bank steering commands from the Flight Director computer. The HSI or EHSI is similar to a heading indicator, except that it combines navigation commands from the VHF Omni-Range (VOR) or Global Positioning System (GPS) receivers, which are used for en-route guidance, or from the Instrument Landing System (ILS), which is used for terminal guidance. Besides heading, the HSI/EHSI also provides actual track, desired track, track angle error, drift angle, cross-track deviation, and distance to destination information, from the Distance Measuring Equipment (DME) or Inertial Navigation System (INS). (*Figure 1-4*)

The pilot and the co-pilot not only have independent EADI and EHSI displays, but they also have independent Display Processor Units, also known as Symbol Generators, to drive their displays (*Figure 1-5*).

Display formats are produced by the Symbol Generators that receive inputs from the crew and various on-board systems.

The Flight Director Systems, Navigation Systems, Air Data Systems, and Weather Radar provide inputs to the Symbol Generators, along with commands from the each crewmember's display control panel. The Symbol Generators produce the graphics for the EADI, EHSI, and an optional Multi-Function Display (MFD) that is mounted in the center instrument panel. The MFD, which is physically identical to the EADI and EHSI, is typically used to display weather radar information; however, it can also be used to display either flight information or navigational information in the event of an EADI or EHSI failure. The following section will discuss the Boeing 777 EIS, which is a more advanced example of the one just covered.

ELECTRONIC FLIGHT INSTRUMENT SYSTEM

The Boeing 777, which first entered service in 1995, has six 8' x 8" multi-color LCD displays as shown in *Figure 1-6*. The B777 EIS consists of a dual-redundant Electronic Flight Instrument Systems (EFIS) and Engine Indication and Crew Alerting System (EICAS).

On the left side of the instrument panel is the Captain's EFIS, consisting of a Primary Flight Display (PFD) located outboard and a Navigation Display (ND) located inboard. The Co-Pilot's EFIS located on the right instrument panel has an identical PFD and ND, located outboard and inboard respectively. All the displays are interchangeable to reduce the number of required spares.



Figure 1-3. Equivalent Electromechanical Flight and Navigation Instruments on the left.

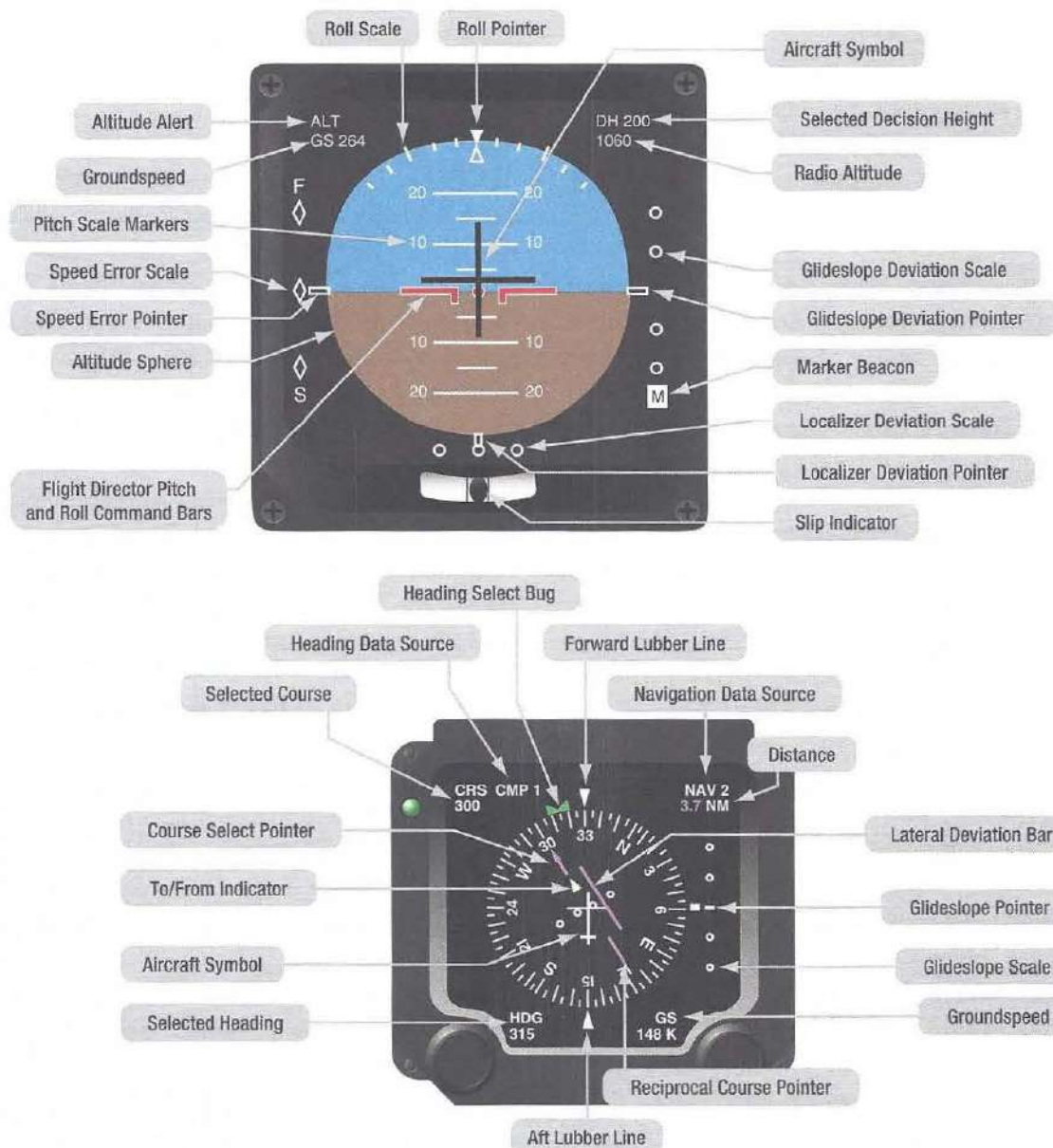


Figure 1-4. Typical EADI (top) and EHSI (bottom) Display Symbology.

The information shown on each display, whether for flight or navigation, is determined by what each crew member selects on their individual display control panels.

The PFD takes the place of the EADI and displays all the information critical to flight, including attitude, airspeed, barometric altitude, vertical speed, heading, flight modes, radio altitude, ILS data, and Traffic Alert and Collision Avoidance System (TCAS) resolution advisory. The PFDs are designed to increase the crew's situational awareness by integrating all of this information into a single composite display instead of the crew having to monitor several independent analog instruments. Also, the colors on the display change to

alert the crew to potentially hazardous flight conditions, such as low airspeed, high rate of descent, etc.

Figure 1-7 is a typical Primary Flight Display format showing the artificial horizon in the center of the display, airspeed on the left side, altitude on the right side, heading on the bottom, and flight modes on the top of the display. Notice how the moving ladder format used for altitude and airspeed provide both absolute and relative information so the crew knows not only the exact numeric value, but also the rate that the altitude and airspeed is changing.

The Navigation Display, shown in *Figure 1-8*, takes the place of the EHSI display to show the requisite

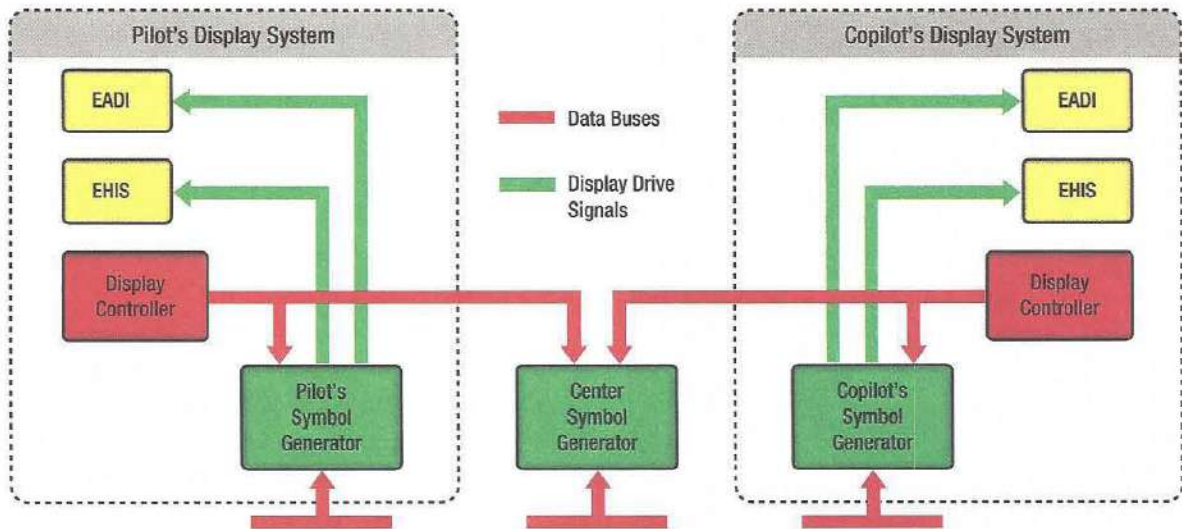


Figure 1-5. Electronic Displays are driven by Symbol Generators.

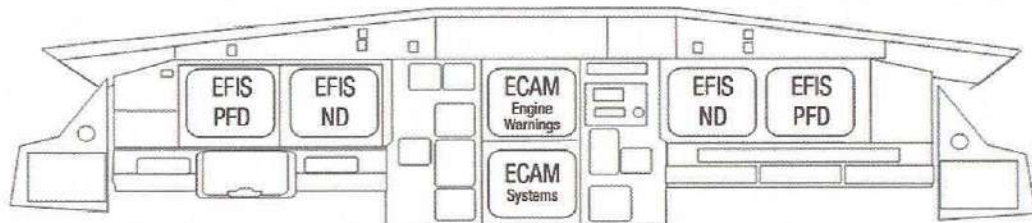
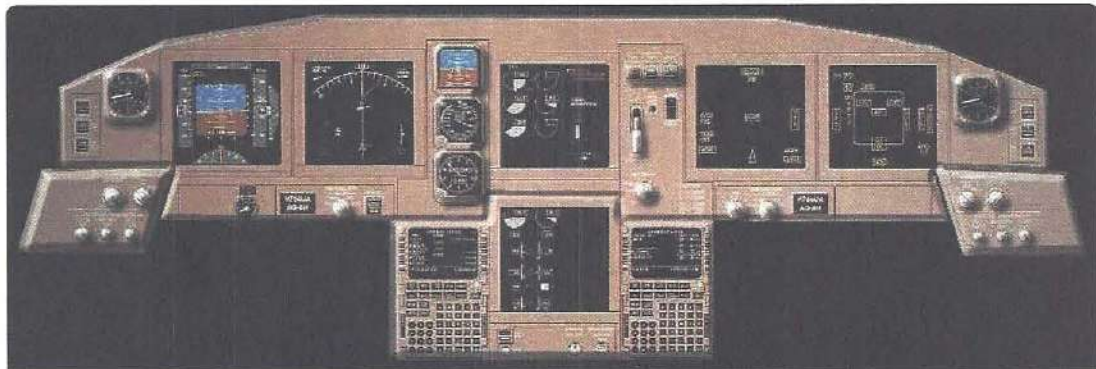


Figure 1-6. Boeing 777 Electronic Instrument System has 6 LCD Displays.

information to navigate the aircraft, including heading, VOR, GPS, and ILS guidance. The ND has the ability to overlay additional information on the navigation page to eliminate the need for separate dedicated displays. Some examples of information that is typically overlaid on the ND include weather information from either the onboard weather radar (WXR) or ground based sensors, and digital maps showing pre-programmed routes and waypoints from the Flight Management System.

ENGINE INDICATION AND CREW ALERTING SYSTEM

The Boeing Engine Indication and Crew Alerting System (EICAS), also called an Electronic Centralized

Aircraft Monitor (ECAM) on Airbus aircraft, performs the monitoring of aircraft systems that was previously performed by the Flight Engineer in three crew member cockpits. As previously shown in *Figure 1-6*, the two EICAS displays on the B777 are located in the center instrument panel. The upper EICAS display shows engine performance data, such as pressure ratio, N1 rotor speed, exhaust gas temperature, total air temperature, thrust mode, etc., in addition to cabin pressure, flat/slat position, landing gear position, and crew status alerts. (*Figure 1-9*)

The EICAS engine display format mimics the round analog instruments, while also providing digital

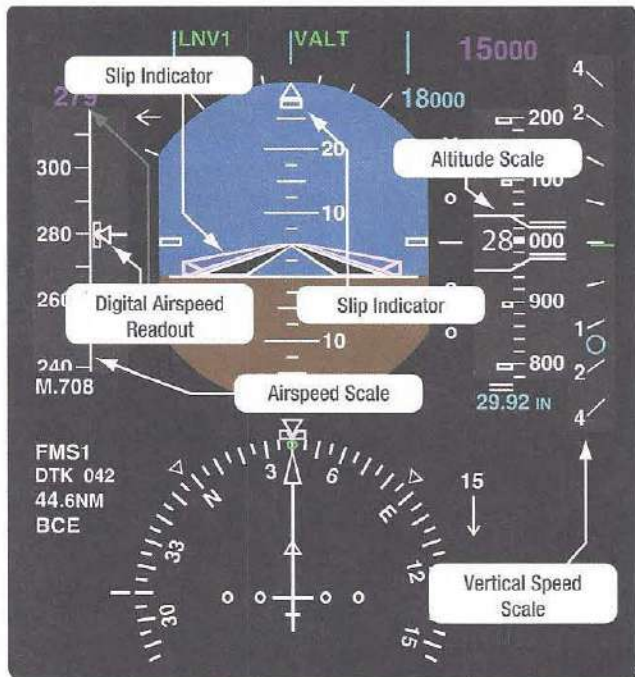


Figure 1-7. Primary flight display format.

readouts of the parameters. EICAS improves situational awareness by allowing the crew to see systems operation in graphical format and alerting them to any failures or impending failures. For example, if low oil pressure is detected, the EICAS will provide an aural alert and show to the oil pressure page on a lower display with a red box outlining which engine has low oil pressure.

The Airbus ECAM system provides the crew with the following levels of warning along with detailed messages as to the nature of the problem and suggested courses of action.

- Level 3: An overspeed, fire, or stall condition will cause a repetitive chime aural warning with a bright red flashing light.
- Level 2: A system failure, but not a safety of flight issue, will result in a single chime aural warning and a steady amber light.
- Level 1: Failure leading to system degradation results only in an amber light.
- Mode or System Status: If everything is normal, a green light will illuminate.

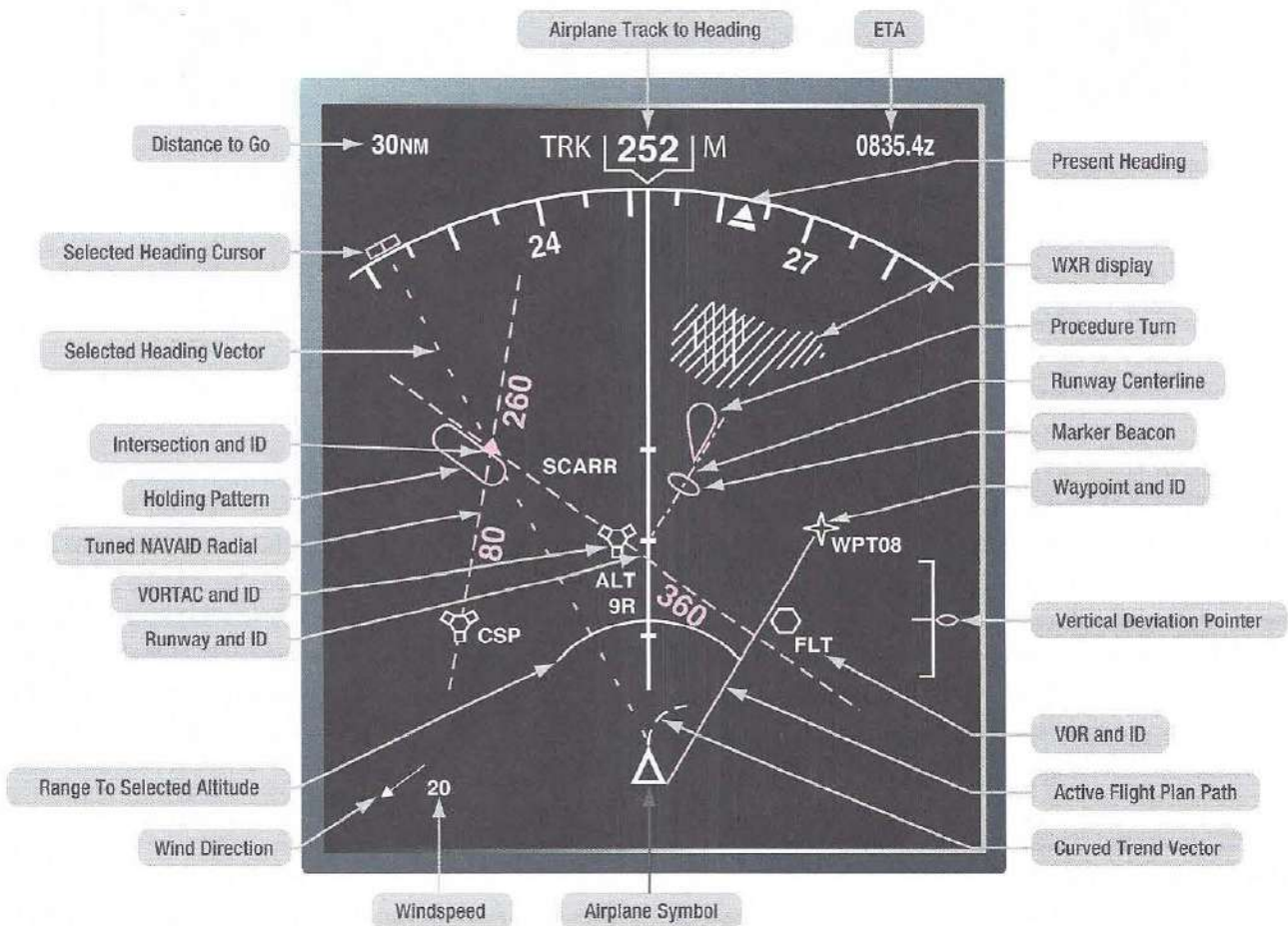


Figure 1-8. Navigation map display format.

The lower EICAS display is called a Multi-Function Display because it provides auxiliary information to the flight crew and maintenance crew. The MFD can be used as a secondary engine display, status display, communications display, maintenance page, or electronic checklist. The MFD formats also include synoptic displays that provide system status diagrams for the fuel, electrical, hydraulic, flight control, and environmental control systems, in addition to showing door and landing gear positions. On some aircraft, the MFD is also used to display images from the ground maneuvering camera system.

Figure 1-10 is a schematic diagram of an Engine Indication and Crew Alerting System with all its associated components. The display select panel allows the crew to choose which computer is actively supplying information. It also controls the display of secondary engine information and system status displays on the lower monitor.



Figure 1-9. EICAS engine display format.

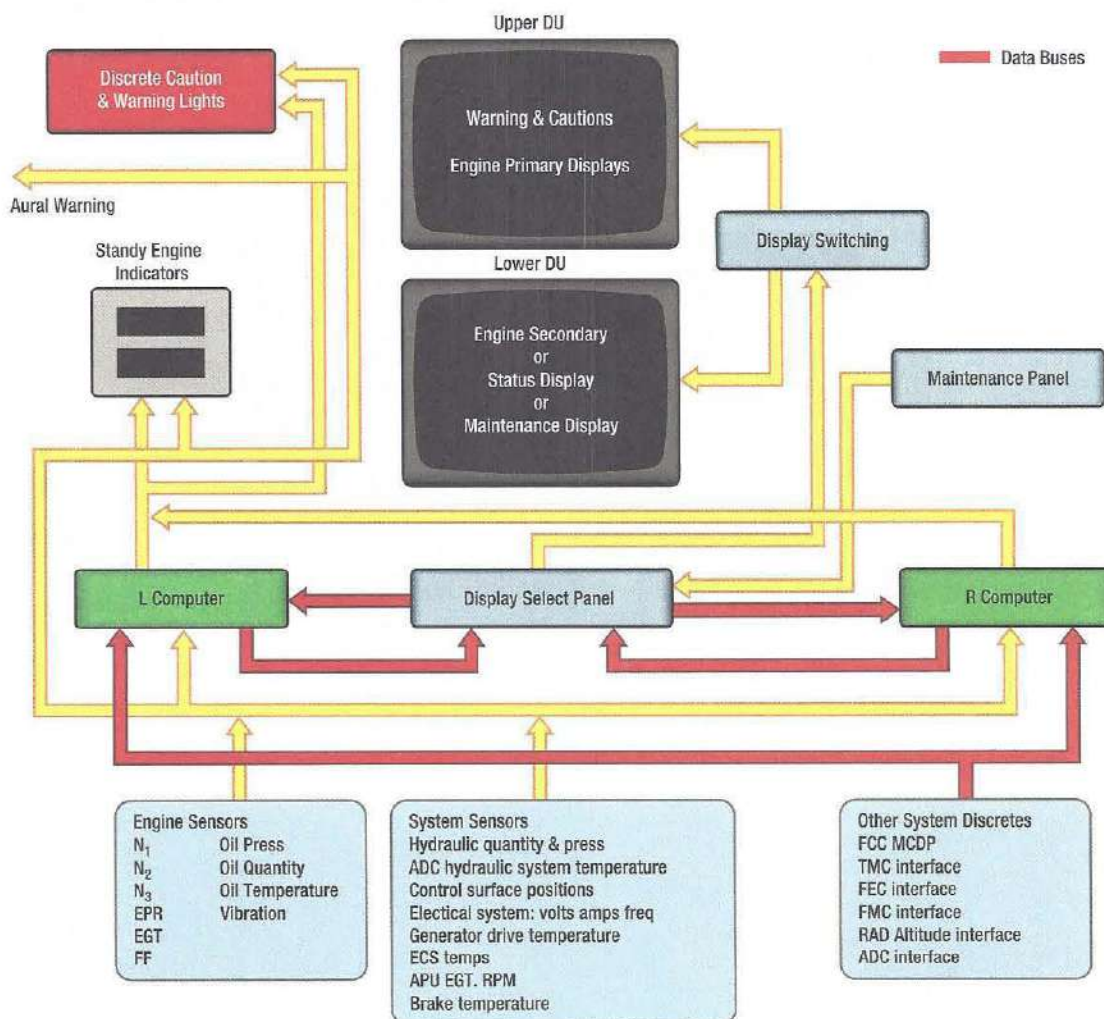


Figure 1-10. EICAS schematic diagram.

EICAS has a unique feature that automatically records the parameters of a failure event to be regarded afterwards by maintenance personnel. Pilots that suspect a problem may be occurring during flight can press the event record button on the display select panel. This also records the parameters for that flight period to be studied later by maintenance. Hydraulic, electrical, environmental, performance, and Auxiliary Power Unit (APU) data are examples of what may be recorded. EICAS uses Built-In-Test Equipment (BITE) for systems and components.

This *sub-module* contained an overview of a state-of-the-art aircraft cockpit with its Electronic Instrument System. The following chapters will discuss how digital data streams are formed and processed by aircraft computers and then sent over digital data buses to cockpit displays to provide essential information for the flight crew and maintenance crew.

A maintenance control panel is included for technicians. When the aircraft is on the ground, push-button switches display information pertinent to various systems for analysis. (Figure 1-11)

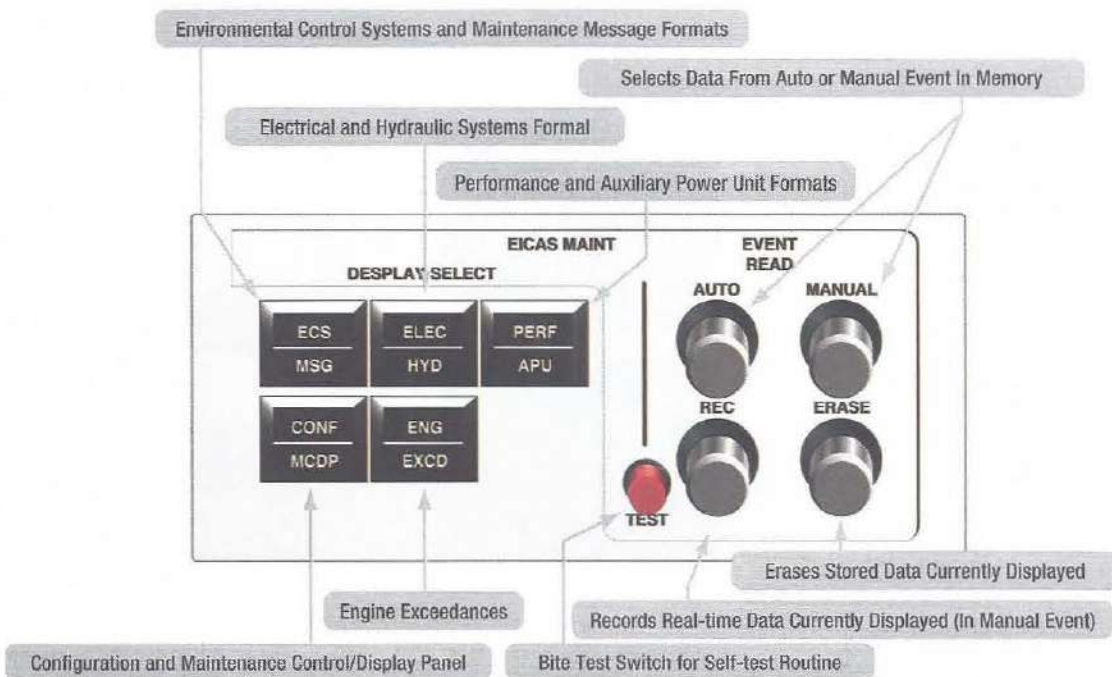


Figure 1-11. EICAS maintenance control panel.

Question: 1-1

What are the differences between analog and digital instruments?

Question: 1-5

What information does a Primary Flight Display (PFD) provide?

Question: 1-2

What are the advantages of Liquid Crystal Displays (LCD) over Cathode Ray Tube (CRT) instruments used in "Glass Cockpits"?

Question: 1-6

What type of information is typically overlaid on the Navigation Display (ND)?

Question: 1-3

What types of information does an Electronic Attitude Direction Indicator (EADI) and an Electronic Horizontal Situation Indicator (EHSI) provide to the flight crew?

Question: 1-7

How information does the Engine Indication and Crew Alerting System (EICAS) provide to improve crew situational awareness?

Question: 1-4

What is the purpose of the Multi-Function Display (MFD)?

Question: 1-8

What occurs when the flight crew pushes the "event" button on the EICAS Display Select Panel?

ANSWERS

Answer: 1-1

Analog instruments are typically mechanical or electro-mechanical devices, whereas digital instruments are driven by a digital data stream sent from a computer, called a Display Processor Unit or a Symbol Generator

Answer: 1-2

Flat-panel LCDs are lighter than CRT displays, require less volume, and require less electrical power, thereby generating less cockpit heat.

Answer: 1-3

The EADI is an artificial horizon with lateral bars superimposed to display computer-generated pitch and bank steering commands from the Flight Director computer. The EHSI is similar to a heading indicator, except that it combines navigation commands from the VHF Omni-Range (VOR) or Global Positioning System (GPS) receivers which are used for en-route guidance, or from the Instrument Landing System (ILS), which is used for terminal guidance.

Answer: 1-4

The MFD is typically used to display weather radar information; however, it can also be used to display either flight information or navigational information in the event of an EADI or EHSI failure. In addition, the MFD can be used as a secondary engine display, status display, communications display, maintenance page, or electronic checklist. The MFD formats also include synoptic displays that provide system status diagrams for the fuel, electrical, hydraulic, flight control, and environmental control systems, in addition to showing door and landing gear positions

Answer: 1-5

The PFD takes the place of the EADI and displays all the information critical to flight, including attitude, airspeed, barometric altitude, vertical speed, heading, flight modes, radio altitude, ILS data, and Traffic Alert and Collision Avoidance System (TCAS) resolution advisory.

Answer: 1-6

Some examples of information that is typically overlaid on the ND include weather information from either the onboard weather radar or ground based sensors, and digital maps showing pre-programmed routes and waypoints from the Flight Management System.

Answer: 1-7

The EICAS display shows engine performance data, such as pressure ratio, N1 rotor speed, exhaust gas temperature, total air temperature, thrust mode, etc., in addition to cabin pressure, flap/slat position, landing gear position, and crew status alerts. EICAS improves situational awareness by allowing the crew to see systems operation in graphical format and alerting them to any failures or impending failures.

Answer: 1-8

Pushing the event button records the parameters for that flight period to be studied later by maintenance. Hydraulic, electrical, environmental, performance, and Auxiliary Power Unit (APU) data are examples of what may be recorded.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

NUMBERING SYSTEMS

SUB-MODULE 02

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A **B1**

Sub-Module 02 NUMBERING SYSTEMS Knowledge Requirements

5.2 - Numbering Systems

Numbering systems: binary, octal and hexadecimal; Demonstration of conversions between the decimal and binary, octal and hexadecimal systems and vice versa.

-

1

Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

NUMBERING SYSTEMS

DECIMAL

Numbers are used to describe the quantity of something. A numbering system is a written system for expressing numbers as symbols. All numbering systems have bases to understand how the numbering system works. For example, the symbol "10" could mean "ten" in decimal form (base-10) or it could mean "two" in binary form (base-2). To differentiate between them, express a decimal as $10_{\text{base}10}$ or 10_{10} .

The most common numbering system that is used in everyday life is the decimal system. The prefix in the word "decimal" is a Latin root for the word "ten". Thus, the decimal system uses ten different symbols (0, 1, 2, 3, 4, 5, 6, 7, 8, and 9) and is referred to as a base-10 numbering system. To represent a number higher than 9, go to the next digit placement, such that 10 means zero units of one and one unit of ten. At the last symbol, a new placement is created to the left and counted up, so that 100 appears after 99, and so on. Each additional placement is an additional power of 10. Knowing this will help in understanding the other bases.

BINARY

The binary number system has only two symbols: 0 and 1. The prefix in the word "binary" is a Latin root for the word "two", and as such, is referred to as a base-2 numbering system. The use of the binary numbering system is based on the fact that switches or valves have two states: OPEN or CLOSED (ON or OFF).

Primary uses of the binary number system include computer architecture and digital electronics. In computers, information is stored as a series of 0's and 1's, forming strings of binary numbers known as machine language. Similarly, the binary number system is used in digital electronics because the two basic conditions of electricity, ON and OFF, can represent the two digits of the binary number system. When a switch is ON, it represents the digit 1, and when it is OFF, it represents the digit 0.

Millions and even billions of tiny switches are arranged so that digital devices can perform the functions they do with a binary number system. It is easy to recognize a binary number when written because it only uses 1's and 0's. To ensure it is not mistaken for another number system expression, a binary number system numeral may be written with a prefix or suffix that indicates it is binary. Binary number system identifiers are shown in the following example. There are others. The value of all of the binary numbers shown in this example is the same (11 in the decimal number system).

1011_2 $1011_{\text{base}2}$ bin 1011 0b1011 1011b

When reading or pronouncing a binary number, it is common to simply say "1" or "0" moving from left to right until all the digits are pronounced.

To read 1011_2 , say: "one, zero, one, one"

PLACE VALUES

As stated previously, the decimal number system used in everyday life is a base-10 system. There are 10 symbols available for use as place value holders; 0, 1, 2, 3, 4, 5, 6, 7, 8, and 9. When positioned in a number, they are also positioned to represent a place value. If 9 is exceeded, the place value resets to 0 and a 1 must be placed in the next place value column to the left. *Figure 2-1* illustrates the decimal number system place values. They are derived by sequentially raising 10 to a higher power moving from right to left. Thus, each position has a value 10 times that of the position to its right.

The binary number system is a base-2 system. There are 2 digits available for use as place value holders; 0 and 1. Each place value in the binary number system represents 2 raised to a sequentially higher power from right to left. This is similar to the decimal system used in everyday life.

Figure 2-2 illustrates the place values of the binary number system. It shows to what power 2 is raised to establish value and the decimal number system equivalent of each place. Each place value position

DECIMAL PLACE VALUE CHART

10^7 = 10 000 000	10^6 = 1 000 000	10^5 = 100 000	10^4 = 10 000	10^3 = 1 000	10^2 = 100	10^1 = 10	10^0 = 1
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Figure 2-1. Place values of the decimal number system.

BINARY PLACE VALUE CHART

2^7 = 128	2^6 = 64	2^5 = 32	2^4 = 16	2^3 = 8	2^2 = 4	2^1 = 2	2^0 = 1
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Figure 2-2. Derivation of the place values of the binary number system.

has a value 2 times that of the position to its right. Remember, when writing binary numbers and placing digits in positions of place value, the only digits available are 0 and 1. To exceed 1, the place value is reset to 0 and a 1 is placed in the next place value column to the left. Place values are used to convert our everyday decimal numbers to binary numbers.

Figure 2-3 illustrates how binary numbers are formed by placing a 1 or a 0 in the binary place value positions. Binary digits are called "bits". The Least Significant Bit (LSB) on the far right of the binary place value position table is 2^0 , which equals 1. In this last column, alternate every other time going down the column inserting 1s and 0s. Likewise, the next LSB is 2^1 , or 2, which means alternate every 2 times down the column inserting 1s and 0s, and so forth.

Likewise, at the Most Significant Bit (MSB) on the far left side of the binary place value position table, alternate 2^3 or every 8 times between 1s and 0s to form the binary equivalent of the decimal number shown in the far left column.

BINARY PLACE VALUE POSITIONS				
DECIMAL	8	4	2	1
0	0	0	0	0
1	0	0	0	1
2	0	0	1	0
3	0	0	1	1
4	0	1	0	0
5	0	1	0	1
6	0	1	1	0
7	0	1	1	1
8	1	0	0	0
9	1	0	0	1
10	1	0	1	0
11	1	0	1	1
12	1	1	0	0
13	1	1	0	1
14	1	1	1	0
15	1	1	1	1

Figure 2-3. Binary value place positions.

BINARY NUMBER SYSTEM CONVERSION

Each binary number column has a decimal value. To convert from decimal to binary, find the binary column that has the largest value but is equal to or smaller than the decimal number being converted. Place a 1 in that column and subtract the column value from the decimal number being converted. Look at the difference. Place a 1 in the column that has the largest value but is equal to or smaller than the decimal number difference of what was just subtracted. Now subtract this column value from the difference of the decimal number being converted and the previous column difference. If a column is not used, place a zero in it. Continue this operation until all of the binary place value columns with 1's, when added together, have the same value as the decimal number being converted. Write the number in binary form including a 1 or a 0 for each column.

Example: Convert the decimal number 100_{10} to a binary number. Use the binary place value chart in *Figure 2-4* to assist in remembering the decimal equivalent value for each binary place value holder. The largest decimal number system value in a binary number system place holder that is less than or equal to 100 is 64. Thus, a 1 is placed in the 64 column (2^6) of the binary place value chart. Subtract 64 from 100 for a difference of 36.

The binary place value holder that is less than or equal to 36 is 32. Place a 1 in the 32 column (2^5) of the binary place value chart. Subtract 32 from 36 for a difference of 4. The binary place value holder that is less than or equal to 4 is 4. Place a 1 in the 4 column (2^2) of the binary place value chart. Subtract 4 from 4 for a difference of 0. Since there is nothing left to be converted, place a 0 in all place value columns that do not contain a 1. Write the number using all the 1's and 0's recorded in the chart from right to left: $1100100_2 = 100_{10}$

DECIMAL NUMBER	2^7 = 128	2^6 = 64	2^5 = 32	2^4 = 16	2^3 = 8	2^2 = 4	2^1 = 2	2^0 = 1
1								1
2							1	0
3							1	1
5						1	0	1
8					1	0	0	0
20				1	0	1	0	0
35			1	0	0	0	1	1
96		1	1	0	0	0	0	0
100		1	1	0	0	1	0	0
200	1	1	0	0	1	0	0	0
255	1	1	1	1	1	1	1	1

Figure 2-4. Use of binary number system place values to write various decimal numbers in binary (base₂).

To convert a binary number to a decimal number, simply add the column values of the binary place holders with a 1.

Example: Convert the binary number 10010111 to a decimal number. From left to right, the base-2 values represent by each 1 in this binary number are added together:

$$128 + 16 + 4 + 2 + 1 = 10010111_2 = 151_{10}$$

As can be seen, a binary number is typically much longer than its decimal equivalent. However, modern circuits have very fast switching speeds so that the length of binary numbers can be tolerated. This is especially true because of the reliability that is gained from a system that is built from components that are either 1 (ON) or 0 (OFF), that is, either have voltage or do not have voltage.

OCTAL

The binary numbering system requires many bits to represent relatively small numbers. In the preceding example, it required 8 binary bits (10010111) to represent a 3-digit decimal (151). As such, analyzing the numerical states of digital logic using the binary numbering system can become quite tedious for computer programmers developing machine language code. For this reason, place-weighted numbering systems, such as octal, were

developed. The prefix in the word "octal" is a Latin root for the word "eight", and as such, it is referred to as a base-8 numbering system.

Octal has 8 symbols available as place value holders (0, 1, 2, 3, 4, 5, 6, and 7). As shown in *Figure 2-5*, each place weight differs from the one next to it by a factor of 8, instead of only by a factor of 2 as in the binary system. To convert an octal number to a decimal, one must multiply the value of the power of 8 depending on where the digit falls on the above octal place value chart.

Example: Convert octal number 42 to a decimal. The least significant digit of 2 is multiplied by 8^0 , which is 1, and the next digit of 4 is multiplied by 8^1 , which is 8. The results are then added as shown below.

$$2 \times 1 = 2 \quad 4 \times 8 = 32 \quad 2 + 32 = 34$$

OCTAL NUMBER SYSTEM CONVERSION

Octal numerals can be made from binary numerals by grouping consecutive binary digits into groups of three. To convert a decimal to an octal number, begin by converting the decimal to a binary number. Then separate the binary number into groups of 3 digits starting from the right. If needed, add implied zeros to the left of the number to form complete groups of 3 digits each. Next, convert each group of 3 digits to an octal value using *Figure 2-6*.

Example: Convert the decimal number 100_{10} to an octal number by first converting it to its binary number of 001100100. Break the binary number into groups of three and convert.

$$001 = 1 \quad 100 = 4 \quad 100 = 4 \quad \text{Octal number} = 144_c$$

So as not to confuse an octal number of 144 with the decimal number of 100, any of the following conventions may be used either before or after the octal number.

$$144_8 \quad 144_{\text{base}_8} \quad \text{oct } 144 \quad 0c144 \quad 144c$$

OCTAL PLACE VALUE CHART

8^7 2 097 152	8^6 262 144	8^5 32 768	8^4 4 096	8^3 512	8^2 64	8^1 8	8^0 1
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Figure 2-5. Derivation of the place values of the octal number system.

DECIMAL	BINARY	OCTAL	HEX	DECIMAL	BINARY	OCTAL	HEX
0	00000000	000	0	50	00110010	062	32
1	00000001	001	1	51	00110011	063	33
2	00000010	002	2	52	00110100	064	34
3	00000011	003	3	53	00110101	065	35
4	00000100	004	4	54	00110110	066	36
5	00000101	005	5	55	00110111	067	37
6	00000110	006	6	56	00111000	070	38
7	00000111	007	7	57	00111001	071	39
8	00001000	010	8	58	00111010	072	3A
9	00001001	011	9	59	00111011	073	3B
10	00001010	012	A	60	00111100	074	3C
11	00001011	013	B	61	00111101	075	3D
12	00001100	014	C	62	00111110	076	3E
13	00001101	015	D	63	00111111	077	3F
14	00001110	016	E	64	01000000	100	40
15	00001111	017	F	65	01000001	101	41
16	00010000	020	10	66	01000010	102	42
17	00010001	021	11	67	01000011	103	43
18	00010010	022	12	68	01000100	104	44
19	00010011	023	13	69	01000101	105	45
20	00010100	024	14	70	01000110	106	46
21	00010101	025	15	71	01000111	107	47
22	00010110	026	16	72	01001000	110	48
23	00010111	027	17	73	01001001	111	49
24	00011000	030	18	74	01001010	112	4A
25	00011001	031	19	75	01001011	113	4B
26	00011010	032	1A	76	01001100	114	4C
27	00011011	033	1B	77	01001101	115	4D
28	00011100	034	1C	78	01001110	116	4E
29	00011101	035	1D	79	01001111	117	4F
30	00011110	036	1E	80	01010000	120	50
31	00011111	037	1F	81	01010001	121	51
32	00100000	040	20	82	01010010	122	52
33	00100001	041	21	83	01010011	123	53
34	00100010	042	22	84	01010100	124	54
35	00100011	043	23	85	01010101	125	55
36	00100100	044	24	86	01010110	126	56
37	00100101	045	25	87	01010111	127	57
38	00100110	046	26	88	01011000	130	58
39	00100111	047	27	89	01011001	131	59
40	00101000	050	28	90	01011010	132	5A
41	00101001	051	29	91	01011011	133	5B
42	00101010	052	2A	92	01011100	134	5C
43	00101011	053	2B	93	01011101	135	5D
44	00101100	054	2C	94	01011110	136	5E
45	00101101	055	2D	95	01011111	137	5F
46	00101110	056	2E	96	01100000	140	60
47	00101111	057	2F	97	01100001	141	61
48	00110000	060	30	98	01100010	142	62
49	00110001	061	31	99	01100011	143	63
				100	01100100	144	64

Figure 2-6. Binary to octal and hexadecimal conversion table.

HEXADECIMAL

Another place-weighted numbering system is hexadecimal with a base of 16. Each hexadecimal digit represents four binary digits (bits) and there are eight bits in each byte. Hexadecimal notation is more popular because binary bit grouping in computing and digital electronics are in multiples of eight (8, 16, 32, 64, and 128 bit). Hexadecimal symbols include normal decimal symbols of 0, 1, 2, 3, 4, 5, 6, 7, 8, and 9, plus six alphabetical characters of A, B, C, D, E, and F. The hexadecimal place value chart is shown in *Figure 2-7*. Similar to the octal notation, each place weight differs from the one next to it, but by a factor of 16 (instead of 8), thereby reducing the number of bits in half to provide the same amount of information. To convert a hexadecimal (hex) number to a decimal, one must multiply the value of the power of 16 depending on where the digit falls on the above hexadecimal place value chart.

Example: Convert hex symbol 1A to a decimal. The least significant digit of A(10) is multiplied by 16^0 , which is 10, and the next digit of 1 is multiplied by 16^1 , which is 16. The results are then added as shown below.

$$10 \times 1 = 10 \quad 1 \times 16 = 16 \quad 10 + 16 = 26$$

So as not to confuse the hex number, of say 10, with the decimal number of 16, any of the following conventions may be used either before or after the hex number.

$$10_{16} \quad 10_{\text{base}_{16}} \quad \text{hex}10 \quad 0 \times 10 \quad 10 \times$$

HEXADECIMAL NUMBER SYSTEM CONVERSION

Hex numerals can be made from binary numerals by placing consecutive binary digits into groupings of 4, instead of 3 as with octal numbers. To convert a decimal to a hex number, begin by converting the decimal to a binary number. Then separate the binary number into groups of 4 digits starting from the right. Again, add implied zeros to the left of the number to form complete groups of 4 digits each. Next, convert each group of 4 digits to a hexadecimal value using *Figure 2-6*.

Example: Convert the decimal number 100_{10} to a hex number by first converting it to its binary number of 01100100. Break the binary number into groups of four starting from the right and convert.

$$0110 = 6 \quad 0100 = 4 \quad \text{Hex number} = 64_{\text{hex}}$$

To summarize, the "native language" of digital electronics, referred to as machine language, is binary. Octal and hexadecimal are more efficient variations of binary for programming since octal and hexadecimal are based on powers of 8 and 16, respectively, which are even multiples of the binary's base-2. This *sub-module* demonstrated how binary digits are grouped together and directly converted to or from their respective octal or hexadecimal numbers. It is important to understand that all digital devices, such as computers, will operate only off of binary digits known as bits.

BINARY CODED DECIMALS

Computers instructions are formed by groupings binary digits to form words. A series of four binary digits will form a 4-bit word. These 4-bit words are represented by Binary-Coded Decimals (BCD). As shown in *Figure 2-3*, binary 1000 represents decimal 8 and binary 0010 represents decimal 2. BCD coding uses the binary equivalent of the decimal number; however, BCD coding and binary numbers are not the same. A BCD number must be between decimal number 0 and 9 since each BCD number is expressed in units, tens, hundreds, thousands, etc. The binary number equivalent of decimal 82 is 01010010. However, the BCD expression would be two 4-bit words consisting of 1000 representing number 8 and 0010 representing number 2 as two separate decimals.

Example: Convert the decimal number 264_{10} to a BCD number by first separating each decimal number in to its place value and then converting each decimal in to 4-bit BCD words.

$$2 = 0010 \quad 6 = 0110 \quad 4 = 0100$$

HEXADECIMAL PLACE VALUE CHART

16^7 259 435 456	16^6 16 777 216	16^5 1 048 576	16^4 65 536	16^3 4 096	16^2 256	16^1 16	16^0 1
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Figure 2-7. Derivation of the place values of the hexadecimal number system.

Question: 2-1

Explain the decimal numbering system. How many symbols and what is its power?

Question: 2-5

Explain how to convert a decimal number to a binary number.

Question: 2-2

Why is the binary numbering system used in digital electronics?

Question: 2-6

Why are place-weighted numbering systems, such as octal and hexadecimal, used?

Question: 2-3

When writing binary numbers and placing digits in positions of place value, what occurs when a place value exceeds 1?

Question: 2-7

Convert the decimal number 100_{10} to an octal number.

Question: 2-4

Where is the Least Significant Bit (LSB) located on the binary place value table?

Question: 2-8

Convert hex symbol 1A to a decimal.

ANSWERS

Answer: 2-1

The decimal system uses ten different symbols (0, 1, 2, 3, 4, 5, 6, 7, 8, and 9) and is referred to as a base-10 numbering system since each additional placement is an additional power of 10.

Answer: 2-2

The binary number system is used in digital electronics because the two basic conditions of electricity, ON and OFF, can represent the two digits of the binary number system. When a switch is ON, it represents the digit 1, and when it is OFF, it represents the digit 0.

Answer: 2-3

The only digits available are 0 and 1. To exceed 1, the place value is reset to 0 and a 1 is placed in the next place value column to the left.

Answer: 2-4

The LSB is always located on the far right of the binary place value table at 20.

Answer: 2-5

To convert from decimal to binary, find the binary column that has the largest value but is equal to or smaller than the decimal number being converted. Place a 1 in that column and subtract the column value from the decimal number being converted. Look at the difference. Place a 1 in the column that has the largest value but is equal to or smaller than the decimal number difference of what was just subtracted. Now subtract this column value from the difference of the decimal number being converted and the previous column difference. If a column is not used, place a zero in it. Continue this operation until all of the binary place value columns with 1's, when added together, have the same value as the decimal number being converted. Write the number in binary form including a 1 or a 0 for each column.

Answer: 2-6

The binary numbering system requires many bits to represent relatively small numbers. For example, 8 binary bits (10010111) are required to represent a 3-digit decimal (151). As such, analyzing the numerical states of digital logic using the binary numbering system can become quite tedious for computer programmers developing machine language code.

Answer: 2-7

First convert 100_{10} to its binary number of 01100100. Then break the binary number into groups of three and convert as shown below:

$$\begin{aligned} 001 &= 1, & 100 &= 4, & 100 &= 4 \\ \text{Octal number} &= 144c \end{aligned}$$

Answer: 2-8

The least significant digit of A is multiplied by 160, which is 10, and the next digit of 1 is multiplied by 161, which is 16. The results are then added as shown below.

$$10 \times 1 = 10, \quad 1 \times 16 = 16, \quad 10 + 16 = 26$$



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

DATA CONVERSION

SUB-MODULE 03

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A B1

- 1

DATA CONVERSION

Sub-Module 03 DATA CONVERSION Knowledge Requirements

5.3 - Data Conversion

Analog Data, Digital Data;

Operation and application of analog to digital, and digital to analog converters, inputs and outputs, limitations of various types.

Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

DATA CONVERSION

ANALOG DATA

Analog and digital signals can both contain the same useful information. For example, an analog watch with hands pointing to numbers on a dial tells time just as well as a LCD watch that displays digital numbers. The advantage of the analog watch is that it tells time in relative terms, such as ¼ past the 11th hour; whereas the digital watch tells time in discrete units, such as 11:15am. Many cockpit instruments display both analog and digital formats.

Analog circuits are different from digital circuits in that they do not have two set values, such as 0 volts representing "OFF" and 5 volts representing "ON". Instead, analog circuits will vary continuously in both time and value from high to low. AC (alternating current) analog signals can be bipolar in that they have both positive and negative limits as seen in an AC sine wave. *Figure 3-1* illustrates the sine wave output of an AC synchro transmitter that varies in value (amplitude) from 0 volts to its +5 volt limit and returns to 0 volts before moving to its -5 volt limit and then back to 0 volts in one time cycle. DC (direct current) analog signals are unipolar in that they will have 0 volts as one of its limits with either a positive or a negative voltage defining its other analog signal voltage range limit.

Analog signals have the advantage in that they can represent any functional quantity, such as time, temperature, pressure, etc., by outputting an equivalent

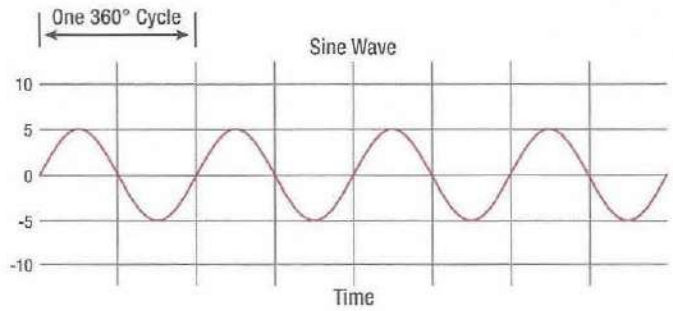


Figure 3-1. AC analog signal (sine wave).

functional quantity of voltage or current. Prime examples are aircraft fuel quantity and oil pressure analog synchro systems. By locating the transmitter of a synchro system remotely, fluid pressure can be directed into it without the necessity of running tubing through to the cockpit.

Inside the transmitter, the motion of a pressure bellows can be geared to the transmitter rotor in such a way as to make the rotor turn. (*Figure 3-2*) As in all synchros, the transmitter rotor turns proportional to the pressure sensed, which vary the voltages set up in the windings of the synchro stator. These voltages are transmitted to the indicator coils that develop the magnetic field that positions the pointer. Aircraft with digital instrumentation make use of pressure sensitive solid-state sensors that output digital signals for collection and processing by dedicated computers. Others may retain their analog sensors, but may forward this information through an analog-to-digital (A/D) converter for a computer to process and store the digital information for cockpit displays.

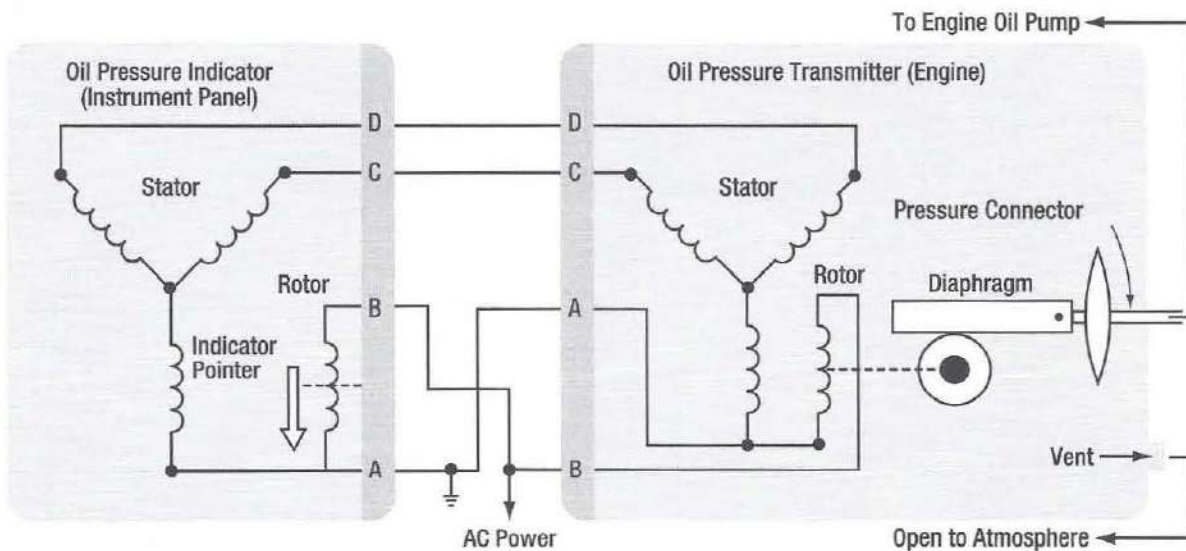


Figure 3-2. Analog synchro instrument system.

DIGITAL DATA

Analog circuits and devices vary continuously in both time and value from high to low; however, digital data are discrete and discontinuous representations of information. Digital signals are different from analog signals in that there are only two (binary) levels of voltage: high for "ON" and low for "OFF". These different voltage levels are put into a sequence of digital numbers to describe the value being transmitted. As stated in the previous sub-module, the binary number system is used in digital electronics because the two basic conditions of electricity, ON and OFF, can represent the two digits of the binary number system. When a switch is ON, it represents the digit 1, and when it is OFF, it represents the digit 0. Digital circuits will be discussed later in *sub-module 05*.

ANALOG TO DIGITAL CONVERSION

As shown in *Figure 3-3*, an Analog-to-Digital Converter (ADC) is a device that converts a continuous input voltage to a digital data stream that represents the amplitude of the input analog signal. As such, the ADC performs conversions periodically by sampling and quantizing the input signal over a very short period of time. The result is a sequence of digital numbers that have been converted from continuous time and amplitude analog signals to discrete time and amplitude digital signals.

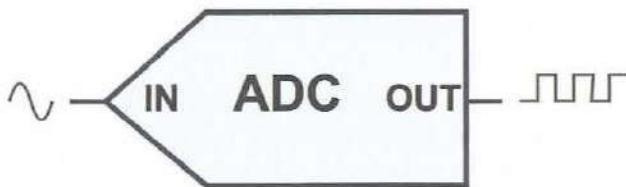


Figure 3-3. Symbol for an analog to digital converter.

To begin the analog-to-digital data conversion process, the voltage range is divided into 2^n equal bins and then sampled continuously. This value sampled is held until the next sample is taken. The ADC generates binary numbers that represents each voltage level sampled. If the voltage is divided into 2^1 bins it will generate 2 bits per sample. As shown in *Figure 3-4*, the first sample generates binary output 01 to represent 1 volt measured at the first interval, and the second sample results in a binary output of 10 which represents 2 volts at the second interval, and so on.

Clearly the digital representation of the analog waveform shown in *Figure 3-4* is a distorted version of

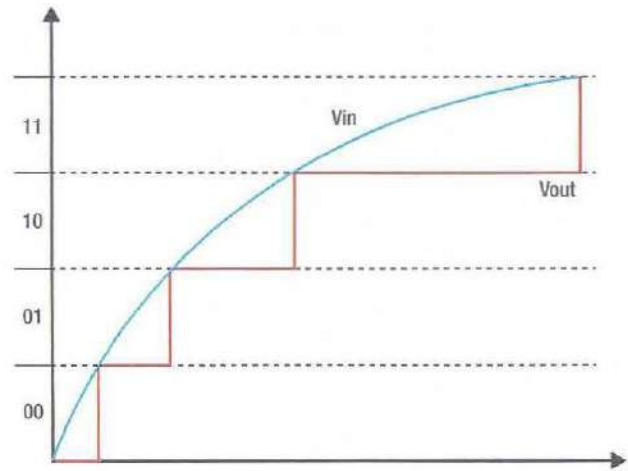


Figure 3-4. Analog-to-digital conversion by sampling and quantizing.

the original analog signal, although the basic similarity of the two can be discerned. Errors are produced by dividing the voltage range into bins that implies conversion back to the original analog signal will produce the exact same values. Quantization error can be reduced by generating more bits per sample, with each bit occupying less of the overall voltage range.

For example, a 4-bit ADC will sample 2^4 or 16 voltage bands, which is its decimal equivalent value of dynamic range. Dynamic range is the ratio of the largest input that can be converted to the smallest step size. For example, a 4-bit ADC with an input of 0 to 5 volts has a quantization step size of 5 volts / 16 bands = 0.3125. Therefore, the dynamic range is calculated to be $5 / 0.3125 = 16$.

DIGITAL TO ANALOG CONVERSION

Digital-to-Analog Converters (DACs) are found in everyday use. For example, digital information stored on Digital Video Discs (DVD) and Compact Disc (CD) use DACs to convert digital data streams to analog music and video signals. Digital-to-analog is the reverse of the above A/D conversion process such that each binary number is converted back into nominal levels by reconstructing the original waveform.

As shown in *Figure 3-5*, a DAC is a device that reconstructs finite-precision time series data in to a continuously varying signal, which theoretically can have an infinite number of states. In simple terms, it takes binary numbers, or combination of binary numbers, and changes them into corresponding voltages, such that, for example, binary number 1 equals 1 volt, binary number 2 equals 2 volts, binary number 3 equals 3 volts, and so on.

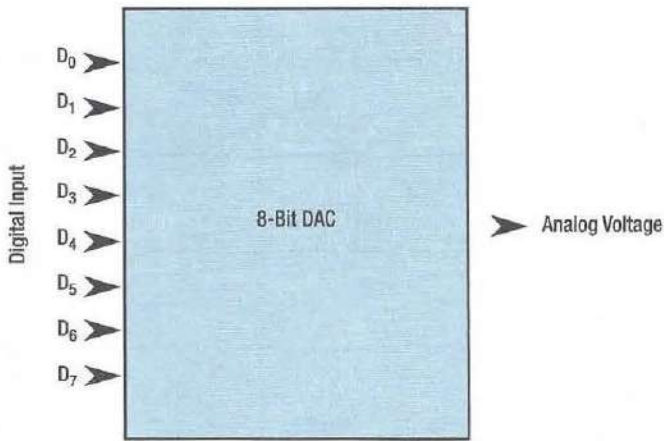


Figure 3-5. 8-Bit digital-to-analog converter symbol.

A typical DAC converts a sequence of binary digits (bits) into "impulses" that are then processed by a reconstruction filter to smooth out the step response into continuous curves. These impulses are created by updating the analog voltage output at uniform sampling intervals, controlled by a clock signal, which are then interpolated by a low-pass reconstruction filter to fill in the gaps between the impulses creating a continuously varied output. (Figure 3-6)

Other DAC methods produce a pulse-modulated signal that can then be filtered in a similar way to produce a smoothly varying signal.

Figure 3-7 is a schematic diagram of a 4-bit resistor-ladder DAC with an op-amp. This DAC converts a binary input to a matching decimal number that corresponds to the output voltage. The numbers 1, 2, 4, and 8 refer to the relative weights assigned to each bit whereby input "1" is the Least Significant Bit (LSB) and input "8" is the Most Significant Bit (MSB). Thus if a +5 volts (logic 1) is applied to input "1", the output will

be $5 \times (4\,000\text{ ohms}/20\,000\text{ ohms}) = 5 \times 0.2 = 1\text{ volt}$. If instead +5 volts is applied to input "2", the output will be $5 \times (4\,000\text{ ohms}/10\,000\text{ ohms}) = 5 \times 0.4 = 2\text{ volts}$.

Similarly, if either the "4" or "8" inputs are logic 1, then the output will be either 4 volts or 8 volts respectively. However, if +5 volts is applied to all 4 terminals simultaneously, the output will be 15 volts, representing the binary number input 1111. As a result, the output voltage can be one of 16 different voltages (including zero), in accordance with the input binary codes of 0000 through 1111 as shown on the corresponding table.

LIMITATIONS OF CONVERSION

As previously discussed, analog signals are converted into digital signals so that the information is manipulated by instructions executed within a computer and then converted back to analog signals to drive analog display formats (such as hands on a clock) that are easily recognized by the crew. However, reconstructing a signal from digital-to-analog or from analog-to-digital can degrade the signal by introducing errors, also known as noise. Reconstruction noise, as well as sampling noise from quantization, not only combine in the final signal, but also compound over multiple stages of conversion resulting in a loss of quality, or fidelity, of the original signal. All though not apparent, the waveform shown at the bottom of Figure 3-8 is a distorted version of the original waveform shown at the top of Figure 3-8.

A prime example of an everyday device that converts analog signals to digital and back to analog signals is a telephone. The microphone on the phone receives sound pressure from the sender's voice, which produces an analog signal. The analog signal is converted to a digital signal which is then transmitted through the airwaves to the receiver's phone.

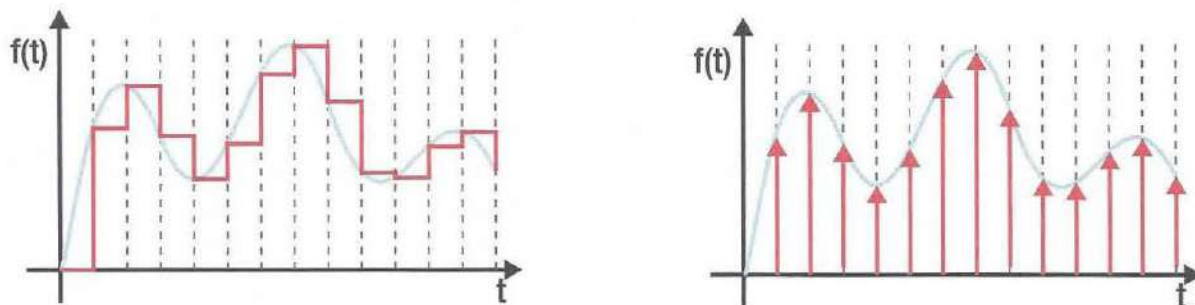
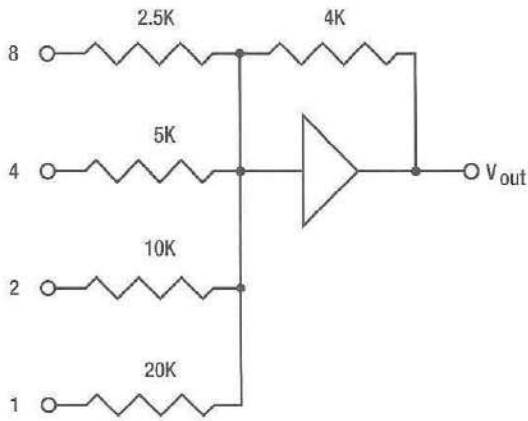


Figure 3-6. DAC output on left before reconstruction, and on right after reconstruction.



V out	BINARY NUMBER			
	8	4	2	1
0	0	0	0	0
1	0	0	0	1
2	0	0	1	0
3	0	0	1	1
4	0	1	0	0
5	0	1	0	1
6	0	1	1	0
7	0	1	1	1
8	1	0	0	0
9	1	0	0	1
10	1	0	1	0
11	1	0	1	1
12	1	1	0	0
13	1	1	0	1
14	1	1	1	0
15	1	1	1	1

Figure 3-7. 4-Bit resistor-ladder DAC with voltage output table.

Once received, it is converted back into an analog signal to drive the coil on the speaker to replicate the sender's voice. However, it is well known that the quality of the sender's voice on the phone will always be of less quality (fidelity) as compared to hearing the person speak in person. As such, it is important to recognize that signal degradation is a known limitation of multiple conversions.

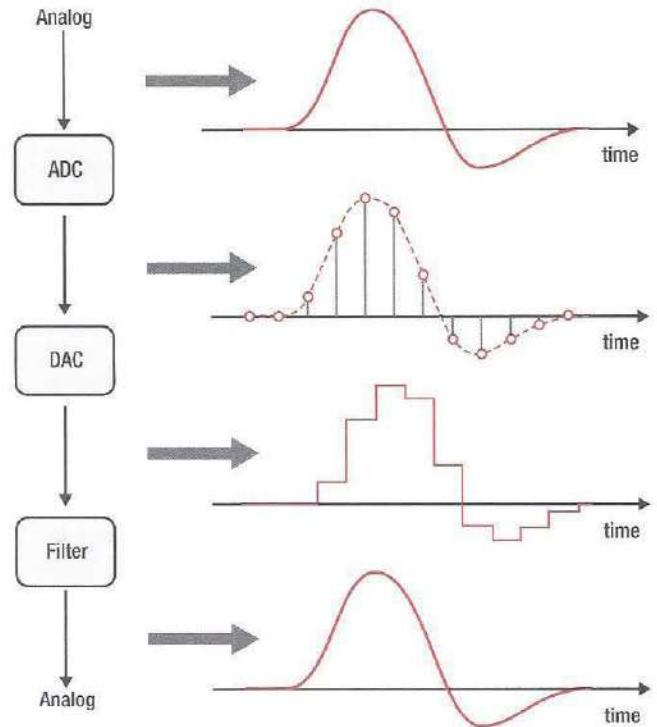


Figure 3-8. Conversion from analog to digital and back to analog.

Question: 3-1

What is the difference between analog circuits and digital circuits?

Question: 3-4

How can quantization error be reduced in an Analog-to-Digital Converter (ADC)?

Question: 3-2

Are DC (direct current) analog signals bipolar or unipolar?

Question: 3-5

Explain the device and process used to convert a digital signal to an analog signal.

Question: 3-3

Explain the device and process used to convert an analog signal to a digital signal.

Question: 3-6

What are the limitations of using multiple Analog-to-Digital Converters and Digital-to-Analog Converters?

ANSWERS

Answer: 3-1

Analog circuits are different from digital circuits in that they do not have two set values, such as 0 volts representing "OFF" and 5 volts representing "ON". Instead, analog circuits will vary continuously in both time and value from high to low. Analog signals have the advantage in that they can represent any functional quantity, such as time, temperature, pressure, etc., by outputting an equivalent functional quantity of voltage or current.

Answer: 3-2

DC analog signals are unipolar in that they will have 0 volts as one of its limits with either a positive or a negative voltage defining its other analog signal voltage range limit. Whereas, AC (alternating current) analog signals can be bipolar in that they have both positive and negative limits as seen in an AC sine wave.

Answer: 3-3

An Analog-to-Digital Converter (ADC) is a device that converts a continuous input voltage to a digital data stream that represents the amplitude of the input analog signal. As such, the ADC performs conversions periodically by sampling and quantizing the input signal over a very short period of time. The result is a sequence of digital numbers that have been converted from continuous time and amplitude analog signals to discrete time and amplitude digital signals

Answer: 3-4

Quantization error can be reduced by generating more bits per sample, with each bit occupying less of the overall voltage range. For example, a 14-bit ADC will sample 2¹⁴ or 16 384 voltage bands.

Answer: 3-5

A Digital-to-Analog Converter (DAC) is a device that that reconstructs finite-precision time series data in to a continuously varying signal, which theoretically can have an infinite number of states. A typical DAC converts a sequence of binary digits (bits) into "impulses" that are then processed by a reconstruction filter to smooth out the step response into continuous curves. These impulses are created by updating the analog voltage output at uniform sampling intervals, controlled by a clock signal, which are then interpolated by a low-pass reconstruction filter to fill in the gaps between the impulses creating a continuously varied output.

Answer: 3-6

Reconstruction noise, as well as sampling noise from quantization, not only combine in the final signal, but also compound over multiple stages of conversion resulting in a loss of quality, or fidelity, of the original signal.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

DATA BUSES

SUB-MODULE 04

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY -

A B1

Sub-Module 04

DATA BUSES

Knowledge Requirements

5.4 - Data Buses

Operation of data buses in aircraft systems, including knowledge of ARINC and other specifications.
Aircraft Network / Ethernet.

- 2

DATA BUSES

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

DATA BUSES

An integrated avionics system consists of various subsystems and components that need to communicate with each other in order to share information. Up until the early 1970's, many avionic systems were largely analog implementations using syncho and potentiometer outputs and inputs with required point-to-point wiring between various sensors and their dedicated cockpit instruments. As such, there were many large and heavy wiring bundles with point-to-point wiring, in addition to reliability problems due to intermittent connector pin failures.

In order to reduce aircraft weight and increase reliability, it became necessary to decrease the amount of aircraft wiring and connectors. Therefore, avionics system designers began using Analog-to-Digital Converters (ADCs) and Digital-to-Analog Converters (DACs) with serial point-to-point digital data buses requiring only two twisted pairs of wires connecting single data transmitters (sources) and single data receivers (sinks). These data buses evolved into single-source with multiple-sink buses, such as ARINC 429, and multiple-source with multiple sinks buses, such as ARINC 629 and its military equivalent, MIL-STD-1553B.

Time-Division Multiplexing (TDM) enabled different forms of information to be transmitted through one communication system. A multiplexer was used to sample input data sequentially and then stagger the different data samples in time to form a composite digital pulse train. By knowing the clock time and address of the various signals, a de-multiplexer at the receiving end would decode and distribute the individual signals. The following sections will discuss several popular military and commercial aircraft digital data buses, beginning with MIL-STD-1553B.

MIL-STD-1553B

In 1975, the U. S. Air Force F-15 and F-16 tactical fighters were the first military aircraft to employ a digital data bus. The TDM concept had evolved from single data source and single data sink to multiple data sources and multiple data sinks residing on a single multiplex bus. This highly reliable serial data bus was originally developed by the U. S. Air Force Research Laboratory and McDonnell Douglas (now Boeing) as H009, and later in 1978, became a military standard, known as MIL-STD-1553B. It has a data transfer rate of 1 million bits per second (1 Mbps) and allows no more than 1 word fault per 10 million words.

MIL-STD-1553B is an asynchronous half-duplex bus, meaning that data can move in both directions, but only in one direction at a time. Full-duplex would mean that data can move in both directions at the same time. An example of half-duplex operation is a speakerphone that does not allow one to speak while another person is talking. However, a cell phone which is full duplex permits one to talk and listen simultaneously.

As shown in *Figure 4-1*, the 1553B bus consists of a Bus Controller (BC) and up to 31 Remote Terminals (RT) which interface with the various subsystems. The Bus Controller (BC) initiates all data transfers by sending a command to a specified RT. Only the Remote Terminal receiving the command will respond. The command may include data or requests for data, and a status request from the RT. The RTs receive and decode the signals, reports errors and corrects them.

As the term implies, the Bus Monitor (BM) monitors the status of each transfer to determine that the data was successful transmitted and received error free. Typically, the Bus Monitor and the Bus Controller are physically located within the same "black box" or Line Replaceable

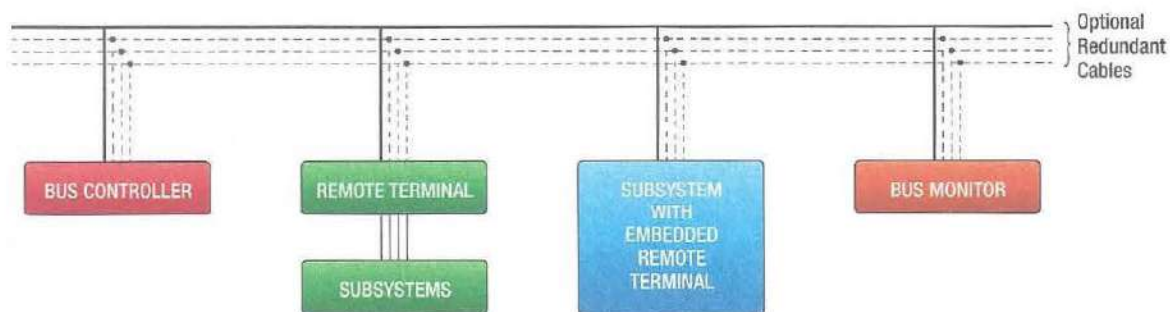


Figure 4-1. MIL-STD-1553B multiplex data bus topology.

S-70 Modernization Cockpit Architecture

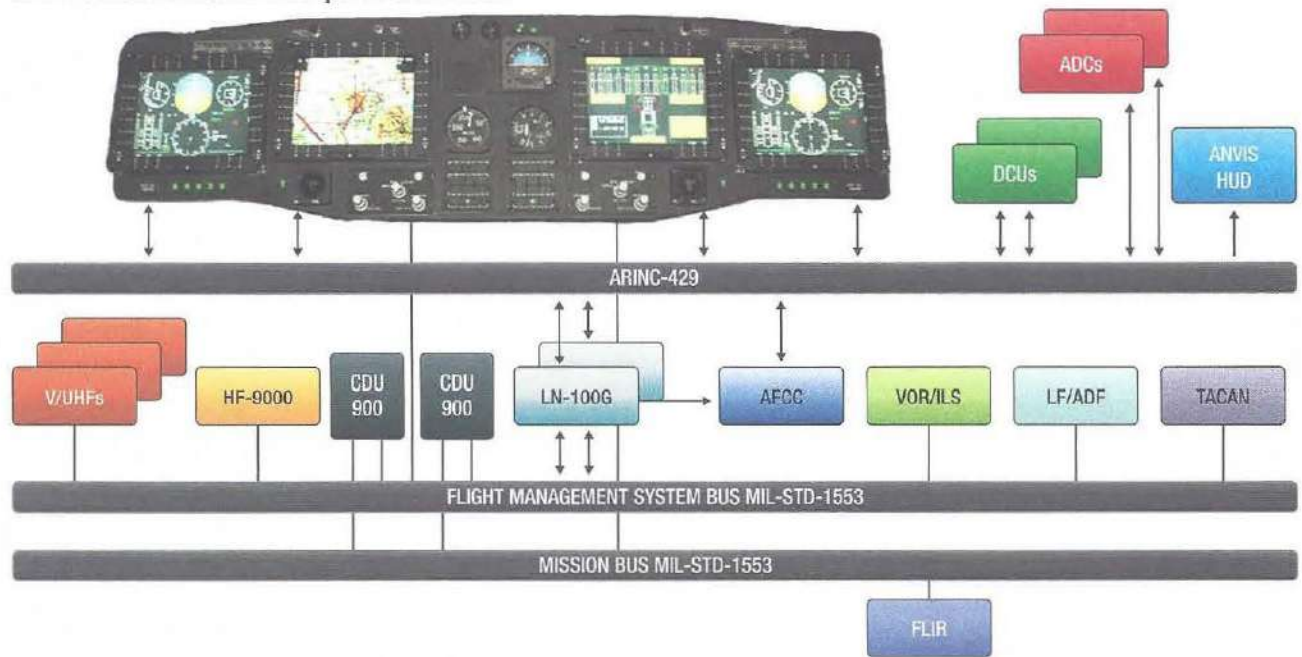


Figure 4-2. Sikorsky S-70 helicopter multi-level bus topology.

Unit (LRU), often called a Mission Computer. The Mission Computer hosts the entire avionics software operating system, known as an Operational Flight Program (OFP).

Topology refers to the physical layout and connections of each device to the bus. *Figure 4-1* illustrates a single-level topology. Multiple level topologies are formed by interconnecting single-level buses so data from one bus can be transferred on to another bus. Multi-level buses are used to isolate flight-critical flight management functions from non-flight critical mission-related functions. (*Figure 4-2*)

Each level will have two or more separate redundant buses, so that a secondary bus can take over communications in the event that the primary bus fails. For example, if the BM receives an error message, the BC may attempt to resend its command signal over a secondary backup bus. Also, it is not uncommon to have a back-up BC/BM as well, although only one BC will have command-response authority over the buses at any one time.

The bus cables are shielded twisted-wire pairs with the shields grounded at both ends. Every device must be coupled to the bus using an isolation transformer to avoid the risk of taking the down the bus if a device short-circuits. Isolation transformers can be either directly coupled (*Figure 4-3*) with no more than a 1 foot

stub length, or transformer coupled (*Figure 4-4*) with a maximum stub length of 20 feet.

Information is transmitted between the BC and the RTs or from RT to RT using composite digital pulse trains consisting of 20-bit command words, data words, and status words using one of the six information transfer formats shown in *Figure 4-5*.

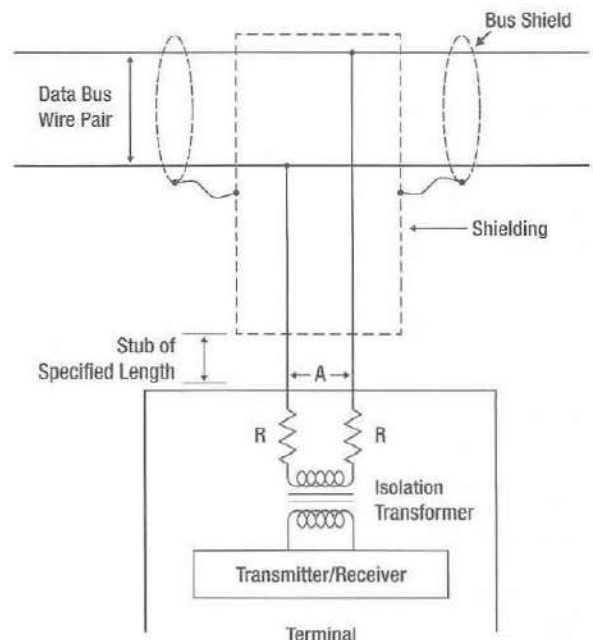


Figure 4-3. Data bus interface using direct coupling.

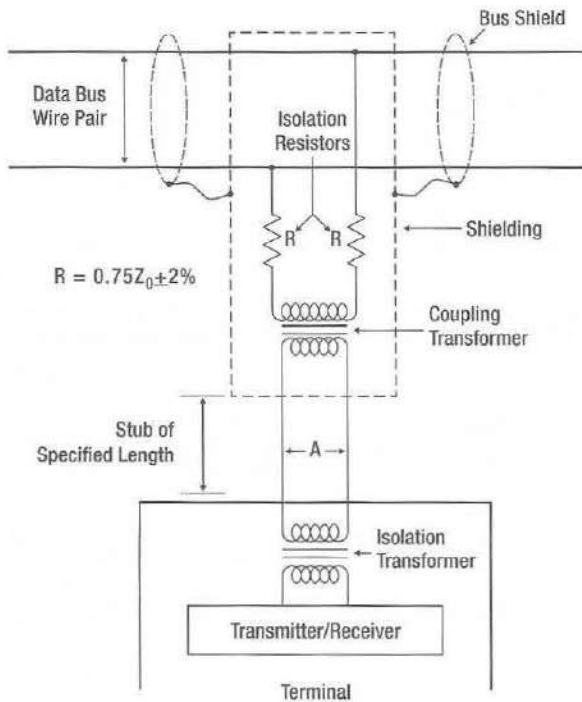


Figure 4-4. Data bus interface using transformer coupling.

The command word tells the RT to receive data, transmit data, or to switch modes. There can be up to 32 data words sent or received following a command. The RT responds with a status word for error checking. For the BC to command an RT to send data to another RT, the BC must first send a receive command followed by a transmit command, since RTs don't have the capability to initiate data transfers on their own.

Broadcast information transfer formats are used on occasions when the BC needs to send data to all the RTs at once. (Figure 4-6) A status word is not included in these broadcast commands because if all the RTs responded at once it would cause data collisions to occur on the bus.

ARINC 429

Aeronautical Radio Incorporated (ARINC) was formed in 1929 as a non-profit organization with airline and aircraft industry representation to develop standards for equipment form, fit and function compatibility and environmental operational specifications. ARINC developed the A429 digital data bus, used in the Boeing 757/767 and Airbus A300/A310, as a commercial aircraft standard. It is less complex and less costly than MIL-STD-1553B. However, it has its limitations.

A429 is not as robust as 1553B as it can only accept up to 20 receiver terminals, and its data rate is limited to 100 000 bits per second (100 Kbps). It has a self-clocking, self-synchronizing data bus protocol similar to 1553B, and it uses shielded twisted-pair wires for a physical connection.

The major limitation of A429 is that it has a simplex architecture, meaning that digital data can travel only in one direction from the transmitter source to the receiver sink at any one time; data can't travel in the opposite direction on the same bus.

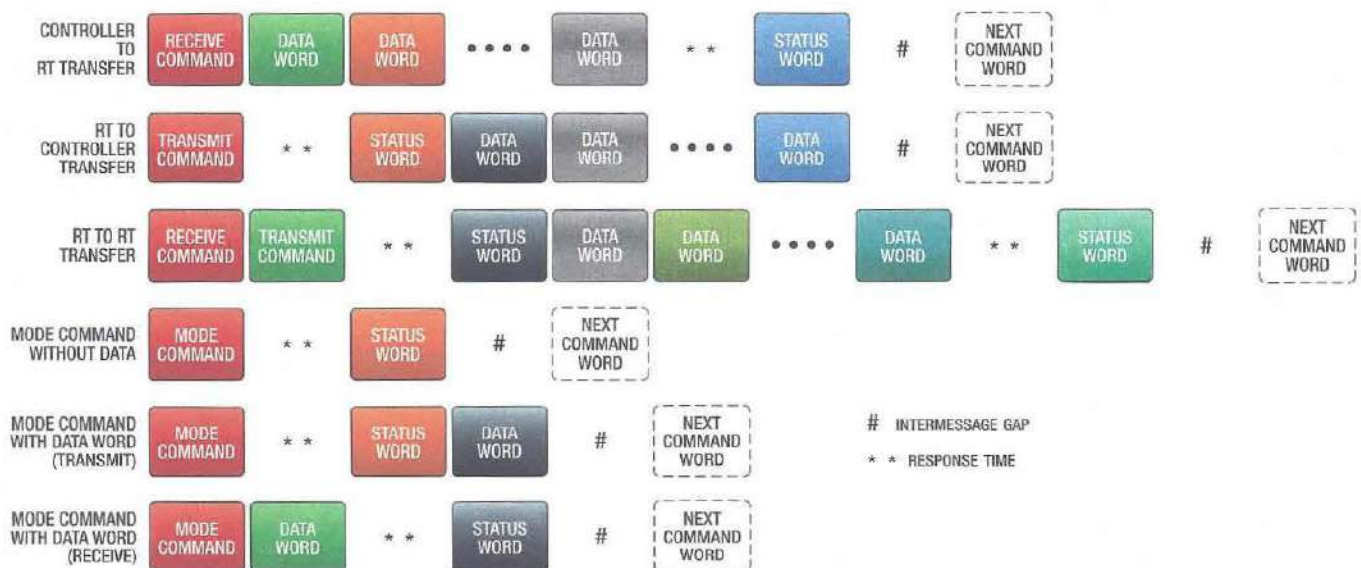


Figure 4-5. Information transfer formats.

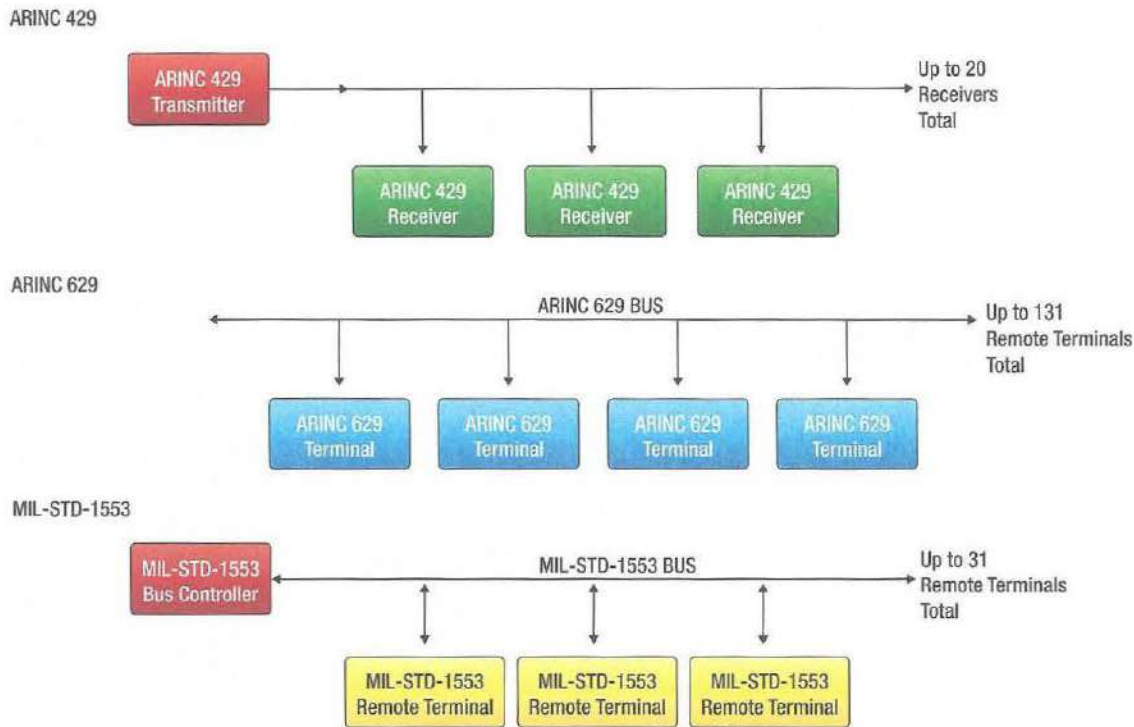


Figure 4-9. Comparison of A429, A629, and 1553B data bus topologies.

A629 uses a time-based, collision-avoidance protocol that allocates an assigned time slot to each terminal in which it is allowed to transmit on to the data bus. Each terminal decides when an appropriate time slot is available for transmission. Terminals are connected to the bus via a Serial Interface Module to provide isolation so that a shorted terminal can't bring down the entire bus. A629 data words consist of 3 sync bits, 16 data bits, and 1 parity bit.

AIRCRAFT NETWORKS/ ETHERNET

Ethernet is a commercial computer networking technology for local area and larger networks that was first introduced in 1980. In 1983, it became standardized by the Institute of Electrical and Electronic Engineers as IEEE 802.3. The original concept used coaxial cables as a shared medium. It has since evolved to using either twisted-pair wires (for low-speed data transfer) or fiber-optic cables (for higher speeds) in conjunction with the use of hubs or switches. The data transfer speed has also since increased from 2 Mbps to 100 Mbps. Each data frame contains of a source address and destination address, in addition to error checking so that damaged data can be detected and the data frame retransmitted if required.

ARINC 664 AFDX

The Avionics Full-Duplex Switched (AFDX) network, currently being used in the Airbus A380 and the Boeing 787, is specified as ARINC Standard 664. AFDX is the equivalent of the Ethernet 100 Mbps network, except that it has been adapted with deterministic timing and redundancy required for avionics applications. AFDX works more like a telephone exchange network than a typical aircraft digital data bus with data being switched from subscriber to subscriber, except that the subscribers are Line Replaceable Units (LRU).

As shown in *Figure 4-10*, the AFDX network topology consists of switches for traffic policing and LRU terminals (end systems) for traffic shaping and integrity checking. The switches and the terminals communicate with each other simultaneously (full-duplex) to prevent data collisions. Data transfer is accomplished via "virtual links", which are unidirectional connections from one source terminal to one or more destination terminals. Virtual links are determined by fixed commutation tables that are resident in each switch. Configuration tables within each LRU terminal dictate the formatting of the data that is transmitted. AFDX data words will contain destination and source addresses and the frame size can be anywhere from 64 to 1518 bytes.

IEEE 1394 FIREWIRE

Another commercial network that is making its way onboard aircraft is IEEE 1394, also known as Firewire. It was originally developed by the Institute of Electrical and Electronic Engineers (IEEE) for the consumer electronics industry as a serial point-to-point interface. It has since become popular for aircraft in-flight entertainment systems for streaming high-speed video signals due to its high data rate of up to 800 Mbps. The Firewire serial bus is also used in the Lockheed Martin F-35 Joint Strike Fighter Vehicle Management System for flight control, engine control and utility systems control, due to its large bandwidth and fault-tolerant topology where no single point failure can bring down the entire bus.

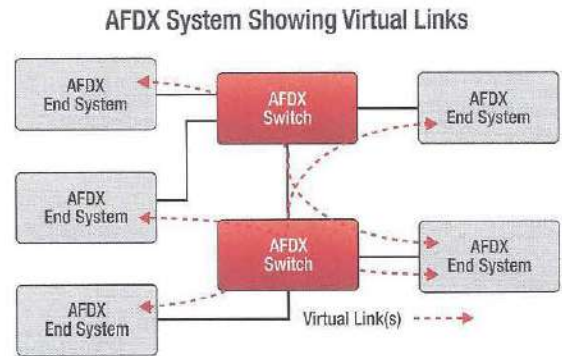


Figure 4-10. AFDX network topology.

Question: 4-1

What are the advantages of using digital data buses over point-to-point wiring?

Question: 4-5

Why is the reason for having multiple-level topology buses?

Question: 4-2

What is Time-Division Multiplexing (TDM) and how does it work?

Question: 4-6

What is the major limitation of ARINC 429?

Question: 4-3

Is MIL-STD-1553B a full-duplex or half-duplex bus and what is the difference?

Question: 4-7

What are the major differences between ARINC 629 and other digital data buses?

Question: 4-4

Explain the operation of the Avionics Full-Duplex Switched (AFDX) network.

Question: 4-8

Describe how the MIL-STD-1553B command-response protocol operates.

ANSWERS

Answer: 4-1

Up until the early 1970's, there were many large and heavy wiring bundles with point-to-point wiring that presented reliability problems due to intermittent connector pin failures. In order to reduce aircraft weight and increase reliability, it became necessary to decrease the amount of aircraft wiring and connectors with serial point-to-point digital data buses requiring only two twisted pairs of wires connecting data transmitters (sources) and data receivers (sinks).

Answer: 4-2

TDM enables different forms of information to be transmitted through one communication system. A multiplexer is used to sample input data sequentially and then stagger the different data samples in time to form a composite digital pulse train. By knowing the clock time and address of the various signals, a de-multiplexer at the receiving end decodes and distributes the individual signals.

Answer: 4-3

MIL-STD-1553B is an asynchronous half-duplex bus, meaning that data can move in both directions, but only in one direction at a time. Full-duplex would mean that data can move in both directions at the same time.

Answer: 4-4

The AFDX network topology consists of switches for traffic policing and LRU (Line Replaceable Units) terminals for traffic shaping and integrity checking. The switches and the terminals communicate with each other simultaneously (full-duplex) to prevent data collisions. Data transfer is accomplished via 'virtual links', which are unidirectional connections from one source terminal to one or more destination terminals. Virtual links are determined by fixed commutation tables that are resident in each switch. Configuration tables within each LRU terminal dictate the formatting of the data that is transmitted. AFDX data words will contain destination and source addresses and the frame size can be anywhere from 64 to 1518 bytes.

Answer: 4-5

Multiple level topologies are formed by interconnecting single-level buses so data from one bus can be transferred on to another bus. Multi-level buses are used to isolate flight-critical flight management functions from non-flight critical mission-related functions. Each level will have two or more separate redundant buses, so that a secondary bus can take over communications in the event the primary bus fails.

Answer: 4-6

The limitation of A429 is that it has a simplex architecture, meaning that digital data can travel only in one direction from the transmitter source to the receiver sink at any one time; data can't travel in the opposite direction on the same bus. What this means is that if there are multiple sinks for one source and one of those sinks needs to transmit back to the source and/or the other sinks, it will need a separate twisted-pair wire to do so since data transfer is not bi-directional.

Answer: 4-7

The A629 data bus has a data rate of 2 Mbps, which is 20 times faster than A429, and can handle 131 terminals instead of only 20. A629 is has a multiple-source and multiple-sync bus topology that is very similar to MIL-STD-1553B, except that it does not have a Bus Controller/Monitor, and separate channels must be used to transmit and receive. A629 uses a time-based, collision-avoidance protocol that allocates an assigned time slot to each terminal in which it is allowed to transmit on to the data bus. Each terminal decides when an appropriate time slot is available for transmission.

Answer: 4-8

The Bus Controller (BC) initiates all data transfers by sending a command to a specified RT. Only the Remote Terminal (RT) receiving the command will respond. The command may include data or requests for data, and a status request from the RT. The RTs receive and decode the signals, reports errors and corrects them.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

LOGIC CIRCUITS

SUB-MODULE 05

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A	B1
-	2
-	-

Sub-Module 05

LOGIC CIRCUITS

Knowledge Requirements

5.5 - Logic Circuits

- (a) Identification of common logic gate symbols, tables and equivalent circuits; Applications used for aircraft systems, schematic diagrams.
- (b) Interpretation of logic diagrams.

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

LOGIC CIRCUITS

LOGIC GATES

A gate is a special type of circuit designed to accept and generate voltage signals corresponding to binary 1's and 0's. Transistors are used in digital electronics to construct circuits that act as digital logic gates. The purpose and task of the device is achieved by manipulating electric signals through the logic gates. Thousands, and even millions, of tiny transistors can be placed on a chip to create the digital logic landscape through which a component's signals are processed.

As explained in *sub-module 02*, digital logic is based on the binary number system. There are two conditions than may exist, 1 or 0. In a digital circuit, these are equivalent to voltage or no voltage. Within the binary system, these two conditions are called Logic 1 and Logic 0. Using just these two conditions, gates can be constructed to manipulate information. There are a handful of common logic gates that are used. By combining any number of these tiny solid-state gates, significant memorization, manipulation, and calculation of information can be performed. A brief discussion of logic gates, their symbols, and truth tables follow.

NOT GATE

The NOT gate, also known as an "inverter", is the simplest of all gates. If the input to the gate is Logic 1, then the output is NOT Logic 1. This means that it is Logic 0, since there are only two conditions in the binary world. In an electronic circuit, a NOT gate would invert the input signal. In other words, if there was voltage at the input to the gate, there would be no output voltage. The gate can be constructed with transistors and resistors to yield this electrical logic every time. (The gate or circuit would also have to invert an input of Logic 0 into an output of Logic 1.)

To understand logic gates, truth tables are often used. A truth table gives all of the possibilities in binary terms for each gate containing a characteristic logic function. For example, a truth table for a NOT gate is illustrated in *Figure 5-1*. Any input (A) is NOT present at the output (B). This is simple, but it defines this logic situation. A tiny NOT gate circuit can be built using transistors that produce these results. In other words, a circuit can be built such that if voltage arrives at the gate, no voltage is output or vice-versa.

When using transistors to build logic gates, the primary concern is to operate them within the circuits so the transistors are either OFF (not conducting) or fully ON (saturated). In this manner, reliable logic functions can be performed. The variable voltage and current situations present during the active mode of the transistor are of less importance.

Figure 5-2 illustrates an electronic circuit schematic diagram that performs the logic NOT gate function. Any input, either a no voltage or voltage condition, yields the opposite output. This gate is built with bipolar junction transistors, resistors, and a few diodes. Other designs exist that may have different components. When examining and discussing digital electronic circuits, the electronic circuit design of a gate is usually not presented. The symbol for the logic gate is most often used. The technician can then concentrate on the configuration of the logic gates in relation to each other.

BUFFER GATE

Another logic gate with only one input and one output is the buffer. It is a gate with the same output as the input. While this may seem redundant or useless, an amplifier

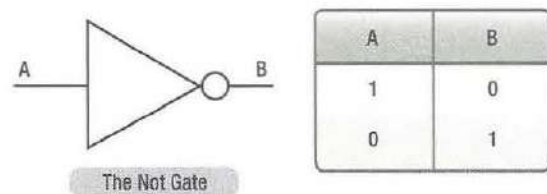


Figure 5-1. A NOT logic gate symbol and a NOT gate truth table.

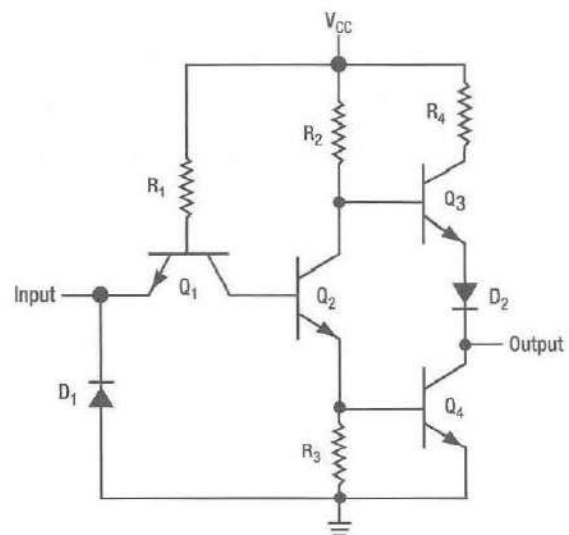


Figure 5-2. An electronic circuit that reliably performs the NOT logic function.

may be considered a buffer in a digital circuit because if there is voltage present at the input, there is an output voltage. If there is no voltage at the input, there is no output voltage. When used as an Operational Amplifier, the buffer can change the values of a signal. This is often done to stabilize a weak or varying signal. All gates are amplifiers subject to output fluctuations. The buffer steadies the output of the upstream device while maintaining its basic characteristic. Another application of a buffer, using two NOT gates in series, is to use it to isolate a portion of a circuit. (Figure 5-3)

An Operational Amplifier (Op Amp) is a high-gain differential voltage amplifier. The output can be hundreds or thousands times greater than the voltage of its input. The output is also linear with the difference between the input potential. They are widely used in a wide variety of electronic circuits including signal processing circuits, control circuits and instrumentation.

AND GATE

Most common logic gates have two inputs. Three or more inputs are possible on some gates. When considering the characteristics of any logic gate, an output of Logic 1 is sought and a condition for the inputs is stated or examined. For example, Figure 5-4 illustrates an AND gate with a schematic representation of two switches in series.

For an AND gate to have a Logic 1 output, both inputs have to be Logic 1. In an actual electronic circuit, this means that for a voltage to be present at the output, the AND gate circuit has to receive voltage at both of its inputs. As pointed out, there are different arrangements of electronic components that yield this result. Whichever is used is summarized and presented as the AND gate symbol. The truth table in Figure 5-4 illustrates that there is only one way to have an output of Logic 1 or voltage when using an AND gate.

An example of AND logic could possibly be engage logic, found in an autopilot. In this case, the autopilot would not be allowed to be engaged unless certain conditions are first met. Such conditions could be: Vertical gyro is valid AND directional gyro is valid AND all autopilot control knobs are in depths AND servo circuits are operational. Only when these conditions are met will the autopilot be engaged. Figure 5-5 Shows the logic of this system found in the aircraft wiring diagrams.

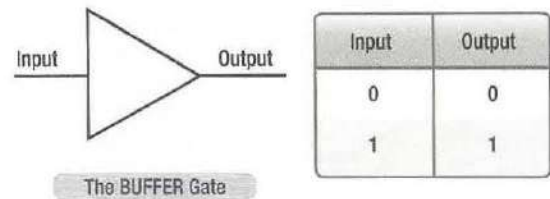


Figure 5-3. A buffer or amplifier symbol and the truth table of the buffer, which is actually two consecutive NOT gates.

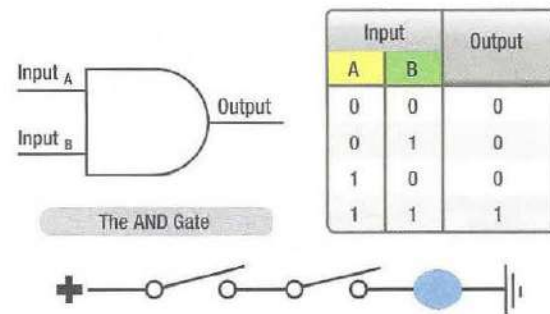


Figure 5-4. An AND gate symbol and its truth table with schematic diagram.

OR GATE

Another useful and common logic gate is the OR gate. In an OR gate, to have an output of Logic 1 (voltage present), one of the inputs must be Logic 1. As seen in Figure 5-6, only one of the inputs needs to be Logic 1 for there to be an output of Logic 1. When both inputs are Logic 1, the OR gate has a Logic 1 output because it still meets the condition of one of the inputs being Logic 1.

Figure 5-7 is a simplified circuit that illustrates the OR logic. The example used is a "DOOR UNSAFE" annunciator. Let's say in this case that the plane has one cabin door and a baggage door. In order for the annunciator light on the master warning panel to extinguish, both doors must be closed and locked. If any one of the doors is not secured properly, the baggage door OR the cabin door, then the "DOOR UNSAFE" annunciator will illuminate.

In this case, two switches are in parallel with each other. If neither one of the two switches is closed, the light bulb will light up. The lamp will be off only when both switches are open.

NAND GATE

The AND, OR, and NOT gates are the basic logic gates. A few other logic gates are also useful. They can be derived from combining the AND, OR, and NOT gates. The NAND gate is a combination of an

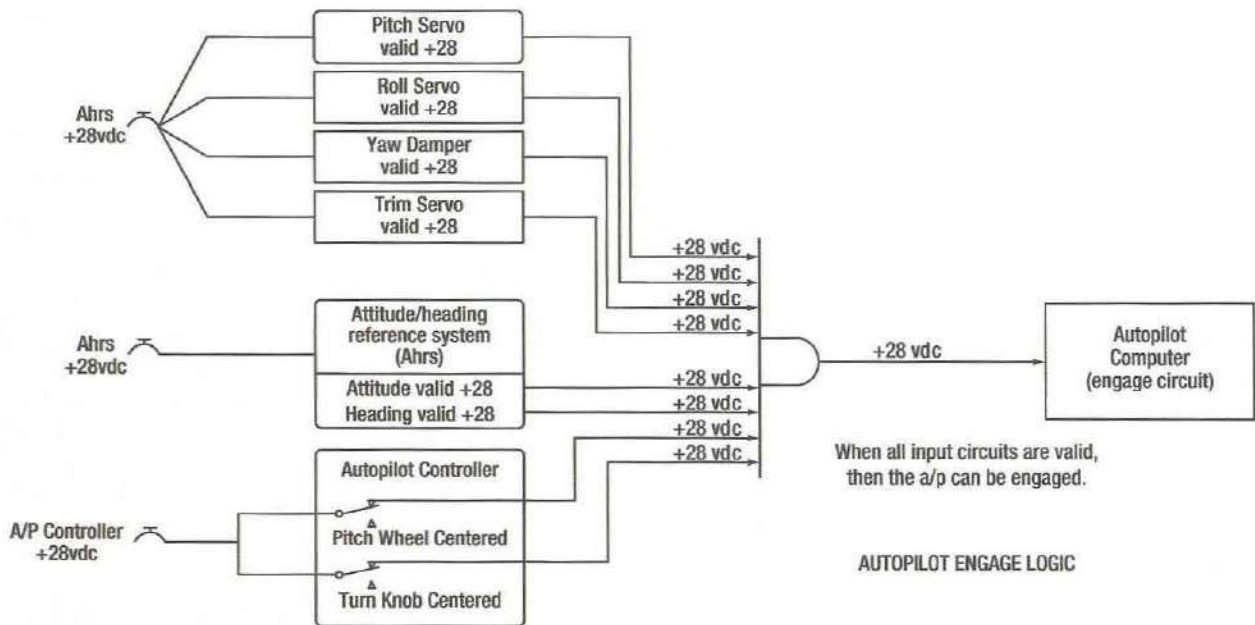


Figure 5-5. AND logic of system found in the aircraft wiring diagrams.

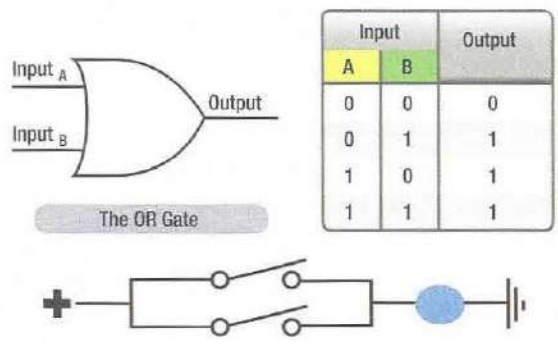


Figure 5-6. An OR gate symbol and its truth table with schematic diagram.

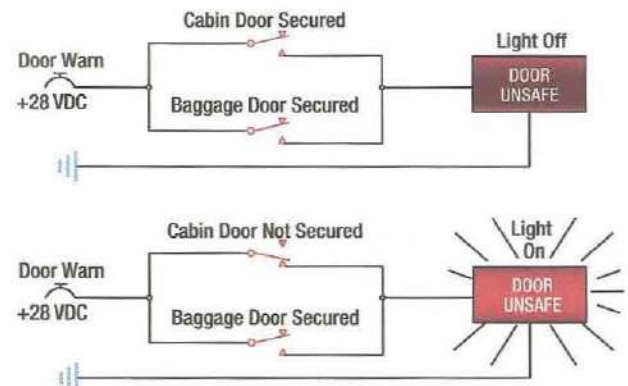


Figure 5-7. Simplified circuit that illustrates OR logic.

AND gate and a NOT gate. This means that AND gate conditions must be met and then inverted. So, the NAND gate is an AND gate followed by a NOT gate. The truth table for a NAND gate is shown in *Figure 5-8* along with its symbol.

If a Logic 1 output is to exist from a NAND gate, inputs A and B must not both be Logic 1. Or, if a NAND gate has both inputs Logic 1, the output is Logic 0. Stated in electronic terms, if there is to be an output voltage, then the inputs cannot both have voltage or, if both inputs have voltage, there is no output voltage. NOTE: The values in the output column of the NAND gate table are exactly the opposite of the output values in the AND gate truth table.

Figure 5-9 is a picture of a Texas Instruments 7400 chip, containing four NANDs. The two additional pins supply power (+5 V) and connect the ground.

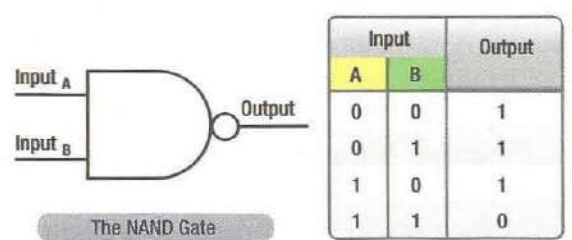


Figure 5.8. A NAND gate symbol and its truth table illustrating that the NAND gate is an inverted AND gate.

NOR GATE

A NOR gate is similarly arranged except that it is an inverted OR gate. If there is to be a Logic 1 output, or output voltage, then neither input can be Logic 1 or have input voltage. This is the same as satisfying the OR gate conditions and then putting the output through a NOT gate. The NOR gate truth table in *Figure 5-10* shows that the NOR gate output values are exactly the opposite of the OR gate output values.

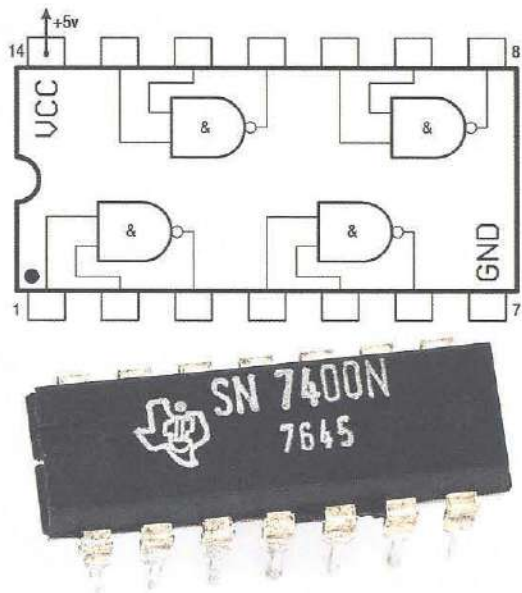


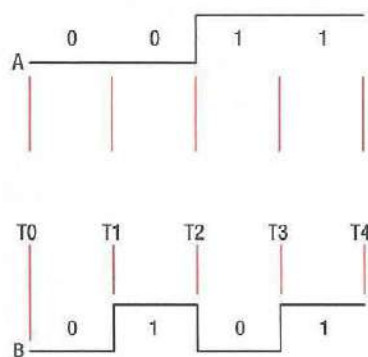
Figure 5-9. TI 7400 NAND chip.

EXCLUSIVE OR GATE

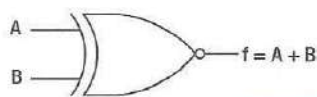
Another common logic gate is the EXCLUSIVE OR (XOR) gate. It is the same as an OR gate except for the condition where both inputs are Logic 1. In an OR gate, there would be a Logic 1 when both inputs are Logic 1. This is not allowed in an EXCLUSIVE OR gate. When either of the inputs is Logic 1, the output is Logic 1. However, with an EXCLUSIVE OR gate, if both inputs are Logic 1, the Logic 1 output is excluded and results in Logic 0. (Figure 5-11)

EXCLUSIVE NOR GATE

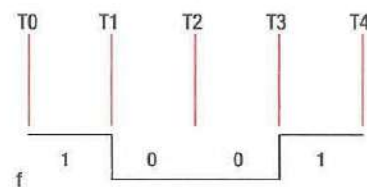
The EXCLUSIVE NOR (X-NOR) gate is nothing more than an XOR gate with an inverted output. It produces a 1 output when all inputs are 1s and also when all inputs are 0s. The standard symbol and truth table is shown in Figure 5-12. "T" is the time interval of the pulse.



Pulse Train Timing Diagram



X-NOR gate input/output



Pulse	A	B	f
T1	0	0	1
T2	0	1	0
T3	1	0	0
T4	1	1	1

TRUTH TABLE

Figure 5-12. Standard Symbol for X-NOR gate.

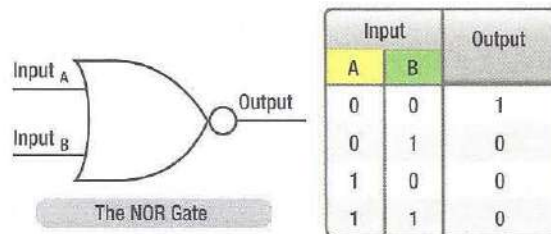


Figure 5-10. A NOR gate symbol and its truth table illustrating that the NOR gate is an inverted OR gate.

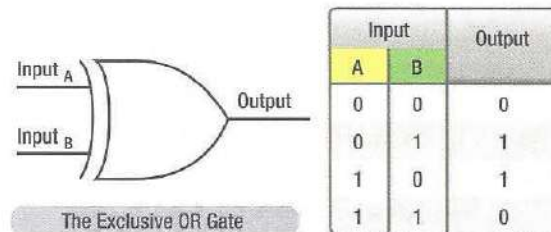


Figure 5-11. An EXCLUSIVE OR gate symbol and its truth table, which is similar to an OR gate but excludes output when both inputs are the same.

NEGATIVE LOGIC GATES

There are also negative logic gates. The negative OR and the negative AND gates are gates wherein the inputs are inverted rather than inverting the output. This creates a unique set of outputs as seen in the truth tables in Figure 5-13.

The negative OR gate is not the same as the NOR gate as is sometimes misunderstood. Neither is the negative AND gate the same as the NAND gate. However, as the truth tables reveal, the output of a negative AND gate is the same as a NOR gate, and the output of a negative OR gate is the same as a NAND gate.

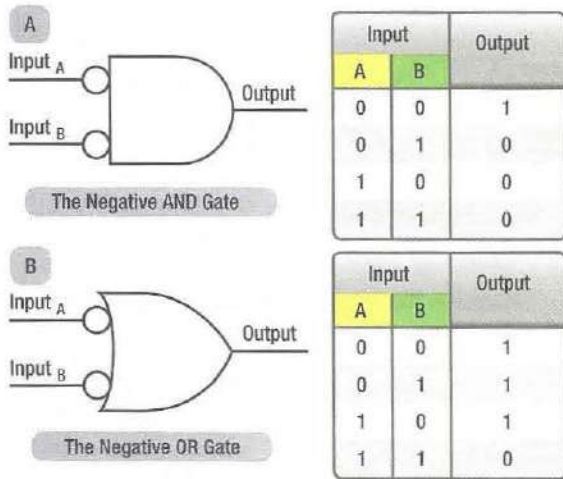


Figure 5-13. The NEGATIVE AND gate symbol and its truth table (A) and the NEGATIVE OR gate symbol and truth table (B). The inputs are inverted in the NEGATIVE gates.

DIGITAL CIRCUITS

Electronic circuits use transistors to construct logic gates that produce outputs related to the inputs shown in the truth tables for each kind of gate. The gates are then assembled with other components to manipulate data in digital circuits. The electronic digital signals used are voltage or no-voltage representations of Logic 1 or Logic 0 conditions. By using a series of voltage and/or no-voltage outputs, a logic circuit manipulates, computes, and stores data. It is worth noting again that an advantage of digital components and circuits is that voltage and current flow does not need to be exact. Positive voltage between 2.6 and 5.0 volts at the input of a gate is considered an input signal of Logic 1. Any voltage less than 2.5 volts at the gate input is considered no voltage or an input of Logic 0.

Two major kinds of logic circuits are the TTL (transistor-transistor logic) and CMOS (complementary metal oxide semiconductor). TTL logic circuit elements are primarily bipolar semiconductor components connected together to produce a consistent output. This output may be combined with the output of other TTL logic elements and logic circuits to perform a task. TTL circuits operate with +5-volts power source. It uses positive logic, meaning Logic 1 occurs with +5 volts and Logic 0 is ground or 0 volts. There are different types of TTL circuits that have different power requirements.

CMOS logic circuits are constructed with metal oxide semiconductor transistors rather than the bipolar

junction transistors used in TTL. CMOS logic circuits use less power because the construction of the logic gates and, therefore, the digital circuits that are comprised of CMOS components use fewer elements.

CMOS transistor output is triggered by lower voltage and does not rely on current flow through the base-emitter junction. The same digital logic results as TTL circuits is accomplished, but CMOS logic circuits are less susceptible to electrical interference and operate with a wider range of voltages (Logic 1 between +3 and +18 volts). CMOS technology is predominant in modern integrated circuits used in aircraft systems.

AIRCRAFT LOGIC CIRCUIT APPLICATIONS

One example of logic circuits applied to aircraft applications would be illuminating display segments of numbers on a radio control head. The circuit shown in *Figure 5-14* uses a NOT gate and three OR gates. Feeding patterns of binary numbers into the four inputs on the left will turn the segment "ON" and "OFF". For example, feed in the decimal number 7 as four binary inputs of "0111" and the gates will trigger as shown, switching "ON" the lower right display segment.

Another aircraft logic circuit application is the Landing Gear Warning Indicator. It consists of a 3-input NOR gate and a 3-Input AND gate, as shown in *Figure 5-15*. As can be seen from the truth tables, when all 3 landing gear are extended and locked they each activate a limit switch which provides a voltage (1) to the 3 inputs of both gates thereby turning "OFF" (0) the red LED (light-emitting diode) and turning "ON" (1) the green LED. The opposite occurs when all three landing gear are retracted turning "ON" (1) the red LED and turning "OFF" (0) the green LED indicator.

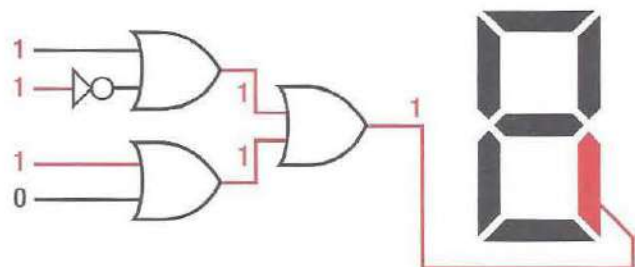
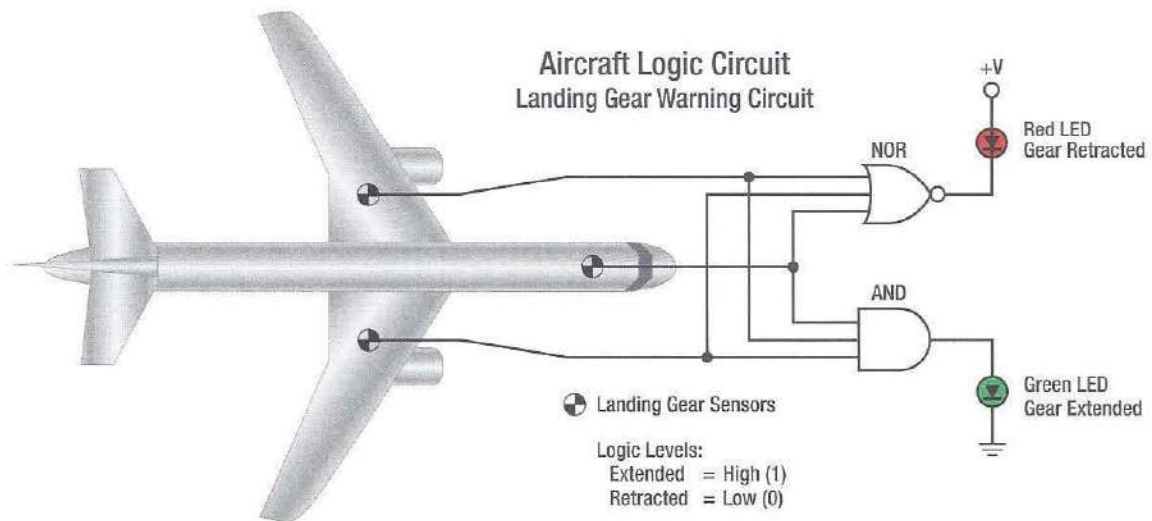


Figure 5-14. Logic circuit used on a radio control head.

The next *sub-module* will discuss computer technology whereby multiple gates are coupled together and applied to the task of binary number storage in memory circuits and manipulation in computing circuits with each gate's output representing one binary digit (bit) of a multi-bit binary number called machine language.



3-INPUT NOR GATE TRUTH TABLE			
INPUT	INPUT	INPUT	OUTPUT
0	0	0	1
1	0	0	0
0	1	0	0
0	0	1	0
1	1	0	0
0	1	1	0
1	0	1	0
1	1	1	0

3-INPUT AND GATE TRUTH TABLE			
INPUT	INPUT	INPUT	OUTPUT
0	0	0	0
1	0	0	0
0	1	0	0
0	0	1	0
1	1	0	0
0	1	1	0
1	0	1	0
1	1	1	1

Figure 5-15. Typical aircraft logic circuit for landing gear warning.

Question: 5-1

What is the difference between an inverter and a buffer?

Question: 5-5

Explain the logic function of the NOR gate.

Question: 5-2

Explain the logic function of the AND gate

Question: 5-6

What is the difference between an OR gate and an EXCLUSIVE OR gate

Question: 5-3

Explain the logic function of the OR gate.

Question: 5-7

What is the difference between the Negative OR and Negative AND gates and the NOR and NAND gates?

Question: 5-4

Explain the logic function of the NAND gate.

Question: 5-8

What is the difference between TTL (transistor-transistor logic) logic circuits and CMOS (complementary metal oxide semiconductor) logic circuits?

ANSWERS

Answer: 5-1

An inverter, also known as a NOT gate, inverts the input signal. In other words, if there was voltage at the input to the gate, there would be no output voltage. A buffer is a gate with the same output as the input used to isolate or amplify a signal.

Answer: 5-2

For an AND gate to have a Logic 1 output, all inputs have to be Logic 1. In an actual electronic circuit, this means that for a voltage to be present at the output, the AND gate circuit has to receive voltage at all of its inputs.

Answer: 5-3

In an OR gate, only one of the inputs needs to be Logic 1 for there to be an output of Logic 1. When both inputs are Logic 1, the OR gate has a Logic 1 output because it still meets the condition of one of the inputs being Logic 1.

Answer: 5-4

The NAND gate is a combination of an AND gate and a NOT gate. This means that AND gate conditions must be met and then inverted. If a Logic 1 output is to exist from a NAND gate, inputs A and B must not both be Logic 1. Or, if a NAND gate has both inputs Logic 1, the output is Logic 0.

Answer: 5-5

A NOR gate is an inverted OR gate. If there is to be a Logic 1 output, or output voltage, then neither input can be Logic 1 or have input voltage. This is the same as satisfying the OR gate conditions and then putting the output through a NOT gate.

Answer: 5-6

An EXCLUSIVE OR (XOR) gate is the same as an OR gate, except for the condition where both inputs are Logic 1. In an OR gate, there would be a Logic 1 when both inputs are Logic 1. With an EXCLUSIVE OR gate, if both inputs are Logic 1, the Logic 1 output is excluded and results in Logic 0.

Answer: 5-7

The output of a Negative AND gate is the same as a NOR gate, and the output of a Negative OR gate is the same as a NAND gate. However, the inputs are inverted in the Negative OR and Negative AND gates.

Answer: 5-8

TTL bipolar junction transistor circuits operate with +5 volts power source. It uses positive logic, meaning Logic 1 occurs with +5 volts and Logic 0 is ground or 0 volts. CMOS logic circuits use less power and use fewer elements. CMOS transistor output is triggered by lower voltage and does not rely on current flow through the base-emitter junction. CMOS logic circuits are less susceptible to electrical interference and operate with a wider range of voltages (Logic 1 between +3 and +18 volts).



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

BASIC COMPUTER STRUCTURE

SUB-MODULE 06

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A **B1**

Sub-Module 06

BASIC COMPUTER STRUCTURE

Knowledge Requirements

5.6 - Basic Computer Structure

- (a) Computer terminology (including bit, byte, software, hardware, CPU, IC, and various memory devices such as RAM, ROM, PROM);
Computer technology (as applied in aircraft systems).
- (b) Computer related terminology;
Operation, layout and interface of the major components in a micro computer including their associated bus systems; Information contained in single and multiaddress instruction words;
Memory associated terms;
Operation of typical memory devices;
Operation, advantages and disadvantages of the various data storage systems.

1

2

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Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

COMPUTER ARCHITECTURE

A computer accepts digital information, processes it per a set of instructions, and provides the results. Computers found on board aircraft are used to provide vehicle and utility control; flight management; navigation, communication and identification; caution and warning; and other essential functions. The basic structure or architecture of a computer is shown in *Figure 6-1*. It consists of a Central Processing Unit (CPU), Main Memory, and an Input and Output (I/O) system.

The Address and Data Buses provide a pathway for information to flow between the CPU, Main Memory, and the I/O system. They are referred to as parallel busses because they consist of multiple lines that send related parts of information simultaneously. Information, either data or instructions, contained on each parallel line is sent from multiple ports on the CPU to arrive at multiple ports at either the Main Memory or the I/O system, or vice versa.

The Control Bus, which provides control signals between the CPU, Main Memory, and the I/O system, is a serial bus. Buses that connect the I/O system with external input and output devices, such as displays and storage, are also serial buses. Serial buses differ from parallel buses in that one bit of information is transmitted or received one bit at a time on a single line in a serial fashion, rather than information being sent all at once over multiple lines, as is done with a parallel bus. Parallel buses tend to be short and are internal to

the computer, where serial buses are used externally throughout the aircraft, as discussed in *sub-module 04*.

The CPU is the "brain" of the computer. It retrieves and executes instructions (i.e., sequence of steps) stored in memory and coordinates the flow of data throughout the computer in a synchronous manner controlled by the clock timing signals. The clock generates a periodic square-wave pulse train used as timing signals. Following a HIGH pulse from the clock, the CPU retrieves data and instructions from Main Memory or the I/O system on the parallel data bus, processes the data, and writes the result back on to the data bus to send to the Main Memory or to the I/O system if, for example, the result is to be displayed or put in to external storage.

The Main Memory stores the information for later access by the CPU. The Input and Output (I/O) system converts the information to other forms to facilitate communication with other onboard computers and to their operators (e.g., flight crew, technicians, etc. through external serial data buses, such as MIL-STD-1553B, ARINC 429, ARINC 629, etc.

BITS, BYTES, AND WORDS

Computers process information using digital data that is coded in single binary digits, known as "bits". A bit can hold 2^1 values, "0" and "1". Eight bits are grouped to form a "byte". A byte can hold 2^8 or 256 values. One thousand bytes, known as a Kilobyte (KB), is equivalent to the amount of information contained on a page in a book.

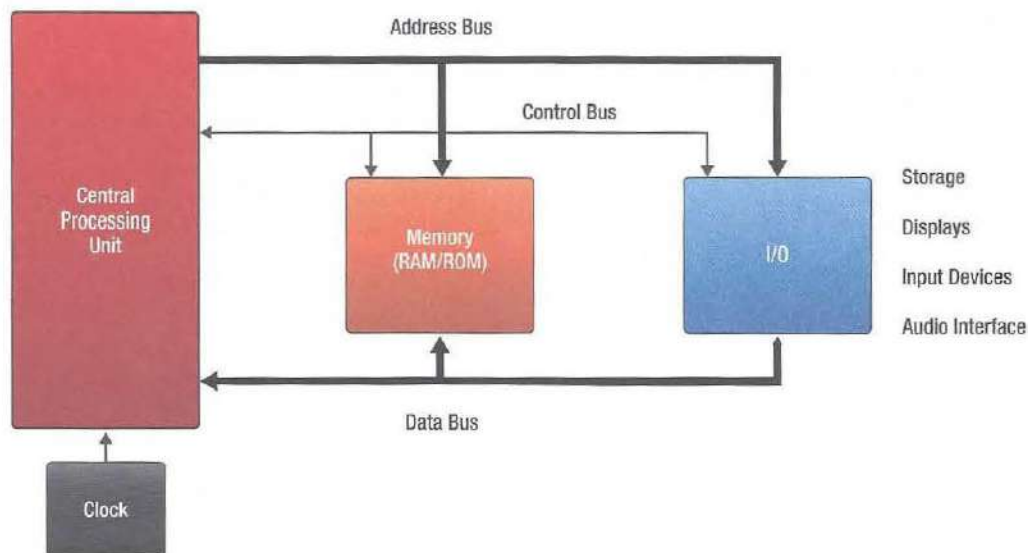


Figure 6-1. Basic computer architecture.

One million bytes, or a Megabyte (MB), is equivalent to the amount of information contained in a large book. A Gigabyte (GB), or one thousand megabytes, is equivalent to the information contained in a two-hour standard-definition movie. A computer's main memory typically stores several GB of information.

1 KB = 1 000 bytes
 1 MB = 1 000 KB = 1 000 000 bytes
 1 GB = 1 000 MB = 1 000 000 000 bytes

Bits are grouped together to form "words". A word is a basic group of digits treated as a unit by a computer. All modern computers use a multiple of a byte as their word size. The parallel data bus between the CPU and Main Memory is normally the same width as the word size or a multiple of the word size. Thus, a 32-bit computer would typically have 32 data bus lines.

There are two types of words: instructions and data. Instructions retrieved from Main Memory tell the CPU what operation to perform on the data. The instructions are a series of steps, such as "branch" to a new instruction, perform a mathematical operation on the data, write the data back into Main Memory, read from the I/O system, or write to the I/O system. Branch is an instruction that may cause the computer to begin execution of a different instruction sequence.

Figure 6-2, illustrates how a 32-bit instruction word could be formed in a Reduced Instruction Set Computer (RISC). The first 6 bits are reserved for the operations code. With these 6 bits there can be 2^6 or 64 possible instructions. The remaining bits designate the destination register, source register and the immediate value. Registers (R) in the CPU provide a temporary storage area to manipulate the data as per the instruction. An immediate value is stored as part of the instruction which employs it, usually to load into, add to, or subtract from, a number stored in a register.



Figure 6-2. 32-bit instruction word format.



Figure 6-3. 32-bit fixed-point word format.



Figure 6-4. 32-bit floating-point word format.

For example, a typical instruction might be to load the contents of memory at the value in R2, add 8, and place the result into R5. This could be followed by a second instruction to add the contents of R5 and -1, and place the result into R6. A third instruction could be to branch if the previous result is 0.

In addition to instruction words there are data words. The numbers in the data are called operands because they are operated on by the instruction set. Operands are defined as objects of a mathematical operation. There are two basic types of data words: fixed-point and floating-point. Fixed-point data words are most common. Fixed-point is further divided into signed and unsigned data. Unsigned data is the simplest since all the bits in the data word signify the magnitude of the number.

Signed numbers are represented in two's complement form. A two's complement number can be negated (turned negative) by taking the complement of the number and then adding one. For example, bits 111 as an unsigned value would be -1 as a two's-complement value, because 111 would be complemented to 000 and adding one would result in decimal -1 as negated. Likewise, bits 110 as an unsigned value would be -2 as a two's-complement value, bits 101 as an unsigned value would be -3 as a two's-complement value, etc. A 32-bit two's complement signed number can hold values from $-2^{31}-1$ to 2^{31} .

As shown in *Figure 6-3*, for signed data, the first bit is the sign, whereby logic 0 is plus (+) and logic 1 is minus (-). The remaining bits signify the magnitude of the number. Floating-point data words are used for numbers that need to be expressed in scientific notation. After the sign bit, the 8 bits that follow are used to express the exponent with the remaining 23 bits reserved for the multiplier, as shown in *Figure 6-4*.

SOFTWARE

Software, unlike hardware, is not a physical entity that can be touched. Instead, software specifies the operations to be performed on data. Data is used as operands by the computer instructions. Instructions can reside in either programs or in algorithms. Think of programs as arithmetic and logic operations described as a sequence of steps that implement an algorithm.

There are two basic types of software, system software and application software. The system software is designed to directly operate the computer hardware. The system software includes the operating system and the I/O device drivers. The operating system instructs the overall computer operation, including start-up, file management, initiating the device drivers, and providing data input and output. It manages resources and provides common services for application software programs that runs on top of the operating system, as shown in *Figure 6-5*. The application programs provide specific functions (e.g., Microsoft Word on a Personal Computer) to the user under the supervision of the operating system.

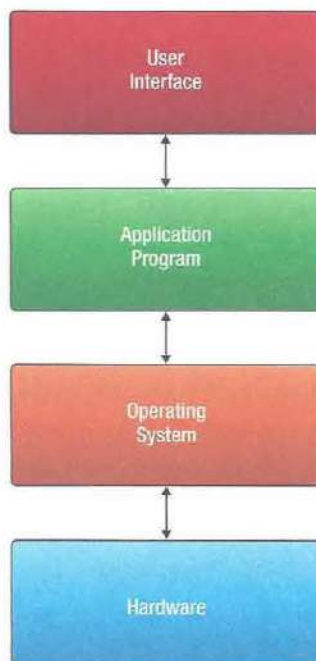


Figure 6-5. Application programs run on top of the operating system.

Software programs are usually written in a high-level programming language, such as C++, which is closer to natural language, and as such, is much easier and more efficient for a programmer to write than machine language. The high-level model-based source code is

then translated into executable object code (machine language) via a software program called a compiler or an interpreter. The difference is that a compiler reads the entire source code before it generates the object code, while the interpreter reads one instruction at a time, produces the object code, and executes the instruction before reading the next instruction. Compiled programs execute much faster than interpreted programs, and for this reason, are the only programs used for avionics software development. (*Figure 6-6*)



Figure 6-6. High-level source code converted in to object code (machine language).

As an alternative, small compact software programs may be directly written in low-level assembly language, which is a mnemonic representation of machine language (such as using the word "sub" for subtract). Assembly language is translated into machine language using a software program called an assembler. A high-level software command may include several assembly language instructions.

HARDWARE

Figure 6-7, illustrates what is known as the John von Neumann architecture after its discoverer who was the first to present the idea of stored program computers. It consists of a Central Processing Unit (CPU), which contains the Arithmetic Logic Unit (ALU), Control Unit (CU), and Main Memory Unit. It typically interfaces to external secondary memory storage and to input and output devices (called peripherals), such as a keyboard, mouse, display, printer, etc.

CENTRAL PROCESSING UNIT

A CPU microprocessor, such as the Intel Pentium 4 (*Figure 6-8*), retrieves and processes instructions and coordinates the flow of data throughout the computer. It performs math and logic calculations and sends data to and retrieves data from memory and other storage devices. The CPU contains registers, an Arithmetic Logic Unit (ALU), and a Control Unit (CU). The registers provide a temporary storage area to manipulate

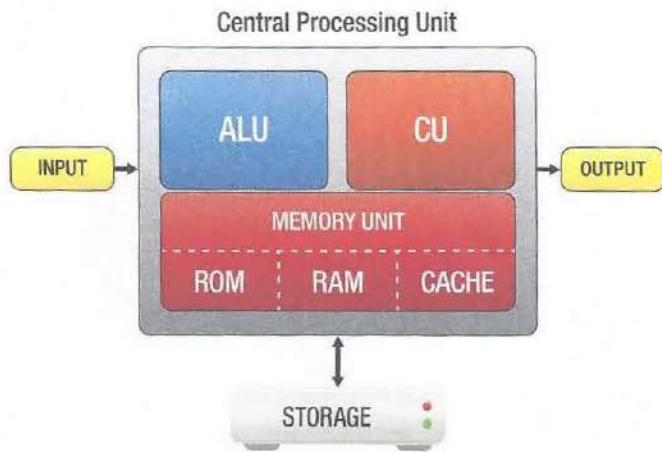


Figure 6-7. Components of the Central Processing Unit.

data during computations. The ALU combines values from the registers, such as adding numbers from different registers, and enters new values in to the registers. Most computer operations are executed in the ALU.

The Control Unit (CU), supervises overall CPU operations, controls the ALU, initiates I/O functions, and decodes instructions to determine whether to add, subtract, multiply, divide, compare, or some other operation. The CU directs the data path between the registers and the ALU to perform a sequence of operations, such as moving an integer from a register to the ALU to execute a given instruction. The CU ensures that an operation is not initiated until the preceding operation is completed.

To execute an instruction, the CPU divides the action to be performed into a sequence of basic steps such that each step will be completed in one clock cycle. The higher the clock speed, the more instructions the computer can execute in any given amount of time. CPU speeds are



Figure 6-8. Intel Pentium 4 32-bit microprocessor.

measured in cycles per second, known as Hertz or Hz. One cycle represents a single task executed, such as adding together two numbers. Computer clock speeds are measured in Gigahertz (GHz), or one billion (10^9) cycles per second. The widely used Intel Pentium 4 runs at clock speeds of 1.3 GHz to 3.8 GHz.

MEMORY (RAM, ROM, PROM)

Computer programs and data are stored in memory as coded binary digits (bits). There are two basic types of main memory, Random-Access Memory (RAM) and Read-Only Memory (ROM). The CPU can "randomly" add or remove data from RAM. As such, RAM is typically faster than ROM. The data portion of programs must reside in RAM during their execution. Because of the increased speed of RAM, the instruction portion of most programs is also in RAM. This is different from Read-Only Memory (ROM), which permanently stores data that can't be changed via "random" writes by the CPU. ROM keeps the data stored even after the power has been removed, thus it is termed non-volatile memory. In addition, the CPU has contained within its chip a small RAM cache storage area for frequently used data. The CPU will always access its internal cache memory before retrieving additional data from the main memory or secondary (external storage) memory.

True ROM chips are manufactured with object code stored on the chip. This is known as firmware. A variation of ROM are Programmable Read-Only Memory (PROM) chips that are manufactured blank with no instruction sets. PROMs are programmed after manufacture by plugging them into a PROM programmer where setting of each bit is locked. An ordinary PROM can't be changed once programmed. However, an Erasable PROM (EPROM) can be reprogrammed in the field using ultraviolet light, and an Electrically Erasable PROM (EEPROM) can be block erased and byte-written while the computer is running. Flash memory, which is faster than EEPROM, also allows memory to be erased and reprogrammed in to blocks of memory. EEPROM and Flash are used for applications that require periodic updates, such as Operational Flight Programs (OFPs), which control the overall avionic systems operation. Other types of non-volatile memory include secondary data storage, such as rotating hard-disk drives and solid-state flash hard drives.

INTEGRATED CIRCUITS

The CPU is essentially a microprocessor contained within an integrated circuit (IC). ICs are nothing more than many complete, digital electronic circuits constructed in the same basic location. The location is known as a chip or processor, microchip or microprocessor. TTL or CMOS circuits are miniaturized and manufactured on tiny, thin, silicon semiconductor wafers. Assemblies with billions of transistors can fit on a chip the size of a fingernail. (Figure 6-9) With so many transistors and logic gates, computer systems with increasingly computational power are achieved.

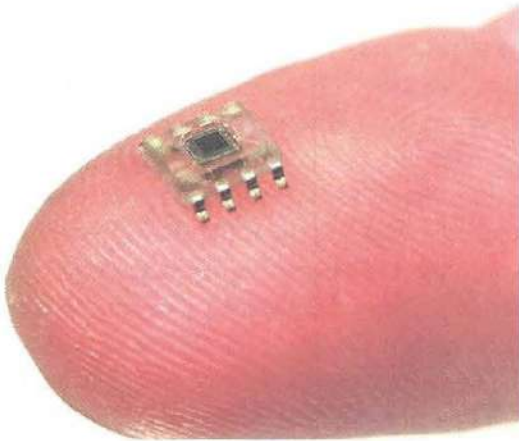


Figure 6-9. Integrated circuits.

Integrated circuits are used in nearly every modern computing and electronic device, including the many electronic devices found on aircraft. The microscopic circuits are constructed directly on the silicon chip during manufacture and cannot be removed or separated. A microprocessor contains one (or more) integrated circuit microchips at the core of the processing unit. It responds to inputs in accordance with instructions contained in its own memory. Due to the physical limitations of placing integrated circuits on a single chip, electronic developers have created microprocessors that combine the use of more than one chip in an architecture. These enable extremely fast processing due to the proximity of the integrated circuits to each on the tiny chip assemblies.

To facilitate the use of integrated circuits and other electronic components, standards have been developed.

The Dual In-line Package (DIP) standard allows the installation of micro-components onto printed circuit boards. It basically calls for two rows of connecting terminals, equal-spaced along each edge of the IC

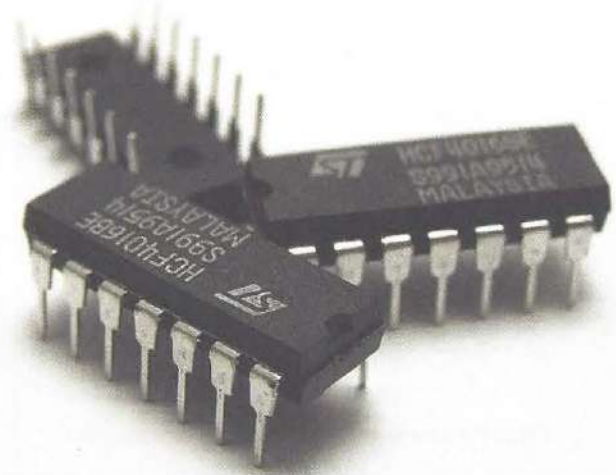


Figure 6-10. A DIP element containing a microprocessor and connection terminals for installation on a printed circuit board.

housing as shown in Figure 6-10. The dimensions of the terminals are standardized as is their use (e.g., power, ground, output, etc.). They come in a variety of sizes with various numbers of terminals. Inside a DIP element there can be transistor circuits, logic circuits and even complete integrated circuits and microprocessors.

AIRCRAFT COMPUTER SYSTEMS

Regardless of the application, all computers have a CPU, a memory and an I/O system. The only difference between business and personal computers and aircraft flight and navigational computers lies in the environment that the computer is designed to operate, the type of external serial data bus system that it interfaces to, and the external hardware devices (peripherals) that are used for control and display of the computer systems.

Aircraft computer systems must be designed to operate in extreme temperature, acceleration, vibration, shock and EMI environments that would not be encountered in a controlled office setting. Also, flight-critical aircraft computer systems must be certified to be fail-safe, such that hardware or software errors can't cause a catastrophic safety-of-flight incident.

Typical peripherals for a Flight Management Computer (FMC) are cockpit displays, an external secondary data storage device, and a Control and Display Unit (CDU). The external secondary data storage device is known as a Data Transfer System (DTS). It is used for

uploading navigation flight plans to the FMC and for downloading maintenance data. A CDU is a keyboard input device with a small display located in the cockpit center console for entering and retrieving flight

management information. As shown in *Figure 6-11*, most aircraft will have two CDUs and two FMCs for redundancy purposes, so if one system fails, the crew will always have a back-up.

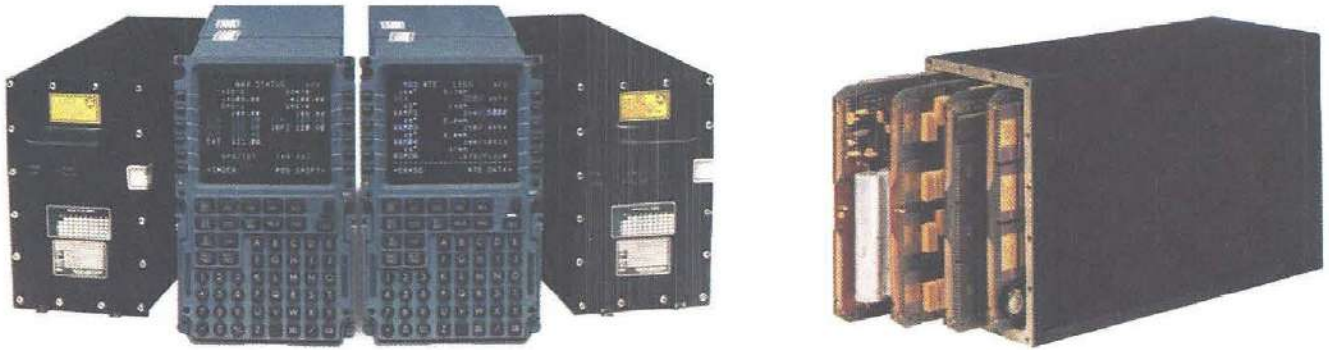


Figure 6-11. Typical aircraft computer system used for flight management.

Question: 6-1

What are the three basic components of a computer and what are their functions?

Question: 6-5

What is the difference between a compiler and an interpreter?

Question: 6-2

Explain the differences between serial data buses and parallel data buses.

Question: 6-6

What are the three main components of a Central Processing Unit (CPU) and what functions do each of these components perform?

Question: 6-3

What are instruction words

Question: 6-7

Explain the difference between Random-Access Memory (RAM) and Read-Only Memory (ROM).

Question: 6-4

What function does the system software perform?

Question: 6-8

What is an Integrated Circuit (IC)?

ANSWERS

Answer: 6-1

The basic structure of a computer consists of a Central Processing Unit (CPU), Main Memory, and an Input and Output (I/O) system. The CPU is the "brain" of the computer. It retrieves and executes instructions stored in memory and coordinates the flow of data throughout the computer in a synchronous manner controlled by the clock timing signals. The Main Memory stores the information for later access by the CPU. The I/O system facilitates communication with other onboard computers and to their operators through external serial data buses.

Answer: 6-2

Serial buses differ from parallel buses in that one bit of information is transmitted or received one bit at a time on a single line in a serial fashion, rather than information being sent all at once over multiple lines, as is done with a parallel bus. Parallel buses tend to be short and are internal to the computer, where most serial data buses are external to the computer. Buses that connect the I/O system with external input and output devices, such as displays and storage, are serial buses.

Answer: 6-3

Instructions words retrieved from Main Memory tell the CPU what operation to perform on the data. The instructions are a series of steps such as "branch" to a new instruction, perform a mathematical operation on the data, write the data back into Main Memory, read from the I/O system or write to the I/O system.

Answer: 6-4

The system software is designed to directly operate the computer hardware. The system software includes the operating system and the I/O device drivers. The operating system instructs the overall computer operation, including start-up, file management, initiating the device drivers, and providing data input and output. It manages resources and provides common services for application software programs that runs on top of the operating system.

Answer: 6-5

The difference is that a compiler reads the entire source code before it generates the object code, while the interpreter reads one instruction at a time, produces the object code, and executes the instruction before reading the next instruction. Compiled programs execute much faster than interpreted programs, and for this reason, are the only programs used for avionics software development.

Answer: 6-6

The CPU contains registers, an Arithmetic Logic Unit (ALU), and a Control Unit (CU). The registers provide a temporary storage area to manipulate data during computations. The ALU combines values from the registers, such as adding numbers from different registers, and enters new values in to the registers. The Control Unit, supervises overall CPU operations, controls the ALU, initiates I/O functions, and decodes instructions to determine whether to add, subtract, multiply, divide, compare, or some other operation.

Answer: 6-7

RAM is typically faster than ROM because the CPU can randomly add or remove data from RAM. Because of its increased speed, the instruction portion of most programs is also in RAM. This is different from ROM, which permanently stores data that can't be changed via random writes by the CPU. ROM keeps the data stored even after the power has been removed, thus it is termed non-volatile memory.

Answer: 6-8

ICs are nothing more than many complete, digital electronic circuits constructed in the same basic location. The location is known as a chip or processor, microchip or microprocessor. A CPU is essentially a microprocessor contained within an IC.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

MICROPROCESSORS

SUB-MODULE 07

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A	B1
-	-

Sub-Module 07 MICROPROCESSORS Knowledge Requirements

5.7 - Microprocessors

Functions performed and overall operation of a microprocessor;
Basic operation of each of the following microprocessor elements: control and processing unit, clock, register, arithmetic logic unit.

*This sub-module does not apply to category B-1.
Relevant subject matter for category B-2 are defined in Module 05B.*



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

INTEGRATED CIRCUITS

SUB-MODULE 08

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A B1

Sub-Module 08 INTEGRATED CIRCUITS Knowledge Requirements

5.8 - Integrated Circuits

- Operation and use of encoders and decoders;
- Function of encoder types;
- Uses of medium, large and very large scale integration.

CERTIFICATION CATEGORY →	A	B1
5.8 - Integrated Circuits	-	-

*This sub-module does not apply to category B-1.
Relevant subject matter for category B-2 are defined in Module 05B.*



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

MULTIPLEXING

SUB-MODULE 09

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A

B1

Sub-Module 09
MULTIPLEXING
Knowledge Requirements

5.9 - Multiplexing

Operation, application and identification in logic diagrams of multiplexers and demultiplexers.

-

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*This sub-module does not apply to category B-1.
Relevant subject matter for category B-2 are defined in Module 05B.*



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

FIBER OPTICS

SUB-MODULE 10

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A	B1
1	1

Sub-Module 10 FIBER OPTICS Knowledge Requirements

5.10 - Fiber Optics

- Advantages and disadvantages of fiber optic data transmission over electrical wire propagation;
- Fiber optic data bus;
- Fiber optic related terms;
- Terminations;
- Couplers, control terminals, remote terminals; Application of fiber optics in aircraft systems.

Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

FIBER OPTICS

ADVANTAGES AND DISADVANTAGES

Sub-module 04 discussed various digital data buses, such as MIL-STD-1553B and ARINC 629, which use shielded twisted-pair copper wires for transmitting information at data rates of one to two millions bits per second (Mbps). From 2 Mbps to 50 Mbps, coaxial cable is the preferred transmission medium.

Coaxial cable, also known as coax, consists of a center wire conductor surrounded by a semi-rigid insulator. Surrounding the wire and the insulator material is a conductive, braided cover that runs the length of the cable. Finally, a waterproof covering is set around the braided shield to protect the entire assembly from the elements. The braided cover in the coax shields the inner conductor from any external electro-magnetic fields. It also prevents the fields generated by the internal conductor from radiating. (*Figure 10-1*)

Aircraft networks, such as AFDX and Firewire, with data rates running as high as 1000 Mbps (1 Gbps), require the use of fiber optic cables to reliably transmit large bandwidths of information.

As shown in *Figure 10-2*, a fiber optic cable consists of the core, which is a thin glass or plastic center where the light travels, surrounded by an outer optical

Besides having a high data-rate capability and a wide bandwidth to carry more information, optical buses exhibit extremely low loss and low crosstalk since there is no line capacitance or mutual coupling. The reason why optical cables exhibit such low loss is because there is very little attenuation, or reduction in signal strength, over long distances as compared to copper wire. Cables made from silica glass fibers have the lowest attenuation, and as such, are widely used in the telecommunications industry for large bandwidths and long distances. Plastic fibers are less expensive, extremely rugged and have a tight bend radius, but exhibit a higher loss.

Tensile strength is the ability of a fiber or wire to be stretched without breaking. Copper wire must have twice the diameter to have the same tensile strength as a glass fiber. When installing fiber cable, care must be taken not to exceed its recommended bend radius since a sharp bend will decrease the tensile strength and may snap the glass. Sharp bends will also increase attenuation since the bends change the angle of incidence and reflection of the light.

The chief advantage of optical cables are that they are immune from Electro-Magnetic Interference (EMI). Copper conductors will act like antennas, either transmitting or receiving energy. Copper wires connecting avionics equipment can be one of the main sources of EMI, which can cause errors to occur during



Figure 10-1. Coaxial Cable typically used for data rates of 2Mbps to 50Mbps.

material, called a cladding, which reflects the light back into the core, and a black polyurethane outer jacket over the cladding to protect the cable from damage and moisture. If the fibers in the core are made from glass there will also be a plastic coating applied to the cladding, called a buffer jacket, to provide additional protection. Materials made from fiberglass or Kevlar add mechanical strength to the cable.



Figure 10-2. Typical fiber optic cable.

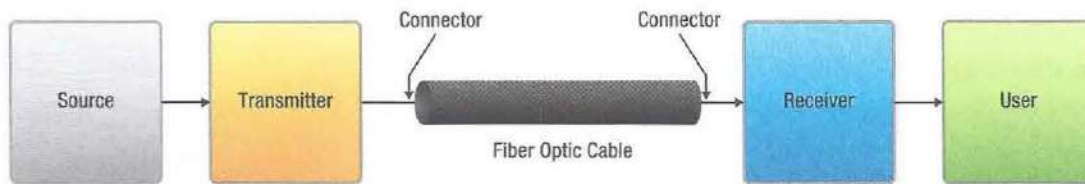


Figure 10-3. Basic fiber optic link.

digital data transmissions. Optical cables can also withstand nuclear radiation in that the fibers will not short out if their jackets melt.

All though optical cables are lighter than copper cables, they are generally more expensive and require the use of optical transmitters and receivers. In addition, fibers are more difficult and expensive to splice than copper wires. However, the advantages of fiber optic networks far outweigh the disadvantages of electrical data buses for the reasons stated above.

FIBER OPTIC DATA BUS

A fiber optic data bus operates basically the same as an electrical data bus except that the fiber carries light instead of electricity. As shown in *Figure 10-3*, a basic fiber optic link connects two electrical circuits from the data source to the data sink (user) using a light source, transmitter, fiber optic cable, and receiver to provide information to the user. The light source can be either a LED or laser diode. The laser diode has a higher output power and faster speed than an LED, but it costs more. The transmitter converts electrical signals into light pulses and sends the pulses over the fiber optic cable to the receiver.

The purpose of the receiver is to rebuild the signals back to their original state as they were presented to the transmitter. The two basic parts of the receiver are the photocell, also called a photodiode detector, which converts the light back into an electrical signal; and the output circuit, which amplifies and reshapes the signal back into its original digital data stream. Clock information is either contained in the transmitted signal or the receiver may provide its own timing information to decode and reshape the digital pulse train.

RELATED TERMS

There are two types of fiber-optic cables that are available, single mode and multimode. As shown in *Figure 10-4*, many beams of light travel through the multimode cable bouncing off of the cable walls. Attenuation is caused by

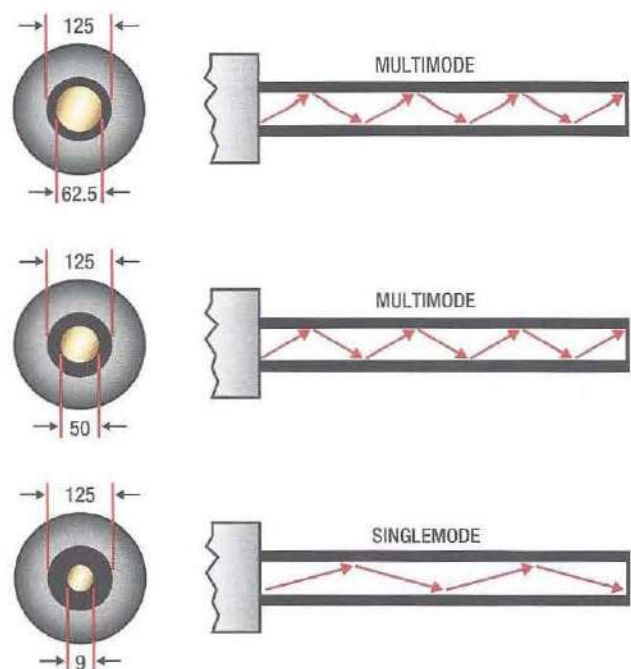


Figure 10-4. Multimode versus Singlemode fiber.

the scattering and absorption of light as it travels down the fiber core. Light is reflected off the cladding, which acts like a mirror so that light can bend along its length. Scattering re-directs light out of the core to the cladding and absorption occurs when the light is not reflected back into the core, but instead is absorbed by the coating due to imperfections in the optical material. Single-mode fiber uses a single direct beam of light, thus allowing for greater distances and increased transfer speeds. Common types of fiber optic cable include the 62.5 micron core with 125 micron cladding multimode cable, 50 micron core with 125 micron cladding multimode cable, and the 9 micron core with 125 micron cladding single mode cable.

TERMINATIONS

Unlike copper wire, fiber optic cables can't be soldered or crimped to make a low resistance connection; however, it is equally important that fiber optic terminations couple light from one component to another with as little loss of optical power as possible.

The key to low loss is precise alignment of the mated fiber cores so that nearly all the light is coupled from one fiber across the junction to the other fiber.

Fibers must be checked for precise perpendicularity and end finish prior to termination. Mismatches can occur due to variations in tolerances between the diameter and concentricity of the core and cladding. In addition, connectors and splices can contribute to insertion losses due to variations in lateral displacement, end separation, angular misalignment and surface roughness.

The scribe-and-break method is commonly used to prepare fibers for termination. A cutting tool scribes a small nick across the cladding. The blade is then pulled across the stationary fiber. After scribing, pressure is increased on the cable by pulling it resulting in a clean break with a mirror-like finish. Once the fiber is prepared, splices can be made either by fusion or by using elastomeric inserts held within a glass sleeve. A fusion splice is accomplished by placing the two fibers on the V-groove of a splicing tool alignment block. The alignment is adjusted while viewing it through a microscope. Once aligned, an electric arc is applied. The localized heating softens the butted fiber ends and surface tension is applied during the fusion process. The finished splice is then encased in epoxy and heat-shrink tubing for protection.

Aircraft applications commonly use SMA (Sub-Miniature Version A) fiber optic connectors due to their ruggedness. An SMA connector consists of a metal body assembly with a precision hole in the tip. A stripped fiber, held within the alignment ferrule, is inserted into the body assembly and secured with epoxy. Strength members in the cable are then crimped between the body assembly and the eyelet to provide rigidity. The excess fiber is removed and then polished to the desired length and optical finish. The connector mates in a sleeve bushing with a screw-type coupling mechanism which provides a secure and aligned fit. (*Figure 10-5*)



Figure 10-5. Standard SMA fiber optic cable connector.



Figure 10-6. Four-port directional coupler.

light entering port 2 should only exit ports 3 and 4. Losses will naturally occur within the coupler due to scattering, absorption, reflections and cable misalignment.

Another type of coupler is the tee coupler, shaped as a "T", and used in the MIL-STD-1773 fiber optic data bus equivalent of MIL-STD-1553B. A tee coupler at each remote terminal splits off a portion of the light from the data bus and carries it to the fiber optic transceiver in each terminal. The disadvantage of the tee coupler is that the optical power loss increases proportionally to the number of terminal nodes on the bus.

A star coupler, as shown in *Figure 10-7*, has multiple ports to distribute the optical power point-to-point to multiple terminals. Unlike the tee coupler, the insertion loss does not increase directly with the number of terminals; and therefore, it is well suited for connecting a large number of terminals to the fiber optic network.

Directional couplers, tee couplers, and star couplers are called passive couplers because they allow the equal division of light between all the terminal nodes that are connected to them. However, an optical switch, such as used in the Avionics Full-Duplex Switched Network (AFDX) only allows light to be coupled from one fiber to another but not to both.



Figure 10-7. A six-port star coupler.

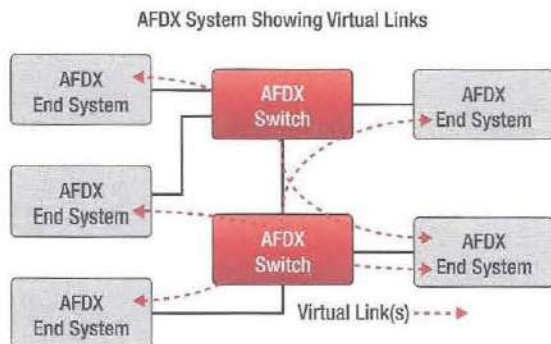


Figure 10-8. AFDX fiber optic network with active switches.

As shown in *Figure 10-8*, it permits one of two circuit paths to be chosen depending on the switch setting. This active switch uses a relay to physically move the fiber between two or more positions. A fiber network failure may be observed as an increase in the bit error rate or a total failure in data transmission, which could be the result of a broken fiber, a source with no optical output, or circuit failure where this is a loss of modulation.

No optical output could be caused by a laser that no longer reaches its threshold where simulated emission occurs. It is important to note that fiber optic cable breakages do not cause intermittent failures, unlike copper wire.

APPLICATIONS IN AIRCRAFT SYSTEMS

All though fiber optic networks are beginning to appear in some modern flight and engine control systems, they are more prevalent in In-Flight Entertainment (IFE) systems due to their high bandwidth characteristics. (*Figure 10-9*)

Currently in development is a Fourth Generation Cabin Distribution System standard, which locates an active fiber optic data switch below the floor panels with fiber optic cabling routed to each of the passenger seats.



Figure 10-9. Panasonic IFE system installed on a Boeing 737-800.

Question: 10-1

Explain the physical construction of a fiber optic cable.

Question: 10-5

What is key to ensure that fiber optic terminations couple light from one component to another with as little loss of optical power as possible?

Question: 10-2

What are the advantages and disadvantages of fiber optics over copper wire?

Question: 10-6

What is the advantage of a star coupler over a T-coupler?

Question: 10-3

Describe the components of a fiber optic data bus and how it operates.

Question: 10-4

What is the difference between multimode and single-mode fiber optic cable?

ANSWERS

Answer: 10-1

A fiber optic cable consists of the core, which is a thin glass or plastic center where the light travels, surrounded by an outer optical material, called a cladding, which reflects the light back into the core, and a black polyurethane outer jacket over the cladding to protect the cable from damage and moisture. A plastic coating applied to the cladding, called a buffer jacket, provides additional protection. Materials made from fiberglass or Kevlar add mechanical strength to the cable.

Answer: 10-2

Besides having a high data-rate capability and a wide bandwidth to carry more information, optical buses exhibit extremely low loss and low crosstalk since there is no line capacitance or mutual coupling. Optical cables are immune from electro-magnetic interference (EMI) and can withstand nuclear radiation. All though optical cables are lighter than copper cables, they are generally more expensive and are more difficult to splice than copper wires.

Answer: 10-3

A fiber optic link connects two electrical circuits from the data source to the data sync using a light source, transmitter, fiber optic cable, and receiver. The light source will be either a LED or laser diode. The transmitter converts electrical signals into light pulses and sends the pulses over the fiber optic cable to the receiver. The photocell detector and output circuit in the receiver decodes the light pulse and converts the signals back to their original electrical state.

Answer: 10-4

Many beams of light travel through the multimode cable bouncing off of the cable walls. Attenuation is caused by the scattering and absorption of light as it travels down the fiber core. Single-mode fiber uses a single direct beam of light, thus allowing for greater distances and increased transfer speeds without suffering from scattering and absorption losses.

Answer: 10-5

The key to low loss is precise alignment of the mated fiber cores so that nearly all the light is coupled from one fiber across the junction to the other fiber. Fibers must be checked for precise perpendicularity and end finish prior to termination. Mismatches can occur due to variations in tolerances between the diameter and concentricity of the core and cladding. In addition, connectors and splices can contribute to insertion losses due to variations in lateral displacement, end separation, angular misalignment and surface roughness.

Answer: 10-6

A star coupler has multiple ports to distribute the optical power point-to-point to multiple terminals. Unlike, the tee coupler, the insertion loss does not increase directly with the number of terminals; and therefore, it is well suited for connecting a large number of terminals to the fiber optic network.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

ELECTRONIC DISPLAYS

SUB-MODULE 11

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A **B1**

Sub-Module 11 ELECTRONIC DISPLAYS Knowledge Requirements

5.11 - Electronic Displays

Principles of operation of common types of displays used in modern aircraft, including Cathode Ray Tubes, Light Emitting Diodes and Liquid Crystal Display.

- 2

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- The applicant should be able to understand the theoretical fundamentals of the subject.
- The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

ELECTRONIC DISPLAYS

CATHODE RAY TUBES

As previously stated, "glass cockpits" evolved in the early 1970's that were more much more reliable than mechanical or electro-mechanical analog instruments, and had the advantage of combining several flight and navigation functions into one display to provide the crew with greater situational awareness. Initially, glass cockpits used Cathode Ray Tube (CRT) technology.

As shown in *Figure 11-1*, a CRT is a vacuum tube with an electron gun that sends a beam of electrons to a fluorescent screen. The electrons are accelerated through a hole in the anode by the voltage difference between the cathode and the anode. The electron beam is steered by horizontal and vertical deflection plates on to any position on the screen. The electron beam striking the phosphor on the screen causes this point on the screen to emit light. The light intensity is changed by changing the anode voltage, which can be as high as 20 000 volts.

In a color display, the screen is coated with a pattern of phosphor dots doped to emit three primary colors: Red, Green, and Blue (RGB). Three electron guns, one for each color, converge on a thin foil shadow mask with holes aligned to a RGB phosphor dot triad, which forms a pixel (picture element). The combination of these three primary colors can produce any number of colors and hues depending on the intensity of each electron beam on their respective pixels. (*Figure 11-2*)

The image on the CRT is made by sweeping the electron beam horizontally from left to right, one line after the other. The display resolution varies depending on the number of lines. For example, a display resolution of 1024×768 means that the screen width is 1024 pixels and the height is 768 pixels for a total of 786 432 pixels. The human eye will not notice the flicker of the image if the image changes at least every 30 milliseconds. Therefore, CRTs typically have a 60 Hz refresh rate meaning that the screen is updated every $1/60$ of a second or 16.7 milliseconds.

This line-by-line scanning technique common in everyday television CRTs is known as raster. Raster is well suited for quickly filling in the background for artificial horizon, digital map and weather radar display formats. However, cockpit displays also use a technique

called stroke or vector graphics to precisely draw symbology overlaid on the raster background. With stroke graphics, the display is sent voltage point pairs and a beam draws a line in one stroke from the last point to the current point. The display processor generates the points that define the shape to send to the display and a Digital-to-Analog Converter (DAC) converts these digital signal points to voltages for the CRT.

LIGHT EMITTING DIODES

Due to their large volume, weight and power requirements, vacuum tube CRT displays have largely been displaced by solid-state displays, such as Light Emitting Diodes and Liquid Crystal Displays.

Light Emitting Diodes (LEDs) operate on the principle of electroluminescence, which is a term used to describe a phenomenon whereby light emission is caused by

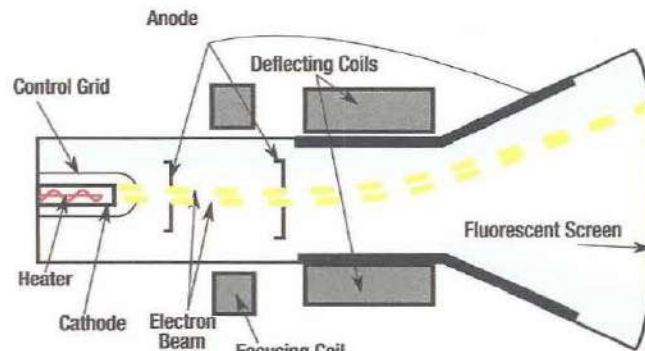


Figure 11-1. Operation of a cathode ray tube.

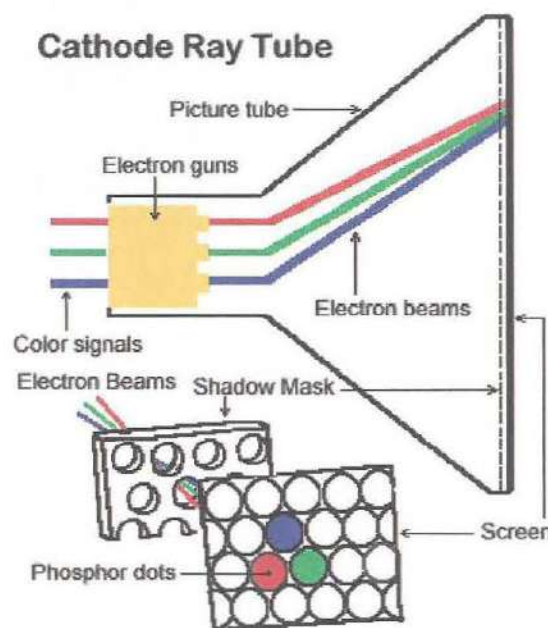


Figure 11-2. Color CRT has 3 electron guns and RGB phosphor dots.

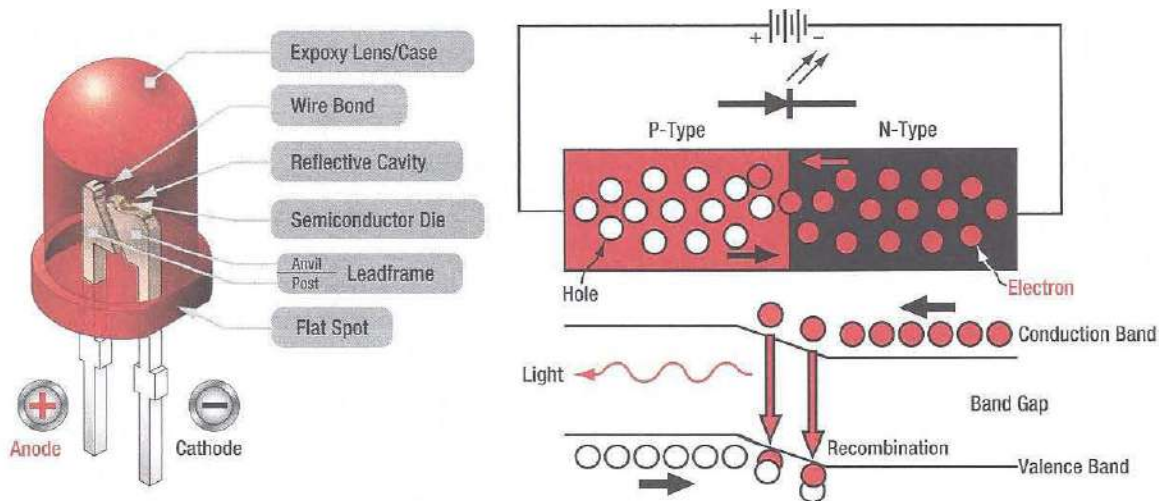


Figure 11-3. An LED producing light by electrons dropping into holes and giving off energy.

the application of an electric current. Light contains electromagnetic energy that is carried by photons. The amount of energy depends on the frequency of light of the photon. This energy can be very useful in the operation of electronic devices since all semiconductors are affected by light energy. LEDs are used for indicator lights, digital readouts, backlighting of liquid crystal display screens, and light sources for fiber optic transmitters. As a cockpit display, LEDs have very good brightness and contrast; however, their resolution is limited to only about 64 cells per inch.

LEDs are simple and reliable. They are constructed of semiconductor material. When a free electron from a semiconductor drops into a semiconductor hole, energy is given off. This is true in all semiconductor materials. However, the energy released when this happens in certain materials is in the frequency range of visible light. *Figure 11-3* illustrates the anatomy of a single LED, the symbol of an LED, and a graphic depiction of the LED process. Note that when the diode is reversed biased, no light is given off. However, when the diode is forward biased, the energy given off is visible in the color characteristic for the material being used. *Figure 11-4* is a table that delineates common LED colors and the semiconductor material that is used in the construction of the diode.

As stated in the previous sub-module, a fiber optic transmitter has an LED source and a fiber optic receiver contains a photodiode detector, which converts the light back into an electrical signal. When a photon strikes a semiconductor atom, it raises the energy level above what is needed to hold its electrons in orbit. The extra

energy frees an electron enabling it to flow as current. The vacated position of the electron becomes a hole. In photodiodes, this occurs in the depletion area of the reversed biased PN (positive-negative) junction turning on the device and allowing current to flow. *Figure 11-5* illustrates a photodiode in a coil circuit. In this case, the light striking the photodiode causes current to flow in the circuit whereas the diode would have otherwise blocked it. The result is the coil energizes and closes another circuit enabling its operation.

LIQUID CRYSTAL DISPLAYS

CRTs and LEDs are emissive displays in that they both generate their own light. However, Liquid Crystal Displays (LCDs) are non-emissive in that they require an external light source to operate. Liquid crystals consist of molecules that are elongated or rod-shaped. When the crystals are placed on a surface that has a pattern of parallel grooves, the elongated molecules will align themselves with the grooves. An LCD cell is constructed by placing the crystals between two grooved glass plates where the grooves on the top plate are aligned 90 degrees perpendicular to the bottom plate. This causes the liquid crystals to twist as they move from top to bottom.

The LCD cells are sandwiched between two glass polarizer plates with a fluorescent light source behind one of the plates. If the two polarizers were oriented in the same direction, light would pass through. However, if the two polarizer plates are placed orthogonal to each other, the light would be blocked from passing, if not for the liquid crystals that twist the light as it passes through the cell. As shown in *Figure 11-6*, when light is applied to the left polarizer with the light projected

Color	Wavelength (nm)	Voltage (V)	Semiconductor Material
Infrared	$\lambda > 760$	$\Delta V < 1.9$	Gallium arsenide (GaAs) Aluminium gallium arsenide (AlGaAs)
Red	$610 < \lambda < 760$	$1.63 < \Delta V < 2.03$	Aluminium gallium arsenide (AlGaAs) Gallium arsenide phosphide (GaAsP) Aluminium gallium indium phosphide (AlGaInP) Gallium(III) phosphide (GaP)
Orange	$590 < \lambda < 610$	$2.03 < \Delta V < 2.10$	Gallium arsenide phosphide (GaAsP) Aluminium gallium indium phosphide (AlGaInP) Gallium(III) phosphide (GaP)
Yellow	$570 < \lambda < 590$	$2.10 < \Delta V < 2.18$	Gallium arsenide phosphide (GaAsP) Aluminium gallium indium phosphide (AlGaInP) Gallium(III) phosphide (GaP)
Green	$500 < \lambda < 570$	$1.9[32] < \Delta V < 4.0$	Indium gallium nitride (InGaN) / Gallium(III) nitride (GaN) Gallium(III) phosphide (GaP) Aluminium gallium indium phosphide (AlGaInP) Aluminium gallium phosphide (AlGaP)
Blue	$450 < \lambda < 500$	$2.48 < \Delta V < 3.7$	Zinc selenide (ZnSe) Indium gallium nitride (InGaN) Silicon carbide (SiC) as substrate Silicon (Si) as substrate — (under development)
Violet	$400 < \lambda < 450$	$2.76 < \Delta V < 4.0$	Indium gallium nitride (InGaN)
Purple	Multiple Types	$2.48 < \Delta V < 3.7$	Dual blue/red LEDs, blue with red phosphor, or white with purple plastic
Ultraviolet	$\lambda < 400$	$3.1 < \Delta V < 4.4$	diamond (235 nm)[33] Boron nitride (215 nm)[34][35] Aluminium nitride (AlN) (210 nm)[36] Aluminium gallium nitride (AlGaN) Aluminium gallium indium nitride (AlGaInN) — (down to 210 nm)[37]
White	Broad Spectrum	$\Delta V = 3.5$	Blue/UV diode with yellow phosphor

Figure 11-4. LED colors and the materials used to construct them.

parallel to its grooves, the polarization rotates by 90 degrees through the twisted liquid crystals, thereby allowing light to pass through the right polarizer that is aligned orthogonal to the left polarizer.

However, when an electric force field is applied to the liquid crystal cell in a direction normal to the cell's grooved surfaces, the molecules will align with the field and the twisting effect will be destroyed. The result is that there will be no polarization, and therefore, the light will be blocked from passing through the right polarizer - the cell will appear black.

As shown in *Figure 11-7*, the electric field is applied by electrodes that are sandwiched on either side of the liquid crystal. By controlling the voltage applied across the liquid crystal layer in each pixel, various amount of light can be allowed to pass thus constituting

different shades of gray or various levels of brightness. In addition, RGB filters can be inserted between the liquid crystal and the outside polarizer to form color displays.

ACTIVE MATRIX LIQUID CRYSTAL DISPLAY

A liquid crystal display made of a matrix of cells as described above is what is known as passive-matrix LCD technology whereby a pixel is turned on or off at the intersection of each row and column in the matrix to display information. This technology is suitable for low quality displays, but for Electronic Instrument Systems that require higher resolution, Active-Matrix Liquid Crystal Display (AMLCD) technology is more commonly used. AMLCDs are considerably more sophisticated, and thus more expensive, because a Thin-Film Transistor (TFT) switch is integrated on the electrode panel for each and every pixel. Since the transistors are individually controlled, the switching

speed and response time is much greater, thus the contrast ratio is greatly improved.

As illustrated in *Figure 11-8*, one side of the liquid crystal has a transparent indium tin oxide (ITO) electrode that is common for all pixels. The TFTs connect the pixels to power from the data line when they are turned on. Just as in passive-matrix LCDs, the image information is sent one line at a time. By choosing different levels of bias it is possible to have many shades of gray or many intensities of color. Color displays have three times the pixels in the horizontal direction as monochrome displays, thus a 640 × 380 display actually has 1920 × 480 pixels.

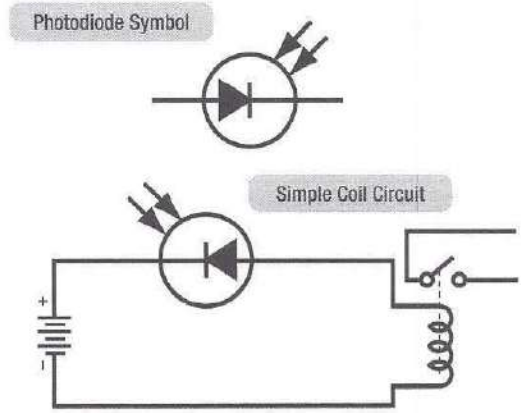


Figure 11-5. A photodiode in a simple coil circuit.

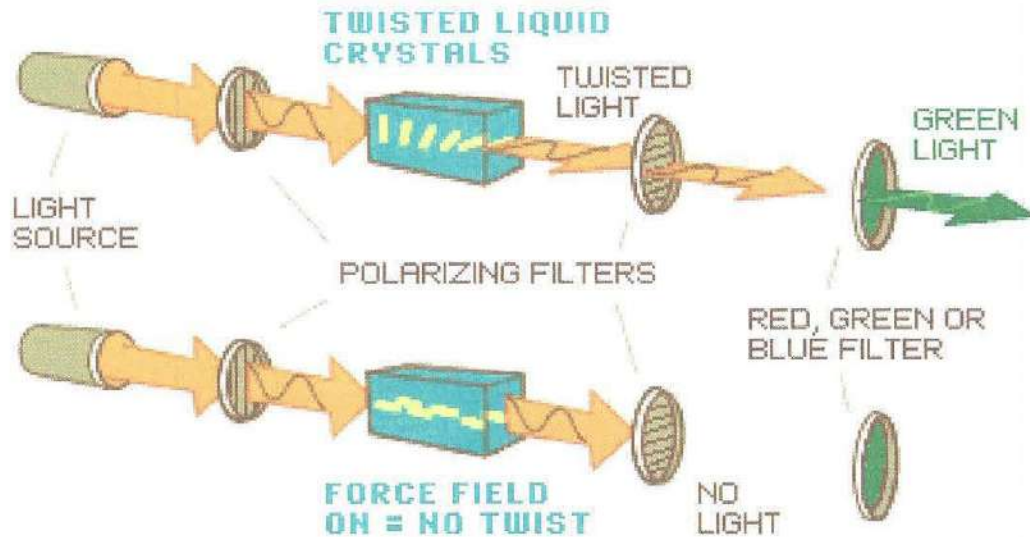


Figure 11-6. Twisted liquid crystals allow light to flow through the right polarizer.

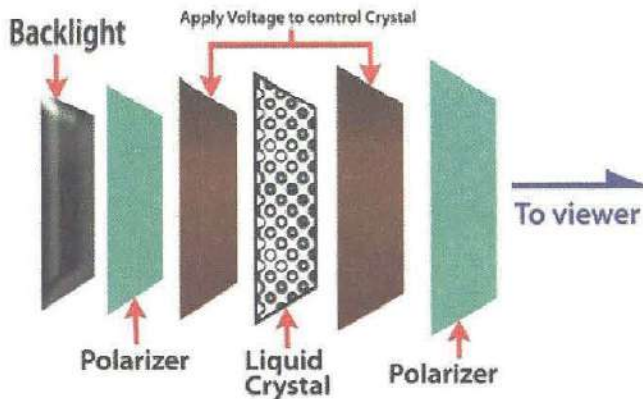


Figure 11-7. Basic liquid crystal cell.

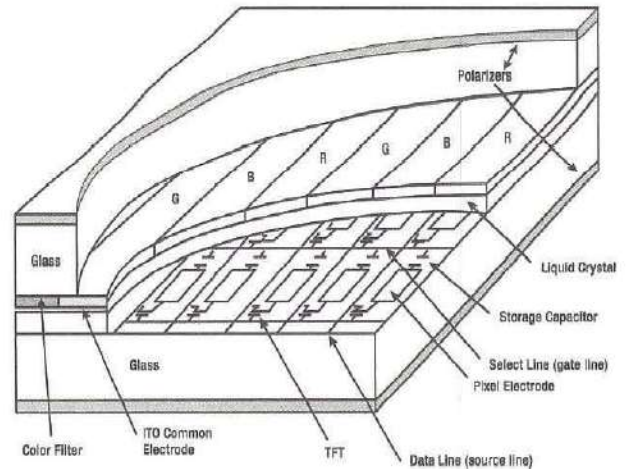


Figure 11-8. Cut-away view of an AMLCD.

Question: 11-1

Explain the operation of a Cathode Ray Tube (CRT) display.

Question: 11-4

Explain the operation of a Light Emitting Diode (LED).

Question: 11-2

How are colors generated in a Cathode Ray Tube (CRT) display?

Question: 11-5

Explain how liquid crystals behave when an electric field is applied.

Question: 11-3

What is the difference between raster scan and stroke scan?

Question: 11-6

What is the difference between a passive-matrix Liquid Crystal Display (LCD) and an active-matrix LCD in both operation and performance?

ANSWERS

Answer: 11-1

A CRT is a vacuum tube with an electron gun that sends a beam of electrons to a fluorescent screen. The electrons are accelerated through a hole in the anode by the voltage difference between the cathode and the anode. The electron beam is steered by horizontal and vertical deflection plates on to any position on the screen. The electron beam striking the phosphor on the screen causes this point (pixel) on the screen to emit light. The light intensity is changed by changing the anode voltage.

Answer: 11-2

In a color display, the screen is coated with a pattern of phosphor dots doped to emit three primary colors: Red, Green, and Blue (RGB). Three electron guns, one for each color, converge on a thin foil shadow mask with holes aligned to a RGB phosphor dot triad, which forms a pixel. The combination of these three primary colors can produce any number of colors and hues depending on the intensity of each electron beam on their respective pixels.

Answer: 11-3

Raster line-by-line scanning is well suited for quickly filling in the background for artificial horizon, digital map and weather radar display formats. However, cockpit displays also use a technique called stroke or vector graphics scanning to precisely draw symbology overlaid on the raster background. With stroke graphics, the display is sent voltage point pairs and a beam draws a line in one stroke from the last point to the current point.

Answer: 11-4

LEDs operate on the principle of electroluminescence, which is a term used to describe a phenomenon whereby light emission is caused by the application of an electric current. When a free electron from a semiconductor drops into a semiconductor hole, energy is given off. When the diode is forward biased, the energy given off is visible in the color characteristic for the material it is made of.

Answer: 11-5

When light is applied to one of the polarizers with the light projected parallel to its grooves, the polarization rotates by 90 degrees through the twisted liquid crystals, thereby allowing light to pass through the other polarizer. However, when an electric force field is applied to the liquid crystal cell in a direction normal to the cell's grooved surfaces, the molecules will align with the field and the twisting effect will be destroyed. The result is that there will be no polarization, and therefore, the light will be blocked from passing through the polarizer and the cell will appear black.

Answer: 11-6

With passive-matrix LCDs, a pixel is turned on or off at the intersection of each row and column in the matrix to display information. Active-Matrix Liquid Crystal Displays (AMLCD) are considerably more sophisticated, and thus more expensive, because a Thin-Film Transistor (TFT) switch is integrated on the electrode panel for each and every pixel. Since the transistors are individually controlled, the switching speed and response time is much greater, thus the contrast ratio is greatly improved.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

ELECTROSTATIC SENSITIVE DEVICES

SUB-MODULE 12

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A B1

1

2

Sub-Module 12

ELECTROSTATIC SENSITIVE DEVICES

Knowledge Requirements

5.12 - *Electrostatic Sensitive Devices*

Special handling of components sensitive to electrostatic discharges;

Awareness of risks and possible damage, component and personnel anti-static protection devices.

Level 1

A familiarization with the principal elements of the subject.

Objectives:

- (a) The applicant should be familiar with the basic elements of the subject.
- (b) The applicant should be able to give a simple description of the whole subject, using common words and examples.
- (c) The applicant should be able to use typical terms.

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

ELECTROSTATIC SENSITIVE DEVICES

RISKS AND POSSIBLE DAMAGE

Static electricity is a simple fact of nature. It is around us all the time and is caused by friction. Most work environments have non-conductive floors and no means of controlling the humidity. As the humidity drops below 20%, a static charge builds up on a person's body. The faster the person walks, the higher the charge. Simply walking across a carpet can generate 1 500 volts of static electricity at 65% relative humidity and up to 35 000 volts of static electricity at 20% relative humidity. Plastics used in most products will produce charges from 5 000 to 10 000 volts. Once the person sits down at the work station, the electrostatic field surrounding their body is enough to cause damage to sensitive electronic components without even touching them. However, when the person touches the component, an electrostatic discharge or spark occurs, and zap, the component is most certainly destroyed. (*Figure 12-1*)

Electro-Static Discharge (ESD) is defined in U.S. military handbook DOD-HK BK-263 as "transfer of electrostatic charges between bodies at different potentials caused by direct contact or induced by an electrostatic field". In other words, an electrostatic charge on one body can be imparted to another body through induction from an electromagnetic field, or through conduction via physical contact. If an electronic component that is charged is then suddenly grounded, the charge will dissipate to ground, but in the process, the component will be damaged due to excessive heat from breakdown of the dielectric material within the component.



Figure 12-1. Electrostatic discharge.

Electrostatic induction occurs when a charged object induces the redistribution of charges in another object. A classic example of this is picking up pieces of paper using a comb that was rubbed against fur. In *Figure 12-2*, the comb is charged negative, meaning that there exists an excess of electrons built up on the comb. The side of the paper closest to the comb will end up being slightly positive due to the attraction of opposite charges, while the opposite side of the paper will be slightly negative due to the repulsion of similar charges.

MIL-STD-1686C is the U.S. military standard for "ESD control programs for the protection of electrical and electronic parts, assemblies, and equipment". It recognizes two classes of ESD-sensitive items: Class I for 100 to 1 000 volts and Class II for 1 001 to 4 000 volts sensitivity. Most electronic components are in Class I. For example, bi-polar transistors are susceptible to ESD between 380 to 7 000 volts; CMOS devices are susceptible between 250 volts and 3 000 volts; and EPROMs, used in computer memories, are susceptible to as low as 100 volts.

The ESD issue is not going away. In fact, the problem is getting much worse. As component technology continues to advance to achieve higher speeds and greater functionality, their physical geometries are shrinking, which is causing components to become even more susceptible to lower discharge voltages. The following section will discuss special handling of ESD-sensitive components and anti-static protection devices which must be used to protect these sensitive electronic components from the dangers of electrostatic discharge.

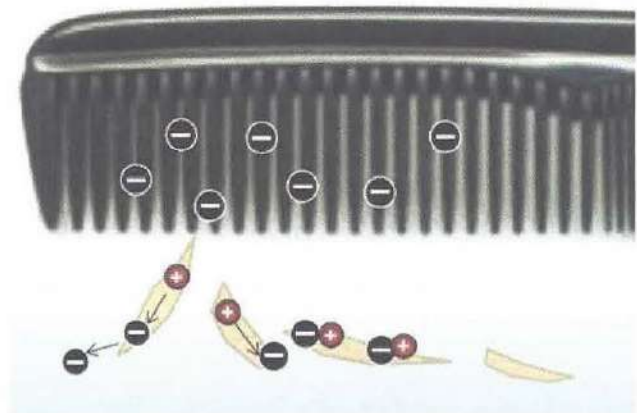


Figure 12-2. Electrostatic induction.

ANTI-STATIC PROTECTION

CONTROLLED ENVIRONMENT

Static electricity can't be eliminated. It can only be controlled. Therefore, it is essential to only handle ESD sensitive devices in static-safe controlled environment. Signage must be placed outside any ESD controlled areas to warn people that special precautions must be taken before entering the controlled environment. (Figure 12-3) Any insulating materials, such as nylon, mylar, vinyl, rubber, mica, ceramics, fiberglass, wood, styrofoam, and plastic, will store static electricity, and therefore, should be kept out of the work area. Technicians should only enter the work area wearing anti-static (steel mesh) smocks and conductive (leather-soled) footwear. If wearing an anti-static heel strap in place of conductive shoes, the grounding cord must run into the sock in order to make contact with the skin.

STATIC-SAFE WORKSTATION

Conductive materials, including personnel, must be grounded. The floor surface should be covered with conductive paints or coatings, anti-static floor finishes, or anti-static vinyl flooring. As shown in Figure 12-4, the work station should have a static dissipative floor mat and table-top mat that have a surface resistivity of 105 to 1012 ohms per square inch.

The conductive mat not only provides a surface that is free of static charge on which to work, but must also remove the static charge from conductive items placed on it. Both the floor and table-top mats should be connected through

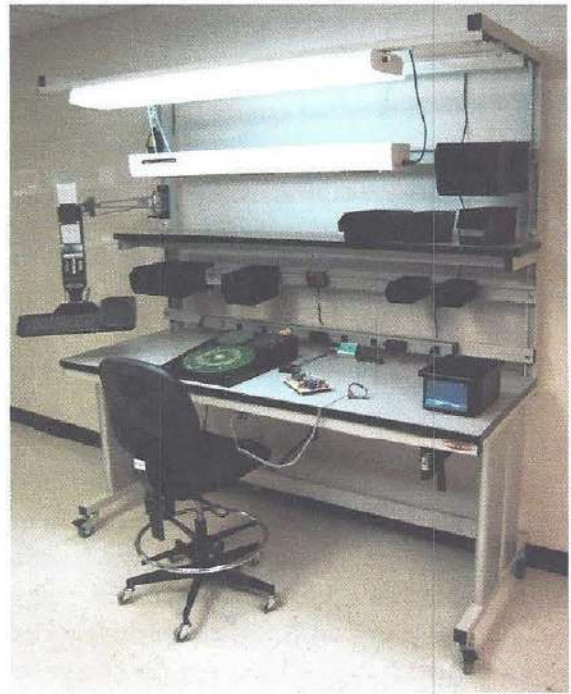


Figure 12-4. Static-safe workstation.

a 1 mega-ohm resistor connected to a common ground point. The resistor is required to protect personnel in the event the ground becomes electrically live.

ANTI-STATIC WRIST STRAPS

The same safety requirement holds true for the anti-static wrist strap (Figure 12-5) in that the coil cord must be plugged or clipped into a receptacle with a 1 mega-ohm resistor connected to a common ground point. The wrist strap must be secure around the wrist at all times while seated at the work station so that it makes good electrical connection with the skin to dissipate any electrical charge to ground before touching sensitive electronic components.



Figure 12-3. Warning sign for an ESD controlled area.



Figure 12-5. Anti-static electricity grounding wristband.

GROUNDING TEST STATIONS

All anti-static devices should be tested before entering the static-safe controlled environment. *Figure 12-6* is a picture of a typical grounding test station used to determine whether the anti-static devices are working properly. A green indicator light means that the wrist strap is worn properly and is working as intended. The test station can also be used to test footwear, heel straps, and coil cords as well.

IONIZERS

Since it is not practical to raise the relative humidity to high levels due to operator discomfort and the fact that it would cause metals to rust, the controlled environment should be equipped with ionizers to neutralize any charged insulators commonly found in the work environment. Because positively or negatively charged surfaces will attract ions of the opposite charge, an air stream containing both positive and negative ions is used to neutralize the charged surface. Once the surface is neutralized, it remains so as long as the ion stream is present. Ionizers are available in high-pressure, low-volume air guns for periodic localized cleaning, and low-pressure, high-volume wall-mounted units designed to be suspended over the work station with the ionized air blowing down over the area to be protected against an ESD event. (*Figure 12-7*)

Designed to cover a work station area, the ionizer will neutralize even the highest electrostatic charge. Normally the system is mounted 30"-36" above the area to be controlled, producing a balanced ionization pattern of approximately 36" wide x 48" long. It is highly recommended to use an electrostatic field meter to detect static charges in the work area to be assured that the

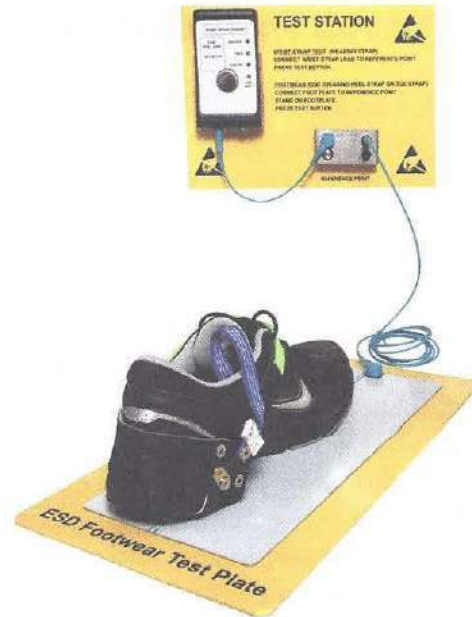


Figure 12-6. Typical grounding test station.

ionizer is functioning properly before handling sensitive components. If the ionizer is not working properly, topical anti-stats should be sprayed in the work area to control the generation and accumulation of electrostatic charges.

SPECIAL HANDLING

All ESD sensitive components should be transported in a closed conductive container (e.g., LRU or a tote box). The container must be stored on a grounded rack, and when moved to the work station, it must make contact with the grounded table mat. Any accumulated charge on the human body should first be discharged, by wearing the grounded anti-static wrist strap, before opening the protective container containing the ESD sensitive component. Also, always use a grounded soldering iron to install ESD sensitive components.

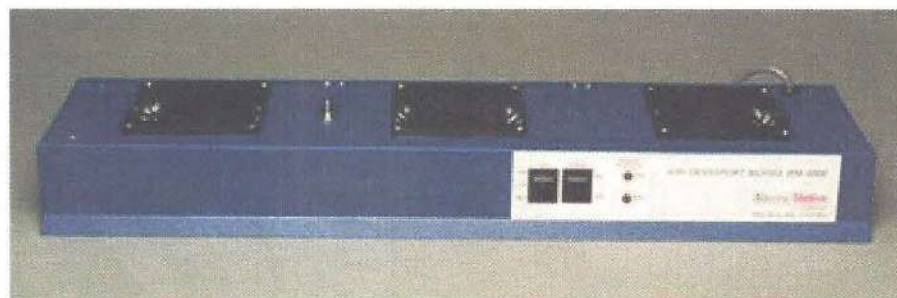


Figure 12-7. Hand-held and wall-mounted ionizers.

All ESD sensitive components should be packaged in an electrostatic shielded conductive bag. These laminated bags (*Figure 12-8*) are made from an outer layer of transparent metallized sheet or an aluminum foil material, a middle insulation layer, and an inner anti-static layer. Finally, the bag is sealed with a label warning that there is an ESD sensitive component inside.



Figure 12-8. Laminated metalized bag for storing ESD sensitive components.

Question: 12-1

What causes static electricity and electrostatic induction?

Question: 12-5

How does one maintain a static-free workstation?=-

Question: 12-2

What is Electro-Static Discharge (ESD) and what are the ways that it can damage electronic components?

Question: 12-6

What is the reason for using ionizers?

Question: 12-3

How susceptible are electronic components to damage from ESD?

Question: 12-7

What precautions should be used when handling ESD sensitive components?

Question: 12-4

What precautions must be taken when working in an ESD controlled environment?

ANSWERS

Answer: 12-1

Static electricity is caused by friction. Simply walking across a carpet can generate 1 500 volts of static electricity at 65% relative humidity and up to 35 000 volts of static electricity at 20% relative humidity. Electrostatic induction occurs when a charged object induces the redistribution of charges in another object.

Answer: 12-2

ESD is the transfer of electrostatic charges between bodies at different potentials caused by direct contact or induced by an electrostatic field. If an electronic component that is charged is then suddenly grounded, the charge will dissipate to ground, but in the process, the component will be damaged due to excessive heat and/or from breakdown of the dielectric material within the component.

Answer: 12-3

Bi-polar transistors are susceptible to ESD between 380 to 7 000 volts; CMOS devices are susceptible between 250 volts and 3 000 volts; and EPROMs, used in computer memories, are susceptible to as low as 100 volts.

Answer: 12-4

Any insulating materials, such as nylon, mylar, vinyl, rubber, mica, ceramics, fiberglass, wood, styrofoam, and plastic, will store static electricity, and therefore, should be kept out of the work area. Technicians should only enter the work area wearing anti-static (steel mesh) smocks and conductive (leather-soled) footwear.

Answer: 12-5

The work station should have a static dissipative floor mat and table-top mat that are connected through a 1 mega-ohm resistor to a common ground point. The wrist strap must be secure around the wrist at all times while seated at the work station so that it makes good electrical connection with the skin to dissipate any electrical charge to ground before touching sensitive electronic components. The wrist strap cord must be plugged into a receptacle with a 1 mega-ohm resistor connected to the same common ground point.

Answer: 12-6

A controlled environment should be equipped with ionizers to neutralize any charged insulators commonly found in the work environment. Because positively or negatively charged surfaces will attract ions of the opposite charge, an air stream containing both positive and negative ions is used to neutralize the charged surface. Once the surface is neutralized, it remains so as long as the ion stream is present.

Answer: 12-7

All ESD sensitive components should be transported in a closed conductive container (e.g., LRU or a tote box). The container must be stored on a grounded rack, and when moved to the work station, it must make contact with the grounded table mat. Any accumulated charge on the human body should first be discharged, by wearing the grounded anti-static wrist strap, before opening the protective container containing the ESD sensitive component. All ESD sensitive components should be packaged in an electrostatic shielded conductive bag.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

SOFTWARE MANAGEMENT CONTROL

SUB-MODULE 13

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A

B1

Sub-Module 13

SOFTWARE MANAGEMENT CONTROL

Knowledge Requirements

5.13 - Software Management Control

Awareness of restrictions, airworthiness requirements and possible catastrophic effects of unapproved changes to software programmes.

-

2

SOFTWARE MANAGEMENT
CONTROL

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

SOFTWARE MANAGEMENT CONTROL

RESTRICTIONS AND CATASTROPHIC EFFECTS

As a result of advances in digital electronics, modern aircraft have become very sophisticated with many millions of lines of code running simultaneously in dozens of airborne computers. As such, it has become imperative that software management control includes a thorough definition and documentation of the aircraft software development process in order to avoid catastrophic effects of unapproved software changes being uploaded onboard aircraft computers that could cause aircraft loss and multiple fatalities. Imagine the consequences if during an Instrument Flight Rules (IFR) approach in zero visibility, the flight control software failed.

Besides the basic production of source code and executable object code, safety standards must be adhered to that specify required software documentation and life cycle artifacts, such as an airworthiness certification plan, software quality assurance plan, software configuration management plan, configuration control procedures, software code standard, software design standard, software requirements standard, software development plan, software verification plan, software design document, software requirements document, traceability, test cases and test procedures, verification results, quality assurance records, configuration management records, problem reports, and a software accomplishments summary.

AIRWORTHINESS REQUIREMENTS

"Software Considerations in Airborne Systems and Equipment Certification" is a standards document dealing with the safety of software used in aircraft systems. It was jointly published in 1992 by the Radio Technical Commission for Aeronautics (RTCA) as DO-178B, and by the European Organization for Civil Aviation Equipment (EUROCAE) as ED-12B. The Federal Aviation Administration (FAA) and European Aviation Safety Agency (EASA) have used DO-178B/ED-12B as certification guidance to determine if the software will perform reliably in aircraft systems.

DO-178B/ED-12B established design assurance levels based on a safety assessment process and hazard analysis by examining the effects of a failure condition in each aircraft system. There are five criticality levels defined in terms of the potential consequence of an undetected error in the software as certified at each of the following levels:

- Level A: Catastrophic: Prevents continued safe flight or landing. Failure may cause multiple fatalities and loss of aircraft.
- Level B: Hazardous/Severe: Failure has large negative impact on safety or performance. May cause serious or fatal injuries to a smaller number of passengers.
- Level C: Major: Failure significantly reduces safety margin, impairs crew efficiency, discomfort or possible injuries to passengers.
- Level D: Minor: Failure reduces the aircraft safety margins, but well within crew capabilities. May include passenger inconvenience such as a routine flight plan change.
- Level E: No Effect: Failure has no impact on the safety or aircraft operation.

Flight control and navigation systems are flight critical and thus require Level A certification. Cabin entertainment systems fall at the other end of the criticality spectrum and would be considered as Level E systems (except for the crew's ability to override it when making public address announcements). Typically, different levels of software criticality will not be run on the same processor, unless of course, an approved software partitioning scheme, such as ARINC 653, is employed. ARINC 653 (Avionics Application Standard Software Interface) is a software specification for space and time partitioning in a real-time operating system that allows a processor to host multiple software applications of different criticality levels on the same processor. ARINC 653 is used in Integrated Modular Avionic (IMA) systems.

When DO-178B was initially published, most software was coded by hand. However, software development processes have since evolved to automatic coding using model-based design. As such, there was a need for clarification or refinement of the definitions between high-level system requirements and low-level software requirements. Also required was a process to determine how to verify software that was model-based

and determine if model-based simulation or formal methods could replace some or all of the software testing activities. Hence, a new standard, DO-178C was developed in 2011 to replace DO-178B. In July of 2013, the FAA released an Advisory Circular (AC 20-115C) making DO-178C as recognized "compliance with applicable airworthiness regulations for the software aspects of airborne systems".

The newer DO-178C standard contains several supplements that map closely with current industry software development and verification practices: Software Tool Qualifications (DO-330), Model-Based Development and Verification (DO-331), Object-Oriented Technology (DO-332), and Formal

Methods (DO-333). Software development tools such as MATLAB, Simulink, and Embedded Coder, are widely used to support software development activities involving model-based design in compliance with DO-178C.

Figure 13-1 is a diagram illustrating the required tracing between certification artifacts as required by DO-178C. Red traces are required only for Level A software applications. Purple traces are required for Levels A, B and C. Green traces are required for Levels A through D. Level E does not require any traceability due to its non-critical nature. DO-178C states that Level A executable object code must be "robust with respect to the software requirements that it can respond correctly to abnormal inputs and conditions".

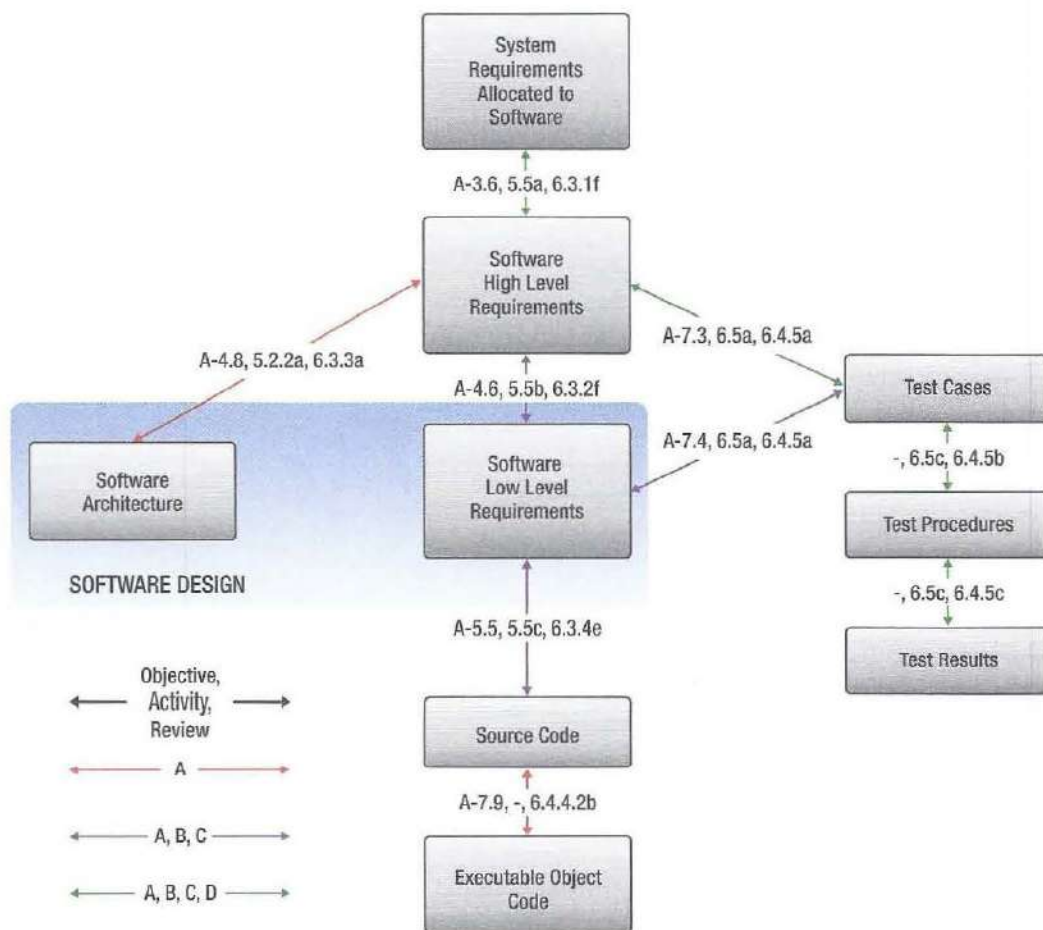


Figure 13-1. DO-178C required traceability between software artifacts.

Question: 13-1

Software management control includes a thorough definition and documentation of the aircraft software development process. What documentation is required?

Question: 13-4

What is ARINC 653 and where is it used?

Question: 13-2

What is DO-178 and why is it important?

Question: 13-5

What was DO-178C developed to take the place of DO-178B?

Question: 13-3

Why are flight control and navigation systems certified at DO-178 Level A?

Question: 13-6

DO-178C requires tracing between which certification artifacts for Level A software applications that are not required for any other levels?

ANSWERS

Answer: 13-1

Documentation includes: airworthiness certification plan, software quality assurance plan, software configuration management plan, configuration control procedures, software code standard, software design standard, software requirements standard, software development plan, software verification plan, software design document, software requirements document, traceability, test cases and test procedures, verification results, quality assurance records, configuration management records, problem reports, and a software accomplishments summary.

Answer: 13-2

DO-178 is a standards document dealing with the safety of software used in aircraft systems. DO-178 established design assurance levels based on a safety assessment process and hazard analysis by examining the effects of a failure condition in each aircraft system. The Federal Aviation Administration (FAA) and European Aviation Safety Agency (EASA) have used DO-178 as certification guidance to determine if the software will perform reliably in aircraft systems.

Answer: 13-3

Flight control and navigation systems are flight critical, and thus require Level A certification, because failure may cause multiple fatalities and loss of aircraft

Answer: 13-4

ARINC 653 is a software specification for space and time partitioning in a real-time operating system that allows a processor to host multiple software applications of different criticality levels on the same processor. ARINC 653 is used in Integrated Modular Avionic (IMA) systems to isolate flight-critical functions from non-flight-critical functions so that if a software application fails, it can't take down the entire IMA system.

Answer: 13-5

When DO-178B was initially published, most software was coded by hand. However, software development processes have since evolved to automatic coding using model-based design. As such, there was a need for clarification or refinement of the definitions between high-level system requirements and low-level software requirements. Also required was a process to determine how to verify software that was model-based and determine if model-based simulation or formal methods could replace some or all of the software testing activities.

Answer: 13-6

DO-178C Level A requires traceability between the source code and executable object code be documented.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

ELECTROMAGNETIC ENVIRONMENT

SUB-MODULE 14

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY -

A

B1

Sub-Module 14

ELECTROMAGNETIC ENVIRONMENT

Knowledge Requirements

5.14 - Electromagnetic Environment

Influence of the following phenomena on maintenance practices for electronic system:
EMC-Electromagnetic Compatibility EMI-Electromagnetic Interference;
HIRF-High Intensity Radiated Field Lightning/lightning protection.

-

2

ELECTROMAGNETIC
ENVIRONMENT

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

ELECTROMAGNETIC ENVIRONMENT

ELECTROMAGNETIC INTERFERENCE (EMI)

Unintended electromagnetic waves can cause severe disruption to aircraft system operation. Electromagnetic waves have both an electric and magnetic component. As discussed in *sub-module 12*, static electric charges set up an influence around them, which is described as an electric field. At each point in space, electric field strength can be measured in terms of volts per meter. Electrostatic induction occurs when a charged object induces the redistribution of charges in another object, such as the example of picking up pieces of paper using a comb that was rubbed against fur due to the attraction of opposite charges.

However, when electrons are moving through a conductor producing an electric current, an additional influence occurs, which is described as a magnetic field. Magnetic field strength is measured in amperes per meter. As shown in *Figure 14-1*, the magnetic field radiates at a right angle to the electrical current traveling through the conductor. The direction of the magnetic lines of force will travel counter-clockwise if the current is flowing towards the viewer. This is called the "right-hand grip" rule because if the viewer grips the wire with the right hand and the thumb is pointed in the direction of the current, the fingers would wrap around the wire in a direction indicating the motion of the magnetic lines of force, called flux.

As shown in *Figure 14-2*, there are four ways that electromagnetic fields can be coupled between the source of the unintentional generation of electromagnetic

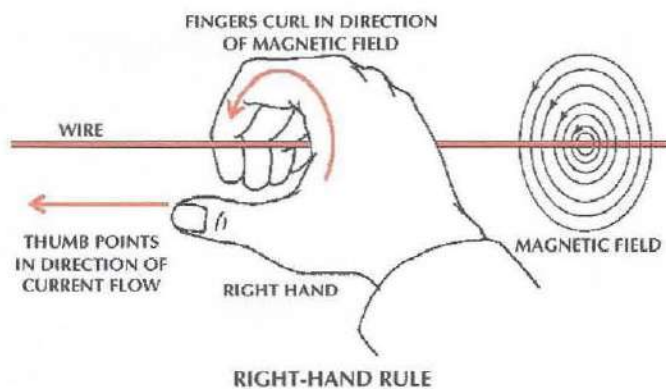


Figure 14-1. Magnetic flux field radiates at a right angle to direction of electrical current.

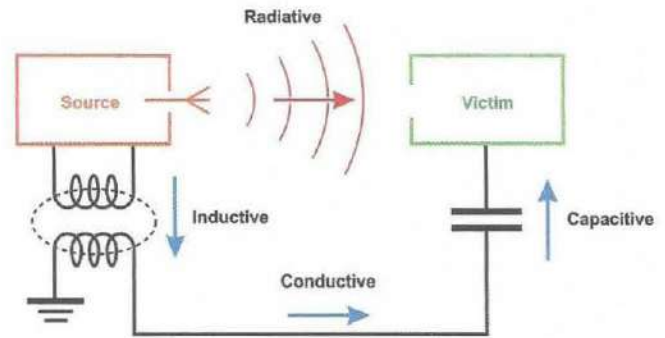


Figure 14-2. The four known EMI coupling methods.

energy and the victim that suffers from its unwanted effects. These four EMI coupling methods can work together or independently, providing either continuous or transient (electromagnetic pulse) interference.

Electromagnetic fields, in the frequency range from DC to light, constantly radiate in to space. For example, a transmitter antenna radiates electromagnetic RF waves to a receiver antenna. Radiative coupling occurs when the source emits or radiates an electromagnetic field that propagates across an open space and is received by the unintended victim. Inductive coupling and capacitive coupling occur over much shorter distances than radiative coupling. Inductive coupling occurs when a varying magnetic flux field from one conductor comes in close proximity to another conductor producing an induced current. Capacitive coupling occurs when a varying electric field exists between two adjacent conductors inducing a voltage change between the conductors through a dielectric, such as air. Finally, conductive coupling occurs when the coupling path between the source and the victim is formed by direct contact through perhaps a wire or metal enclosure.

HIGH-INTENSITY RADIATED FIELD (HIRF)

Of particular concern to aviation safety authorities is the presence of High-Intensity Radiated Fields (HIRF) whereby the power density of the electromagnetic field is sufficient to adversely affect living organisms or degrade equipment performance. A common HIRF device found in aircraft galleys is a microwave oven. Food and beverage items placed in the oven are heated through electromagnetic radiation. HIRF interference can also be caused by high power radio and microwave towers, including ATC primary surveillance radars. Evidence has revealed that most of the crashes of the U.S. Army's

UH-60 Black Hawk helicopter in the 1980's was caused by a malfunction in the electronic flight control system that was highly susceptible to the High-Intensity Radiated Fields from radio broadcast tower emissions.

Radio frequencies are radiated from the aircraft either deliberately or accidentally. Aircraft communications, surveillance and radar equipment radiate RF waves from 10 MHz to tens of GHz. Care must be taken to prevent mutual HIRF interference between transmitters of one system and receivers of another system. Also, accidental radiation can occur when equipment is malfunctioning or wiring is incorrectly installed without proper grounding. Such radiation can cause corruption of bus data by inducing bit errors in the digital data stream.

LIGHTNING/LIGHTNING PROTECTION

Lightning is one of the most energetic of all electromagnetic phenomena. Prior to a lightning discharge, the potential difference between the earth and thunderclouds is approximately 100 million volts. Lightning strike measurements on aircraft indicate electric field strengths in the order of 50 kilovolts per meter and magnetic field strengths of up to 600 amperes per meter. Significant damage can occur to sensitive electronic equipment due to a high electromagnetic pulse (EMP) caused by a lightning strike.

Most aircraft are designed to operate in all weather conditions, and since it may not be possible to divert a flight to avoid a thunderstorm, aircraft are typically designed with both lightning detection and lightning protection capabilities. Since lightning emits a unique electromagnetic signal, it is a reliable means for identifying potentially dangerous weather for the flight crew to avoid. The azimuth of a lightning discharge can be calculated by an ADF receiver using a loop antenna. The field strength intensity (power density) of the lightning strike can reveal the distance from the thunderstorm. This information is typically displayed as symbology that is overlaid on the Weather Radar page on the Multifunction Display. (*Figure 14-3*)

For lightning protection, aircraft have static wicks (*Figure 14-4*) installed at the trailing edge of the horizontal and vertical surfaces to dissipate electromagnetic energy on the surface of the skin back into the atmosphere. An aluminum airplane is quite conductive and is able to



Figure 14-3. Lightning detection overlaid on a MFD weather radar page.

dissipate the high currents resulting from a lightning strike. However, the use of composite materials in modern airliners, such as the Boeing 787 Dreamliner, with a fuselage made predominantly of carbon fiber, has required additional design features, such as putting some metal back into the fuselage for lightning protection.

Carbon fibers are 1 000 times more resistive than aluminum to current flow, and epoxy resin is 1 000 000 times more resistive. Therefore, the surface of an external composite component often consists of a ply or layer of conductive material for lightning strike protection because composite materials are less conductive than aluminum. Many different types of conductive materials are used ranging from nickel-coated graphite cloth to metal meshes to aluminized fiberglass to conductive paints. In addition to a normal structural repair, the



Figure 14-4. Static wicks on Boeing 737 wing.

technician must also recreate the electrical conductivity designed into the part. All components must be electrically bonded to one other with a metal-braided bonding strap to ensure conductivity across the entire aircraft structure. These types of repair generally require a conductivity test to be performed with an ohmmeter to verify minimum electrical resistance across the structure.

ELECTROMAGNETIC COMPATIBILITY (EMC)

The goal of Electromagnetic Compatibility is to eliminate or reduce the harmful effects of unintended Electromagnetic Interference. EMC is achieved by addressing both emission and susceptibility issues, i.e., quieting the sources of interference and hardening the potential victims from attack. In terms of emission, EMC is concerned with keeping electrical equipment that generates EMI operating within specified limits using filtering and shielding.

In terms of susceptibility, EMC addresses the design and operation of equipment that makes it immune to small levels of EMI that can't be entirely eliminated. As such, requirements are placed on equipment and wiring installation that involves the separation of wiring bundles and equipment including signal wire segregation. It also requires proper screening and bonding of equipment racks and RF sealing of equipment. These steps will help obviate the effects of EMI, HIRF, and lightning strikes on or near the aircraft.

EMC has become ever more important since the introduction of digital electronics, which operate on very low-level voltages (e.g., CMOS at 3 volts DC) compared to older analog systems that operate at 115 volts AC. As a result, digital electronics are much more susceptible to EMI. In addition, faster processing and data transfer speeds require higher clock rates of several tens of megahertz and much shorter pulse rise and fall transition times of only a few nanoseconds. The presence of fast pulses on PCBs and data bus transfers can give rise to radiation coupling (crosstalk) to adjacent circuits. The problem is exacerbated with the trend of modern aircraft being manufactured mostly out of light-weight composite carbon graphite materials that lack the electromagnetic shielding provided by aluminum structures.

Therefore, it is the responsibility of the aircraft technician to ascertain the nature and significance of electromagnetic

emissions from all equipment and the effects of any externally generated interference on the operation of all aircraft systems. EMI should be identified and eliminated, or at least reduced as much as possible at the source by eliminating coupling paths through proper equipment layout, shielding, filtering, and grounding techniques.

In accordance with MIL-STD-461, LRUs should be designed with EMI sensitive electronics located on one side of the enclosure, forming a 'Faraday cage' that is shielded from EMI effects so that sensitive microelectronic devices can be operated in a protected environment. All signals entering the EMI 'clean' area should be filtered to remove voltage spikes and surges. The EMI 'dirty' components, such as the power supply unit, that radiate EMI and can withstand to operate in this environment, should be isolated on the other side of the enclosure away from the shielded 'clean' compartment. When an LRU is opened for maintenance, it is imperative that it is reassembled correctly with all shielding and grounding mechanisms put back in place. (*Figure 14-5*)

Finally, cabling should be shielded and grounded to protect the wiring from external radiated interference from passenger electronic devices, such as laptop computers and cellular phones, and from HIRF and lightning strikes. Ultimately, it is the responsibility of the highly qualified aircraft technician to assure that EMI is contained by performing proper maintenance procedures to assure EMC functional integrity of all aircraft systems.



Figure 14-5. Heat-sink shield acts as a faraday cage to block electromagnetic emissions.

Question: 14-1

Explain the "right-hand grip" rule for current flowing through a conductor.

Question: 14-4

How is lightning detected for identifying potentially dangerous weather for the flight crew to avoid?

Question: 14-2

What are the four methods of electro-magnetic coupling?

Question: 14-5

How must carbon composite aircraft structures be repaired to protect the aircraft from the adverse effects of lightning strikes?

Question: 14-3

What are High-Intensity Radiated Fields (HIRF) and why are they of concern?

Question: 14-6

What is the responsibility of the technician when it comes to Electromagnetic Compatibility (EMC)?

ANSWERS

Answer: 14-1

The magnetic field radiates at a right angle to the electrical current traveling through a conductor. The direction of the magnetic lines of force (flux) will travel counter-clockwise if the current is flowing towards the viewer. This is called the "right-hand grip" rule because if the viewer grips the wire with the right hand and the thumb is pointed in the direction of the current, the fingers would wrap around the wire in a direction indicating the motion of the magnetic lines of force.

Answer: 14-2

Radiative coupling occurs when the source emits or radiates an electromagnetic field that propagates across an open space and is received by the unintended victim. Inductive coupling occurs when a varying magnetic flux field from one conductor comes in close proximity to another conductor producing an induced current. Capacitive coupling occurs when a varying electric field exists between two adjacent conductors inducing a voltage change between the conductors through a dielectric, such as air. Finally, conductive coupling occurs when the coupling path between the source and the victim is formed by direct contact.

Answer: 14-3

Of particular concern to aviation safety authorities is the presence of HIRF whereby the power density of the electromagnetic field is sufficient to adversely affect living organisms or degrade equipment performance. HIRF interference caused by radio and microwave towers has been shown to cause malfunctions in the electronic flight control systems leading to aircraft incidents causing loss of life.

Answer: 14-4

The azimuth of a lightning discharge can be calculated by an Automatic Direction Finder (ADF) receiver using a loop antenna. The field strength intensity (power density) of the lightning strike can reveal the distance from the thunderstorm. This information is typically displayed as symbology that is overlaid on the Weather Radar page on the Multifunction Display.

Answer: 14-5

In addition to a normal structural repair, the technician must recreate the electrical conductivity designed into the part. All components must be electrically bonded to one other with a metal-braided bonding strap to ensure conductivity across the entire aircraft structure. These types of repair generally require a conductivity test to be performed with an ohmmeter to verify minimum electrical resistance across the structure.

Answer: 14-6

Accidental radiation can occur when equipment is malfunctioning or wiring is incorrectly installed without proper grounding. Such radiation can cause corruption of bus data by inducing bit errors in the digital data stream. As such, requirements are placed on equipment and wiring installation that involves the separation of wiring bundles and equipment including signal wire segregation. It also requires proper screening and bonding of equipment racks and RF sealing of equipment.



DIGITAL TECHNIQUES ELECTRONIC INSTRUMENT SYSTEMS

TYPICAL ELECTRONIC
DIGITAL AIRCRAFT SYSTEMS

SUB-MODULE 15

PART-66 SYLLABUS LEVELS

CERTIFICATION CATEGORY →

A B1

Sub-Module 15

TYPICAL ELECTRONIC/DIGITAL AIRCRAFT SYSTEMS

Knowledge Requirements

5.15 - Typical Electronic/Digital Aircraft Systems

General arrangement of typical electronic/digital aircraft systems and associated BITE (Built In Test Equipment) such as:

(a) For B1 and B2 only:

ACARS-ARINC Communication and Addressing and Reporting System;
EICAS-Engine Indication and Crew Alerting System FBW-Fly by Wire;
FMS-Flight Management System IRS-Inertial Reference System.

(b) For B1, B2 and B3:

ECAM-Electronic Centralised Aircraft Monitoring EFIS-Electronic Flight Instrument System;
GPS- Global Positioning System;
TCAS-Traffic Alert Collision Avoidance System Integrated Modular Avionics;
Cabin Systems Information Systems.

- 2

ELECTRONIC/DIGITAL
AIRCRAFT SYSTEMS

Level 2

A general knowledge of the theoretical and practical aspects of the subject and an ability to apply that knowledge.

Objectives:

- (a) The applicant should be able to understand the theoretical fundamentals of the subject.
- (b) The applicant should be able to give a general description of the subject using, as appropriate, typical examples.
- (c) The applicant should be able to use mathematical formula in conjunction with physical laws describing the subject.
- (d) The applicant should be able to read and understand sketches, drawings and schematics describing the subject.
- (e) The applicant should be able to apply his knowledge in a practical manner using detailed procedures.

DIGITAL AIRCRAFT SYSTEMS

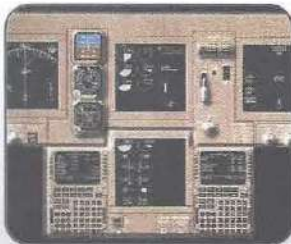
INTRODUCTION

The first *sub-module* discussed Electronic Instrument Systems (EIS). Subsequent sub-modules discussed digital electronics for aircraft applications in general. As shown in *Figure 15-1*, this final *sub-module* will expand on that discussion to include Integrated Modular Avionics Information Systems used to control onboard communications, navigation and surveillance systems and to provide information to be displayed on the EIS. It will also discuss how the crew uses this information to command the Flight Control System to fly the aircraft at the desired altitude, attitude, direction and airspeed. Finally, this *sub-module* will conclude with a discussion on cabin electronic systems.

As shown in *Figure 15-2*, most of the electronics in the Boeing 777 reside in the main equipment center racks located under the cockpit floor and above the nose gear wheel well. The flight control electronics and air data/inertial reference unit are located on the bottom two shelves of the E1 and E2 racks.

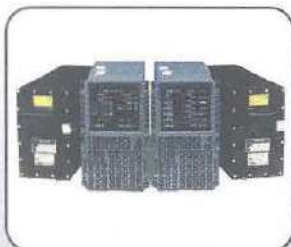
The cabin electronics are situated immediately above that in the third shelf from the bottom. The second and third shelves from the top are where the following Communication, Navigation and Surveillance (CNS) LRUs are located:

- Communications – Very-High Frequency (VHF) Communications Transceivers and the SELCAL (SElective CALling) unit. (Note: The High-Frequency (HF) Communication and Satellite Communication (SATCOM) transceivers used for long-distance and over-the-ocean communications are located further aft in the fuselage.)
- Navigation – Automatic Direction Finder (ADF), Instrument Landing System (ILS), VHF Omni-Range (VOR), Distance Measuring Equipment (DME) and Marker Beacon.
- Surveillance - Air Traffic Control (ATC) Transponders and Traffic Alert and Collision Avoidance System (TCAS).



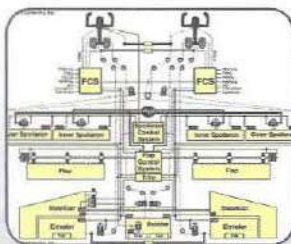
ELECTRONIC INSTRUMENT SYSTEM (EIS)

- Electronic Flight Instrumentation System (EFIS)
- Engine Indication and Crew Alerting System (EICAS)
- Electronic Centralized Aircraft Monitor (ECAM)
- Integrated Modular Avionics (IMA) Information Systems



COMMUNICATIONS, NAVIGATION AND SURVEILLANCE (CNS) SYSTEM

- Aircraft Communication Addressing and Reporting System (ACARS)
- Flight Management System (FMS)
- Inertial Navigation System (INS) and Global Positioning System (GPS)
- Traffic Collision Avoidance System (TCAS)



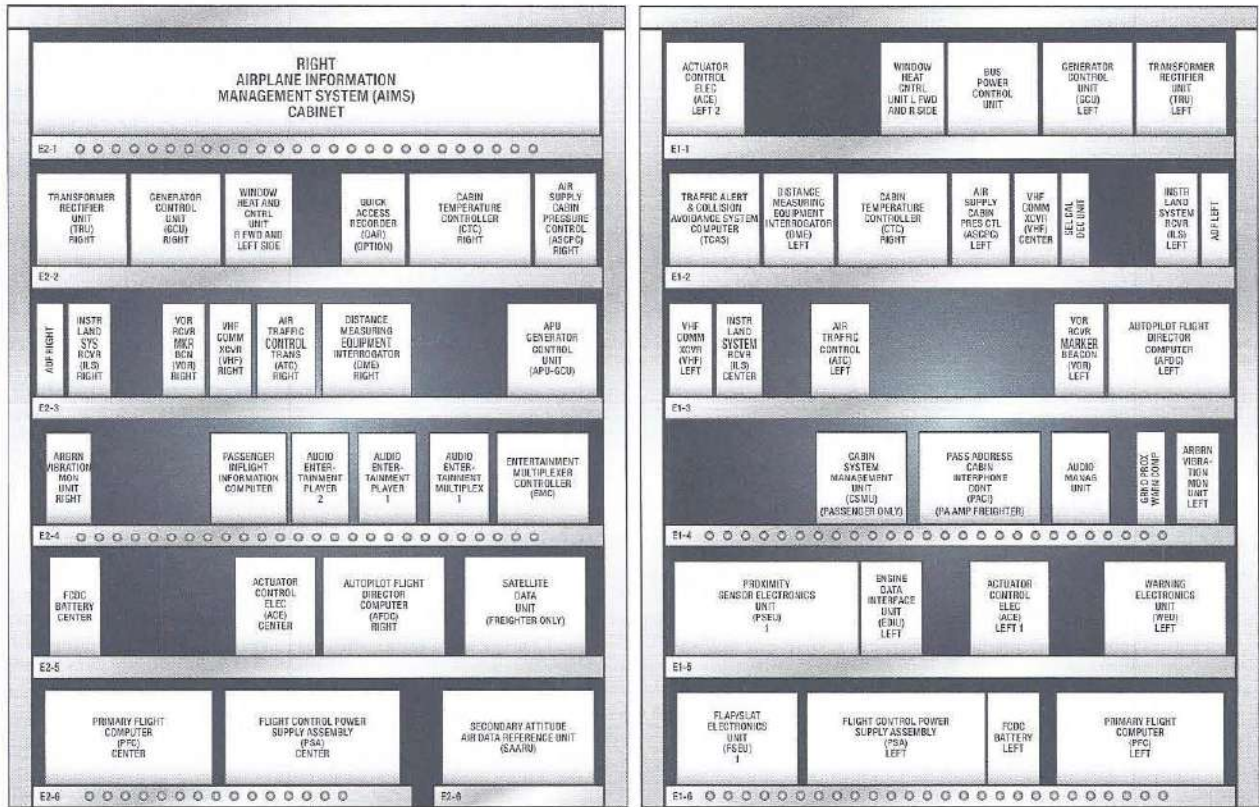
FLY-BY-WIRE FLIGHT CONTROL SYSTEM (FCS)

- Flight Deck Controls
- Flight Director System
- Autopilot and Actuators

Figure 15-1. Typical electronic/digital aircraft systems.

EQUIPMENT CENTERS

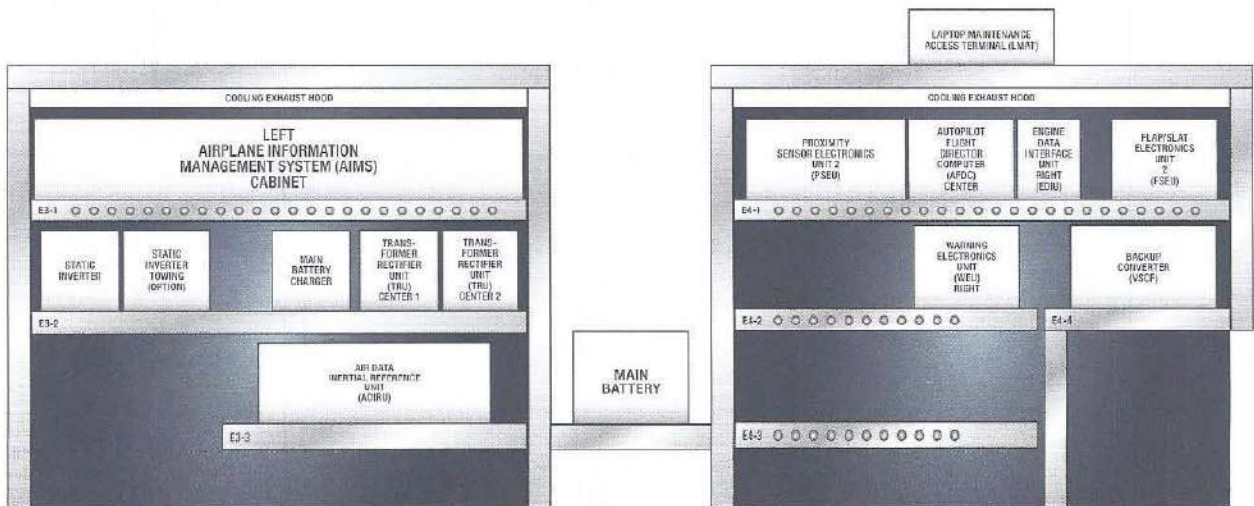
Main Equipment Center Racks



E2 Rack (Looking Aft)

Note: Passenger entertainment equipment on E2-4 is not installed on the 777 Freighter.

E1 Rack (Looking Aft)



E3 Rack (Looking Forward)

E4 Rack (Looking Forward)

Figure 15-2. Boeing 777 main equipment center racks.

The top shelf on the E2 rack contains one of two of the Airplane Information Management System (AIMS) cabinets. The second AIMS cabinet is located in the E3 rack directly opposite the E2 rack looking forward. AIMS contains the electronics for the Electronic

Instrument System and Flight Management System, in addition to the Communications Management System, which controls the Aircraft Communication Addressing and Reporting System (ACARS).

ELECTRONIC INSTRUMENT SYSTEMS

ELECTRONIC FLIGHT AND ENGINE INSTRUMENTS

As previously discussed, the Boeing 777 EIS consists of a dual-redundant Electronic Flight Instrument Systems (EFIS) and Engine Indication and Crew Alerting System (EICAS). On the left side of the instrument panel is the Captain's EFIS, consisting of a Primary Flight Display (PFD) and a Navigation Display (ND). The Co-Pilot's EFIS has an identical PFD and ND. Boeing's Engine Indication and Crew Alerting System, also known as an Electronic Centralized Aircraft Monitor (ECAM) on Airbus aircraft, monitors the aircraft systems. Two EICAS displays are located in the center instrument panel. The lower EICAS display is known as a Multi-Function Display (MFD). *Figure 15-3* is a schematic diagram of the Boeing 777 EIS showing the display processing being performed by the Airplane Information Management System, which will be discussed in more detail in the following paragraphs.

INTEGRATED MODULAR AVIONICS (IMA), INFORMATION SYSTEMS, AND BUILT-IN TEST EQUIPMENT (BITE)

The avionic system architectures that became well established in the mid-1970's are still the standard architectures of current aircraft in service today. These are referred to as "federated architectures" because each LRU contains its own independent dedicated function, such as the CNS LRUs discussed previously. The federated box concept worked well for many years because there were well defined functional boundaries between LRUs, thereby providing a clear division of areas of responsibility between the various avionics suppliers. However, the disadvantage of the federated approach was that there was a duplication of processors, memories, and power supplies making the overall system much heavier and costly than it needed to be.

With the recent advance of digital electronics, it became possible to combine these independent software (SW) functions into a singular cabinet of Line Replaceable Modules (LRMs). (*Figure 15-4*)

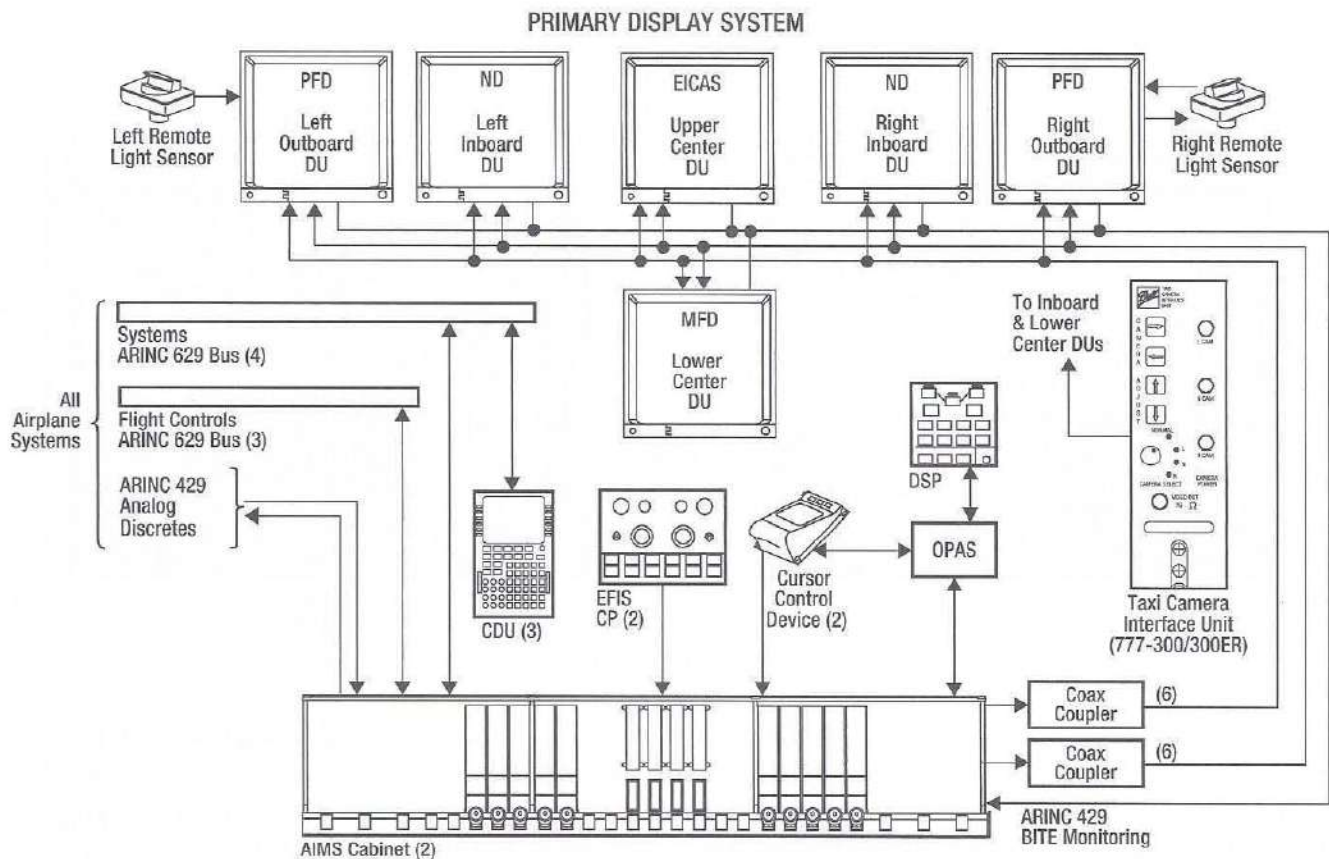


Figure 15-3. Boeing 777 electronic instrument system schematic diagram.

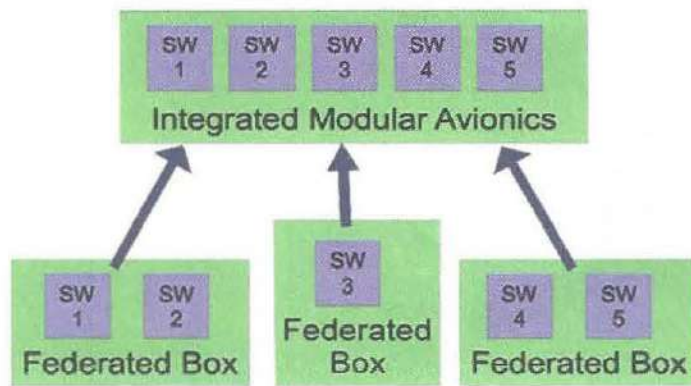


Figure 15-4. IMA Concept (left) and a typical IMA Cabinet (right).

The Integrated Modular Avionics (IMA) concept provides a more unified approach to avionics design resulting in considerable less volume and weight due to the sharing of resources across a number of Line Replaceable Modules. Many of the LRMs have identical hardware whose functionality differs only by the desired software application program installed. This commonality provides a pool of spare resources which improves system availability. In addition, high levels of fault detection and isolation are designed in the BITE (Built-In-Test Equipment) which allows for the replacement of a faulty module on the aircraft with the module being returned to the manufacturer for repair.

The only real disadvantage is that each of the avionic manufacturers must agree on a common set of form, fit and function standards in order that their LRMs fit in the cabinet and they function properly with other LRM. Various standards have been developed for IMA.

The Boeing 777, which first entered service in 1995, was the first commercial aircraft to make use of the Integrated Modular Avionics concept in what Boeing calls its Airplane Information Management System (AIMS), the main computer for many avionic systems. AIMS integrates multiple functions that require large quantities of data collection and processing. (Figure 15-5)

It consists of two cabinets with each cabinet containing 10 LRMs: 2 Core Processor Modules (CPMs) with bus communications capability, 2 CPMs with display graphic generators, 4 CPMs with I/O capabilities, and 2 power conditioning modules. In addition, ARINC 653 software partitioning allows the integration of

multiple computing applications in a singular CPM and isolates flight-critical functions from mission-critical function so that if a single software application fails, it can't take down the entire AIMS.

AIMS interfaces with approximately 130 LRUs, sensors, switches, and indicators to permit the integration of information from a majority of aircraft systems in one place. The onboard maintenance system uses AIMS for the BITE computing function. The maintenance crew uses a Maintenance Access Terminal (MAT) to control the central maintenance computing system and the airplane condition monitoring system. The MAT is a station with a display module, disk drive module, keyboard, and cursor control located at the observer station in the cockpit.

COMMUNICATIONS, NAVIGATION AND SURVEILLANCE SYSTEMS

AIRCRAFT COMMUNICATION ADDRESSING AND REPORTING SYSTEM (ACARS)

Airlines pay their flight and cabin crews based on the times reported for Out-of-the-gate, Off-the-ground, On-the-ground, and In-the-gate (OOOI). Prior to the introduction of data link to aircraft for sending text-based messages, the flight crew would verbally report their OOOI times to the Dispatch radio operators using their VHF or HF communication transceivers.

ACARS was originally called ARINC Communication Addressing and Reporting System because it was developed by ARINC in 1978 as a digital data link for transmission of short text messages between aircraft and ground stations to relieve the crew from having to call in their times and to provide more accurate

ELECTRONIC/DIGITAL AIRCRAFT SYSTEMS

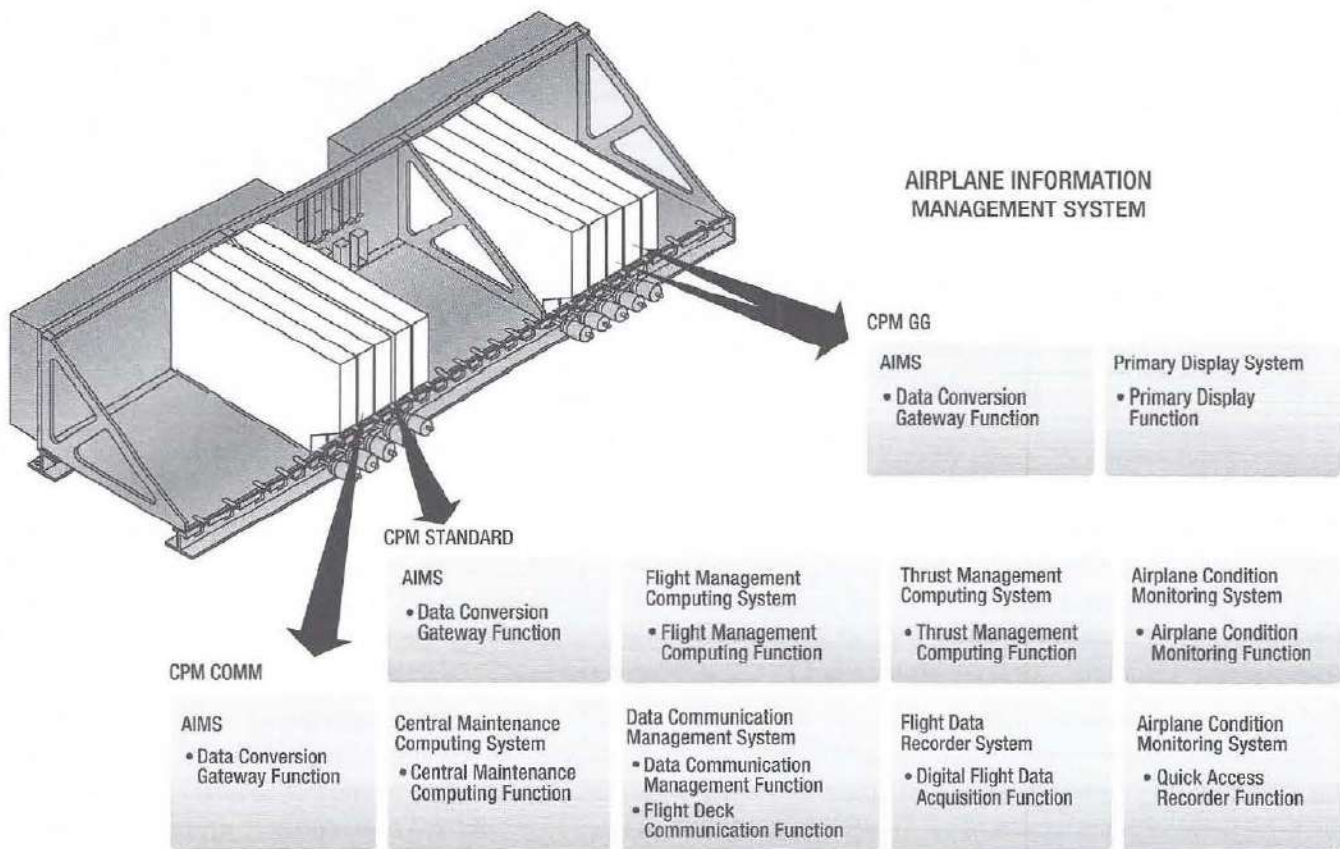


Figure 15-5. Airplane information management system cabinet.

reporting. The ARINC 597 standard defines the operation of the ACARS Management Unit, which uses discrete (on/off) inputs from the landing gear doors, parking brake and weight-on-wheels sensors to automatically determine the OOOI times and send these as text messages. ACARS also has a Medium Shift Keying modem that is used to transmit the OOOI reports over existing VHF or HF radios.

Figure 15-6 shows a typical ACARS display format prior to landing. As the airplane comes out of cruise altitude, ACARS begins updating the Dispatch office with a new estimated time of arrival and other changing details so that appropriate preparations, such as gate assignment and barrage handling, can be made. On touchdown, the ACARS report is automatically sent to Dispatch and the next crew heads for the gate. When the airplane comes to a final stop, the entire report is sent to a printer. The Captain signs the report securing the crew's pay for the day.

INERTIAL NAVIGATION SYSTEM (INS)

Traditional radio navigational aids, such as VOR and DME, require external ground-based references to provide a navigation solution. However, Inertial Navigation Systems, also known as Inertial Reference Systems (IRS), are self-contained navigation aids that use rotation sensors, motion sensors and a computer to continuously calculate (via dead reckoning) the position, orientation, and velocity of the aircraft without the need for external references. This is essential for over-water navigation where no ground-based navigation sensors exist. Inertial navigation uses gyroscopes to measure angular velocity and acceleration meters to measure linear acceleration. Gyros and accelerometers are placed on each of the three axis (pitch, roll and yaw) on a gimbal assembly, commonly referred to as a stabilized platform. (*Figure 15-7 left*)

The flight crew enters an initial geographic position (latitude and longitude) on the ground prior to takeoff, and while in flight, the Inertial Measuring Unit (IMU) detects a change in geographic position, velocity (speed and direction), and orientation (attitude and body rates) for a computer to process to provide the flight crew with a total navigation solution.



Figure 15-6. Typical ACARS display format.

Modern aircraft today use Strapdown IMUs in place of a gyro-stabilized platforms that contain many unreliable precision moving parts. (Figure 15-7 right) With a Strapdown IMU, the gyros and accelerometers for each axis are "strapped down" to the aircraft thereby eliminating the need for gimbals, bearings, or torque motors to stabilize the platform. Strapdown systems use rate gyros to measure the change in angular velocity in each axis. Digital computers make it possible to integrate the changes in pitch, roll and yaw at a rate of 2000 Hz providing extreme accuracy.

Ring Laser Gyros

Most rate gyros are now laser interferometers, also called laser gyros. Laser gyros measure angular rate by employing the properties of two laser beams inside a triangular ring-shaped tuned cavity. The Ring-Laser Gyro (RLG) is made from a triangular block of glass with two tunnels drilled parallel to the perimeter of the triangle and with reflective mirrors placed in each corner. (Figure 15-8 top)

A small charge of helium and neon gas is inserted and the cavity is sealed. When high voltage is applied between the anodes and cathode, the gas becomes ionized and forms two high energy light beams (lasers) that travel around the cavity in opposite directions. Since both counter-rotating beams travel at the constant speed of light, it takes each beam the exact same time to complete its triangular path. However, if the gyro was rotated on its axis, the path of one beam would be shortened, while the path for the other beam would be lengthened. This is known as the Sagnac effect. (Figure 15-8 bottom)

In addition, the laser beam adjusts its wavelength, and hence its frequency, for the length of the path. Since wavelength and frequency are inversely proportional, the laser beam that travelled the shorter distance would increase in frequency, and the laser beam that travelled the further distance would decrease in frequency. This frequency difference, as measured by the photocell detectors at one end of the triangle, is directly proportional to angular rate of turn about the gyro's axis.

Micro-Electro-Mechanical System (MEMS)

The latest technology used for inertial reference are solid-state Micro-Electro-Mechanical System (MEMS) devices. Through the use of solid-state MEMS devices, reliability is increased while weight and volume is decreased, primarily due again to the lack of moving parts. Tiny vibrating piezoelectric IMUs with resistance and capacitance pick-offs are accurate and reliable and only a few millimeters in length and width. They are normally integrated into an Integrated Circuit chip designed to yield an output after various conditioning processes are performed. The chips can be packaged for installation inside a dedicated computer LRU or LRM.

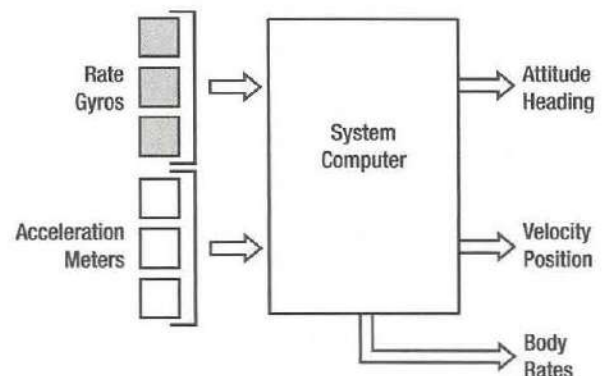
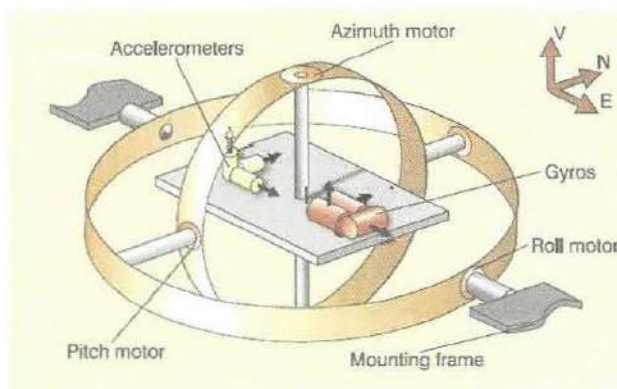


Figure 15-7. Gyro-stabilized IMU (left) and Strapdown IMU (right).

Regardless of which type of IMU device is employed, the advantage of having a self-contained navigation system is negated by the fact that all inertial systems

have a tendency to drift, sometimes as much as 0.6 nautical miles per hour. Small errors in acceleration and angular rate measurements propagate in time into progressively larger errors in velocity and position. This is known as integration drift. Therefore, the inertial position must be periodically corrected by input from some other form of navigation system, such as DME or Global Positioning System. Since DME is a land-based navigation aid, GPS must be used to update the INS when flying over large bodies of water.

GLOBAL POSITIONING SYSTEM (GPS)

The Global Positioning System is a space-based navigation system that was launched by the U.S. Department of Defense in the early 1990's, and has since become very popular commercially, not only for aircraft navigation, but for maritime, automotive and personal applications as well. It provides position data, velocity rate, and system time to GPS receivers all around the world.

GPS consists of three segments: a space system segment, a control system segment, and a user system segment. The space system segment consists of 6 planes of satellites, each plane containing 4 satellites, in precise 10 898 mile geostationary orbits. The control system segment has several monitoring stations located in U.S. controlled territory that track all satellites in view and accumulates ranging data to provide orbit determination and eliminate any errors. The user's GPS receiver computes its distance from the satellites by measuring the travel time of the satellite's signal. By using the distances from at least three satellites, the GPS receiver can triangulate the user's current position. With measurements from four satellites, the GPS receiver can determine elevation as well. (*Figure 15-9 left*)

As previously stated, the INS measures acceleration and angular rates and mathematically integrates these into velocity and position. However, since the inertial system outputs are obtained through integration, they drift at a very low frequency. The GPS is an ideal reference for realigning and recalibrating the INS during flight.

As shown in *Figure 15-9 right*, an algorithm, known as a Kalman Filter, is used to provide error correction to the INS. In addition, the INS provides prepositioning data for re-acquiring the GPS signal should the signal be lost.

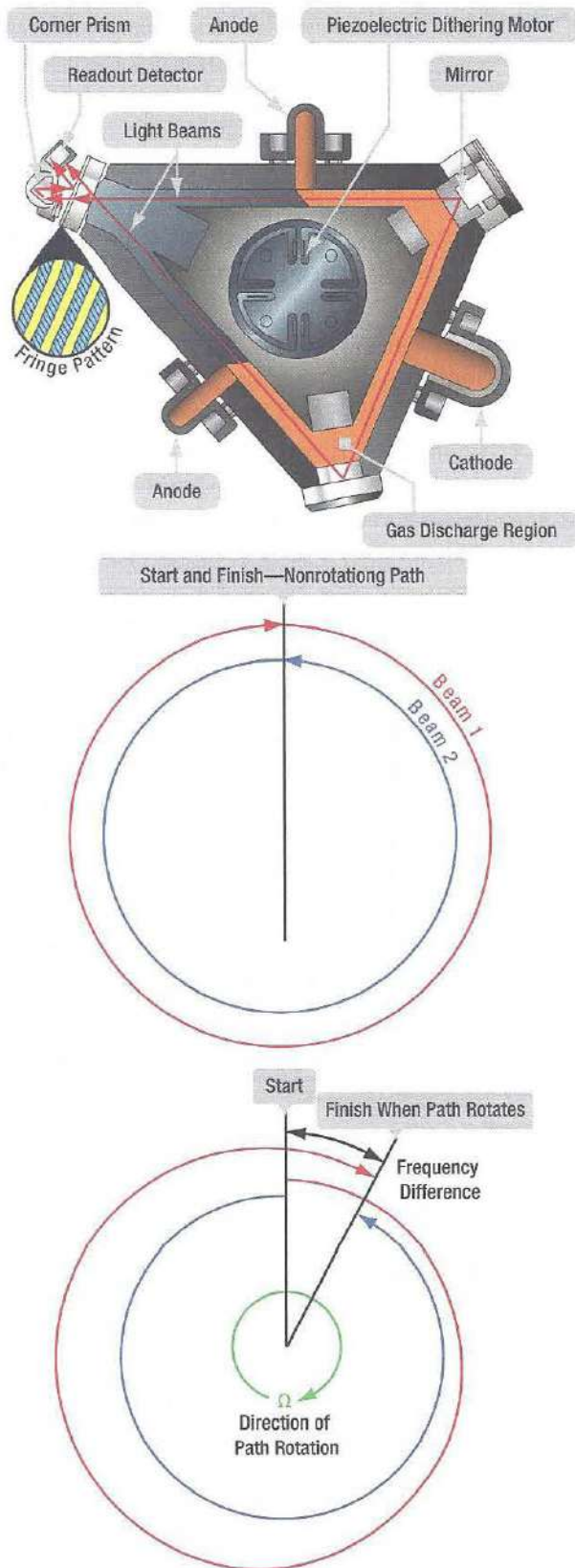


Figure 15-8. Sagnac Effect (bottom), Modern Ring-Laser Gyro IMU (top).

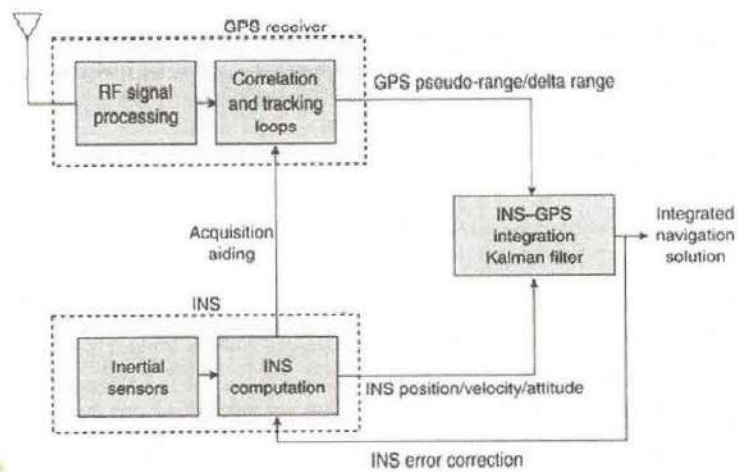
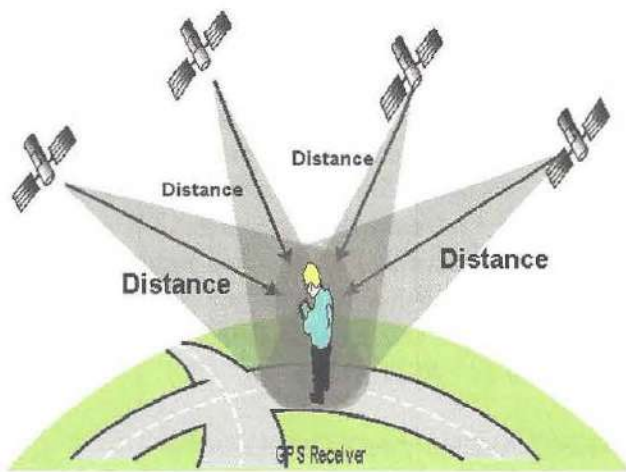


Figure 15-9. GPS Triangulation (left) and Integrated Navigation Solution (right).

FLIGHT MANAGEMENT SYSTEM (FMS)

Flight Management Systems, which became popular in the mid-1980s, automates a wide variety of in-flight tasks previously performed by a human navigator; thereby, reducing the workload on the flight crew. Not only can it define a desired route from the aircraft's current position to any point in the world, but the route will be based on the aircraft's operating characteristics to manage overall flight performance. On-time take-offs and landings, fuel conservation, and long engine and component life all contribute to airline profitability. The FMS helps achieve these results by operating the aircraft with much greater precision than humanly possible.

As shown in *Figure 15-10*, the FMS consists of dual-redundant Flight Management Computers (FMC) and Control Display Units (CDU). During normal

operation, the computers crosstalk with each other to share and compare information. Each FMC is capable of operating independently in the event the other FMC fails. However, only one FMC provides commands to the other aircraft systems at any one time.

Prior to take-off, the flight crew inputs their initial geographic location (latitude and longitude) and flight plans on one of the CDUs located in the center console. The FMC receives navigation and guidance information from the air data, inertial navigation, and global positioning system, in addition to ground-based radio navigational aids, and uses that information to compute ground speed, track, wind direction and velocity. The FMC then computes the optimum flight path, using a stored digital map terrain data base, to guide the aircraft to its final destination.

ELECTRONIC/DIGITAL AIRCRAFT SYSTEMS

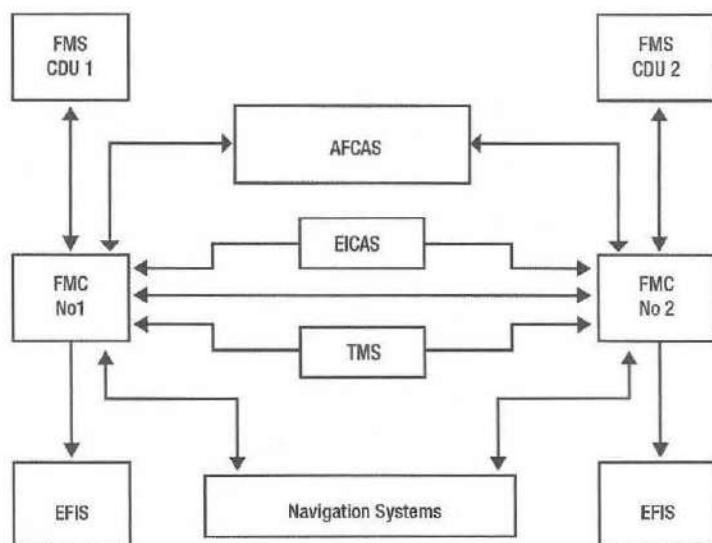


Figure 15-10. FMS Block Diagram (left) and FMS LRUs (right).

The FMC provides waypoints along the intended route on the EFIS Navigation Display (see Figure 1-8), and drives the flight director steering command bars on the EFIS Primary Flight Display (see Figure 1-7). The FMC communicates with the Thrust Management System (TMS) that drives the auto-throttle to control aircraft speed, and the automatic Flight Control System (FCS or AFCAS), that drives the actuators that move the control surfaces for lateral and vertical control along the computed flight path. The FMC continually optimizes the flight path as variables, such as wind speed and direction, change during flight.

Each flight path has vertical, horizontal, and navigational components, which are maintained by manipulating the engine and airframe controls. While doing so, numerous options are available to the pilot. Rate of climb, thrust settings, EPR (engine pressure ratio) levels, airspeed, descent rates, etc., can be varied. Commercial air carriers use the FMS to establish guidelines by which flights can be flown to promote the company's goals for fuel and equipment conservation. The flight crew need only enter variables as requested and respond to suggested alternatives as the FMS presents them. The FMS has stored in its database literally hundreds of flight plans with predetermined operational parameters that can be selected and implemented.

Integration with onboard radio navigational aids allows the FMC to change VOR, DME and ILS frequencies as the flight plan is enacted. Internal computations, using direct input from fuel flow and fuel quantity systems, allow the FMC to carry out lean operations or pursue other objectives, such as high performance operations

if making up time is paramount on a particular flight. Weather and traffic considerations are also integrated. The FMC communicates to the crew via the CDU to present its planned action, gain consensus, or ask for an input or decision. The FMC continuously monitors its inputs for faults during operation. Maintenance personal can retrieve BITE generated information and pilot recorded fault messages. They may also access maintenance pages that identify faulty LRUs that have been identified by BITE.

TRAFFIC ALERT AND COLLISION AVOIDANCE SYSTEM (TCAS)

Traffic collision avoidance systems are transponder based air-to-air traffic monitoring and alerting systems. There are two classes of TCAS. TCAS I was developed to accommodate the general aviation community and regional airlines. This system identifies traffic in a 35 to 40 mile range of the aircraft and issues Traffic Advisories (TA) to assist pilots in visual acquisition of intruder aircraft. TCAS I is mandated on aircraft with 10 to 30 seats.

TCAS II is a more sophisticated system. It is required internationally in aircraft with more than 30 seats or weighing more than 15 000 kg. TCAS II provides the same information of TCAS I, but also analyzes the projected flight path of approaching aircraft. If a collision or near miss is imminent, the TCAS II computer issues a Resolution Advisory (RA). This is an aural and visual command to the pilot to take a specific evasive action. The computer is programmed such that the pilot in the encroaching aircraft receives an RA for evasive action in the opposite direction.

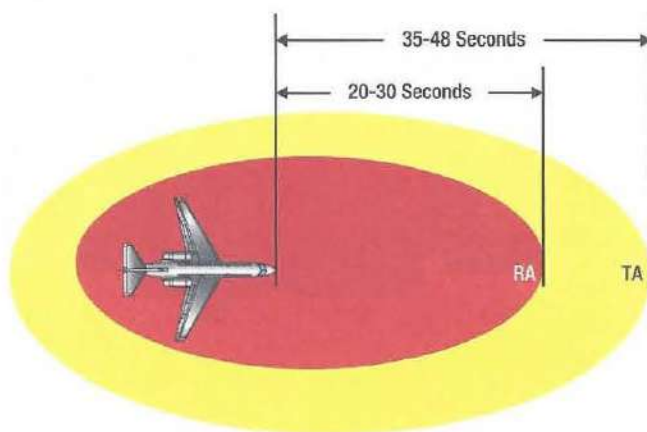


Figure 15-11. TCAS envelope (left) and TCAS display format (right).

As shown in *Figure 15-11*, TCAS issues an audible TA "TRAFFIC" alert when an intruder is 35-48 seconds away and issues an audible RA "CLIMB" or "DIVE" when an intruder is 20-30 seconds away. If vertical separation degrades to 850 feet, a TA warning appears, and at 600 feet, an RA command is issued both aurally and visually to both aircraft to take evasive action. An open diamond indicates a target; a solid diamond represents a target that is within 6 nautical miles or 1 200 feet vertically. A yellow circle represents a target that generates a TA. A red square indicates a target that generates an RA. A plus sign indicates the target aircraft is above and a minus sign indicates that it is below. The arrows show if the target is climbing or descending.

As shown in *Figure 15-12*, the Transponder (XPDR) of an aircraft equipped with TCAS is able to interrogate the Transponders of other aircraft nearby using Secondary Surveillance Radar (SSR) Modes C and S. This is done with a 1030 MHz signal. Interrogated aircraft transponders reply with an encoded 1090 MHz signal that allows the TCAS computer to display the position and altitude of each aircraft. It does this via a directional antenna mounted on the top of the aircraft that transmits interrogations on 1030 MHz at varying power levels in each of four 90 degree azimuth segments.

Transponder replies are received on 1090 MHz and sent to the TCAS computer and compared with the range and altitude data obtained from the lower antenna. The TCAS unit typically receives inputs from the air data computer and radar altimeter as well. TCAS II equipped aircraft use continuous reply information to analyze the speed and trajectory of target aircraft in close proximity. If a collision is calculated to be imminent, an RA is issued.

TCAS target aircraft are displayed on a screen on the flight deck. Different colors and shapes are used on the display to depict approaching aircraft depending on the imminent threat level. Since RAs are currently limited to vertical evasive maneuvers, some stand-alone TCAS displays are electronic vertical speed indicators. Most aircraft use some version of an electronic HSI on a navigational page to display TCAS information. The EFIS Navigational Display or MFD may be used to depict TCAS and weather radar information simultaneously on the same screen with the Primary Flight Display providing vertical speed commands to either ascend or descend.

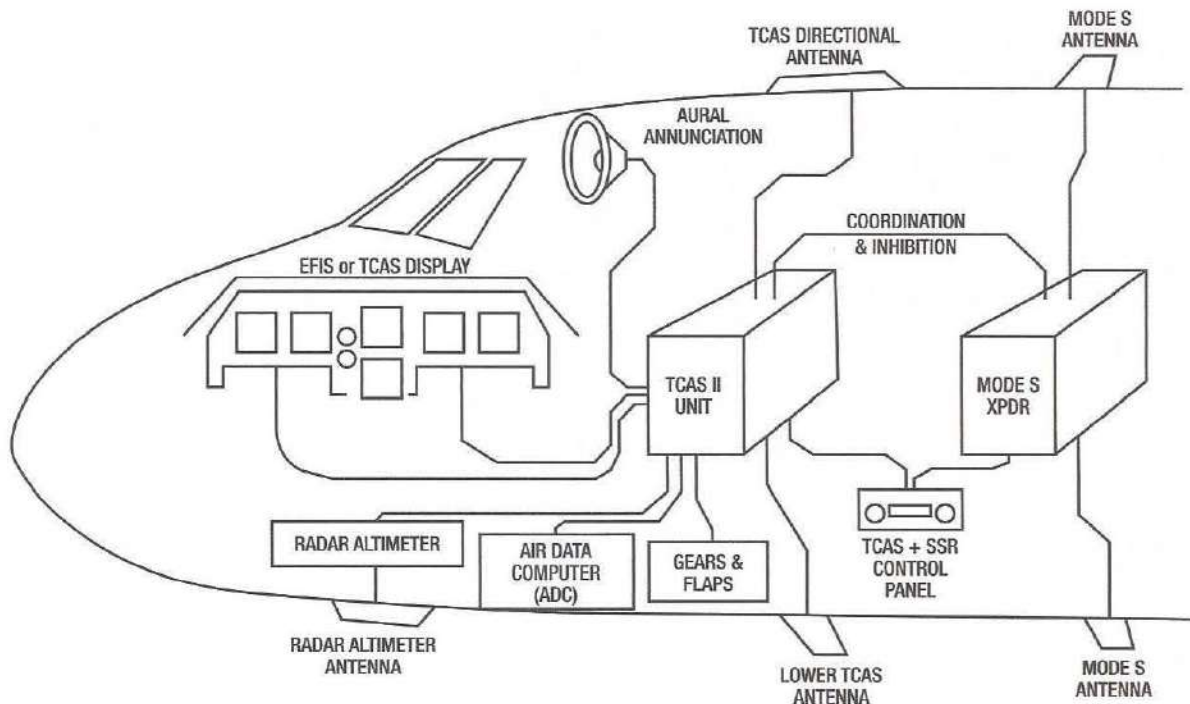


Figure 15-12. TCAS block diagram.

FLIGHT CONTROL SYSTEMS

MECHANICAL FLIGHT CONTROL SYSTEMS

Since the beginning of flight, the only means used to control the attitude, altitude, and direction of the aircraft was through push-pull control rods or cable and pulley systems from the cockpit control column and rudder pedals to the aircraft's control surfaces. (Figure 15-13)

Pitch control is exercised by the elevators located on the horizontal stabilizer to change the pitch of the aircraft. Pitch is exercised by moving the control column forward to pitch down (dive) and pulling aft to pitch up (climb). Roll control is provided by ailerons on the outboard section of the trailing edge of the wings and move in opposite directions. Roll is achieved by moving the control column to the right to drop the right wing and to the left to drop the left wing. Yaw control is provided by the rudder on the vertical stabilizer. Pushing the left peddle will yaw the aircraft to the left, while pushing the right pedal will yaw the aircraft to the right. The roll and yaw control are used simultaneously to perform a coordinated turn to change the heading without slipping the tail.

The elevator, ailerons, and rudder are known as primary flight controls. Larger aircraft will have secondary flight controls, in addition to primary flight controls. This includes high-lift flaps located on the inboard trailing edge of the wings. Deployment of the flaps during take-off or landing extends the flap sections rearward and downward to increase wing area and camber, thereby greatly increasing lift. Slat control is provided by spoilers which extend forward and outward from the leading edge of the wings which has the effect of decreasing wing area and camber to retard lift. At low speeds, roll control provided by the ailerons is augmented by the differential use of the spoilers. For example, during a right turn, the spoilers on the right wing will be extended to reduce the lift on that wing causing it to drop. Speed brakes are deployed when all the over-wing spoilers are extended which has the effect of further decreasing lift and increasing drag to slow the airplane upon landing prior to deploying the thrust reversers once on the ground.

The complexity and weight of mechanical Flight Control Systems (FCS) increases considerably with the size of the aircraft. Therefore, just like power-steering is used on an automobile to augment the muscular strength of

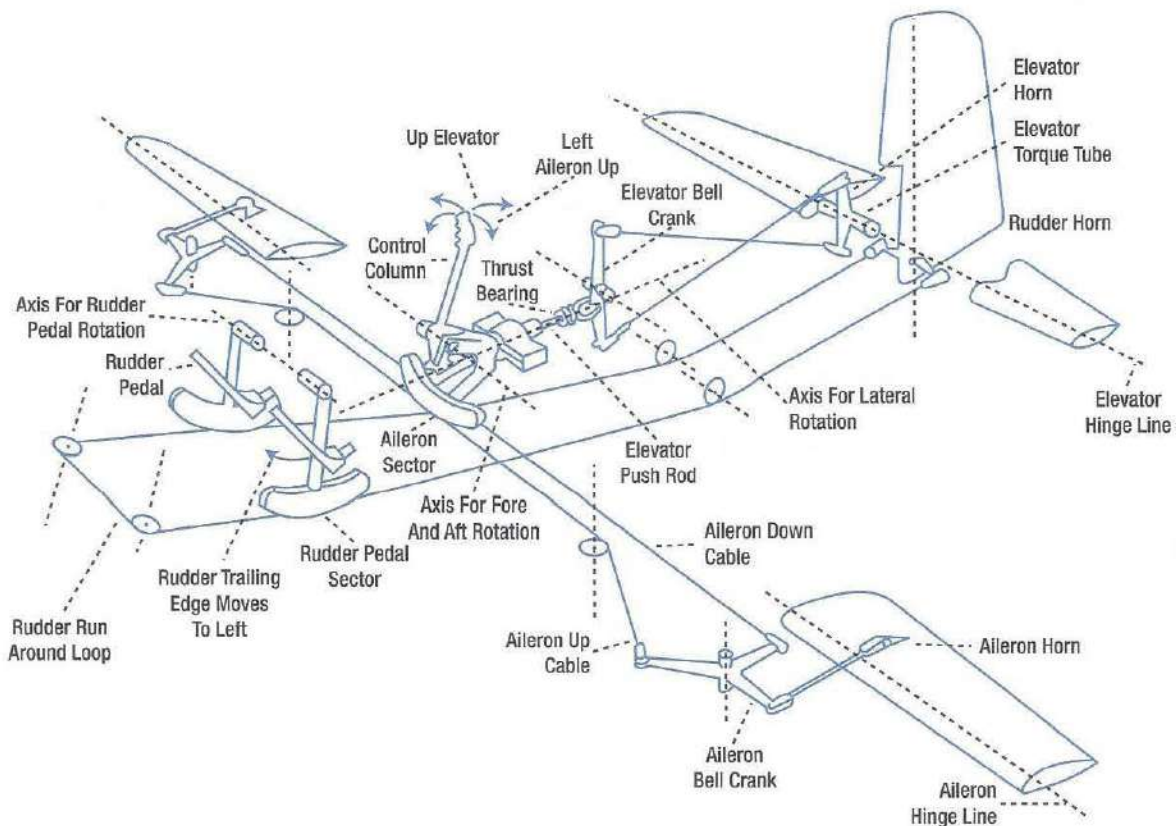


Figure 15-13. Typical mechanical flight control system.

the driver, hydraulic actuators were first introduced on aircraft to assist the pilot in moving the control surfaces, especially the heavy high-lift control surfaces, such as the flaps and slats. A hydro-mechanical FCS consists of a reservoir, a hydraulic pump, and network of hydraulic lines to send fluid pressure to linear actuators that move the control surface when the actuator's servo valve is opened through mechanical cables. Hydro-mechanical systems later evolved to what has become known as "Fly-by-Wire" (FBW) flight control systems, whereby the actuator servo valves are opened by electrical signals sent from digital flight control computers. (Figure 15-14)

AUTOMATIC DIGITAL FLIGHT CONTROL SYSTEMS

A full Fly-By-Wire, known as an Automatic Digital Flight Control System (ADFCS), replaces the hydro-mechanical flight control system in its entirety with an electrical interface. The movements of the pilot's controls are converted to electrical signals and transmitted by wires (hence the term fly-by-wire) to the flight control computers which determine how much to move the actuators at each control surface to provide the expected response. Commands from the flight control computers

are input to the actuators without the pilot's intervention in order to stabilize the aircraft during flight.

The ADFCS is a closed-loop control system meaning that the actual position of the control surface is fed back as an input signal to the flight control computer so that adjustments can be made to achieve and maintain the desired control settings.

As shown in *Figure 15-15*, the Boeing 777 has a triple-redundant (triplex) full fly-by-wire flight control system. Position transducers change the flight crew commands of the control wheels, control columns, rudder pedals and the speed brake lever to analog signals that are sent to the Actuator Control Electronics (ACE), which convert the analog signals to digital format and sends them to the Primary Flight Computers (PFC) over three ARINC 629 data buses. In addition, the PFCs receive airspeed, attitude and inertial data from the Air Data/Inertial Reference Units.

The PFCs calculate the flight control commands based on the flight control law algorithms, and flight augmentation and envelope protection software. The

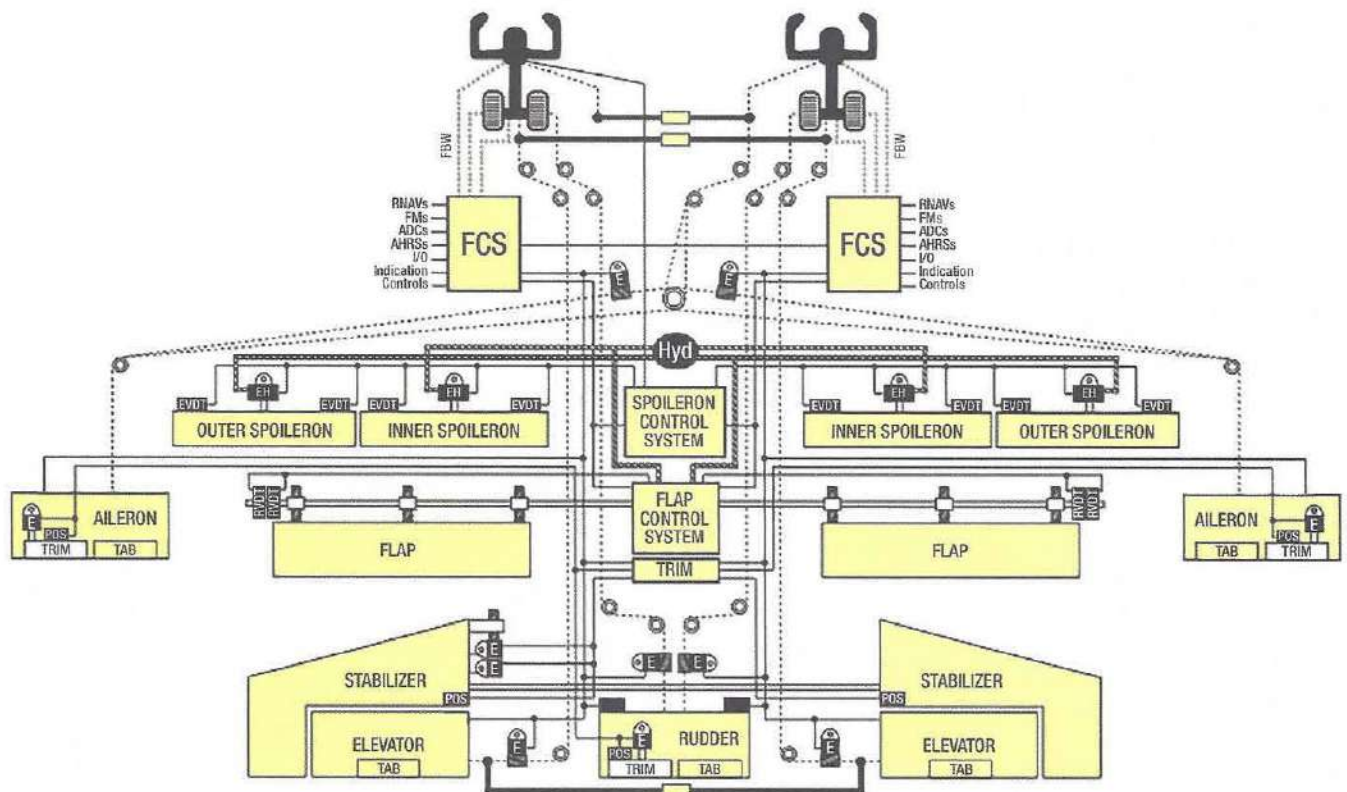


Figure 15-14. Fly-by-Wire flight control system with a mechanical backup.

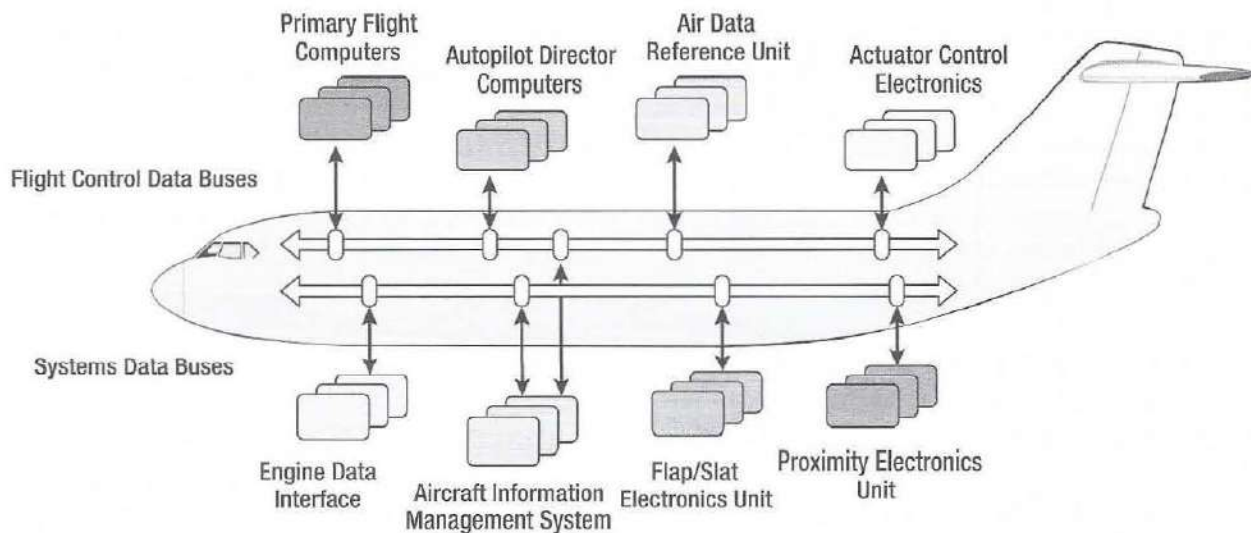


Figure 15-15. Boeing 777 Fly-by-Wire flight control system.

digital command signals from the PFCs are sent to the ACEs. The ACEs change these command signals to analog format and sends them to the Power Control Unit (PCU) actuators which operate the control surfaces. The PCUs contain a hydraulic actuator, an electro-hydraulic servo-valve, and position feedback sensors. The servo-valve causes the hydraulic actuator to move the control surface. The actuator position transducer sends a position feedback signal to the ACEs. After conversion back to digital format, the ACEs send the signal to the PFCs which stops the command when the position feedback signal equals the command position.

The PFCs receive autopilot commands from the three Autopilot Flight Director Computers (AFDCs), which receive flight navigation and guidance inputs from the FMS. The PFCs calculate the flight control commands in the same manner as done for manual operation. In addition, the PFCs supply signals to the back-drive actuators to move the control wheels, control column and rudder pedals in synchronization with the autopilot commands to provide visual feedback of autopilot control to the flight crew. The Proximity Electronics Unit monitors the position of the landing gear, up-locks, down-locks, and all electrically controlled hydraulic selector values. It disables the brake and nose wheel well steering at takeoff and rearms them at landing.

State-of-the-art FBW systems are using newer Electro-Hydrostatic Actuators (EHA) that have the advantage that they don't require a physical connection to the

aircraft's hydraulic system to operate, thereby saving considerable weight. Each EHA (*Figure 15-16*) has self-contained hydraulic reservoirs (shown on top) and a fixed displacement hydraulic pump driven by a variable speed motor (bottom) that is controlled by the Actuator Control Electronics. EHAs are used on the Airbus A380 and Lockheed Martin F-35 Joint Strike Fighter aircraft.

CABIN SYSTEMS

A discussion on digital aircraft systems would not be complete without mentioning cabin electronics, which is familiar topic to anyone who has flown as a passenger on a modern commercial airliner. In the 1970's, In-Flight Entertainment (IFE) systems were limited to pre-recorded audio tapes or compact discs that passengers listened to through their individual earphones or headsets. Later, when flat panel LCD screens became available, passengers could watch VCR video tapes on their seat back color displays (*see Figure 10-9*).



Figure 15-16. Electrostatic Actuator used on the F-35 horizontal tail.

However, passengers today want more than pre-recorder video. They desire to use their PC laptops on board the aircraft and have an AC power source and direct internet connectivity. Many also want cellphone connectivity while the aircraft is in flight. For this to be possible, Wi-Fi access points and cellphone picocell base stations are being installed.

Figure 15-17 illustrates one such system used to provide in-flight connectivity employing a SATCOM and a low-profile electronically steerable antenna to obtain a 1500 Mhz Inmarsat broadband satellite link. The Inmarsat system has three geostationary satellites which provides adequate coverage anywhere in the world (except near the north and south poles). The satellites transmit the aircraft signals to ground stations located around the globe where the data is linked to a telecommunications provider to send the data over public networks.

On board the aircraft, a communications manager computer in the cabin acts as the server to pass the data to and from the SATCOM and distribute the data between the Wi-Fi access point, cellphone picocell, and

the IFE network. Like all cellular base stations, the picocell controls the output power of the cellphone to the minimum power necessary to establish a link, thereby preventing interference with onboard aircraft systems and also preventing the cellphone from connecting to terrestrial-based cellular stations. A cockpit control is used to interrupt the system with important public address messages. The cabin crew can also send live news, sports or weather feeds. A high bandwidth data bus network, such as Firewire, is used for sending and receiving broadband video and Voice-Over-Internet Protocol (VOIP) data.

In addition to cabin applications SATCOM, transceivers are used for flight crew communicating and for maintenance operations. For example, the aircraft Health and Usage Monitoring System (HUMS) constantly measures the health of all onboard systems through Built-In Test Equipment (BITE), and if a fault is detected, it sends this information to maintenance operations via a satellite link so that the technician has a spare unit in hand to replace when the aircraft lands at its destination.

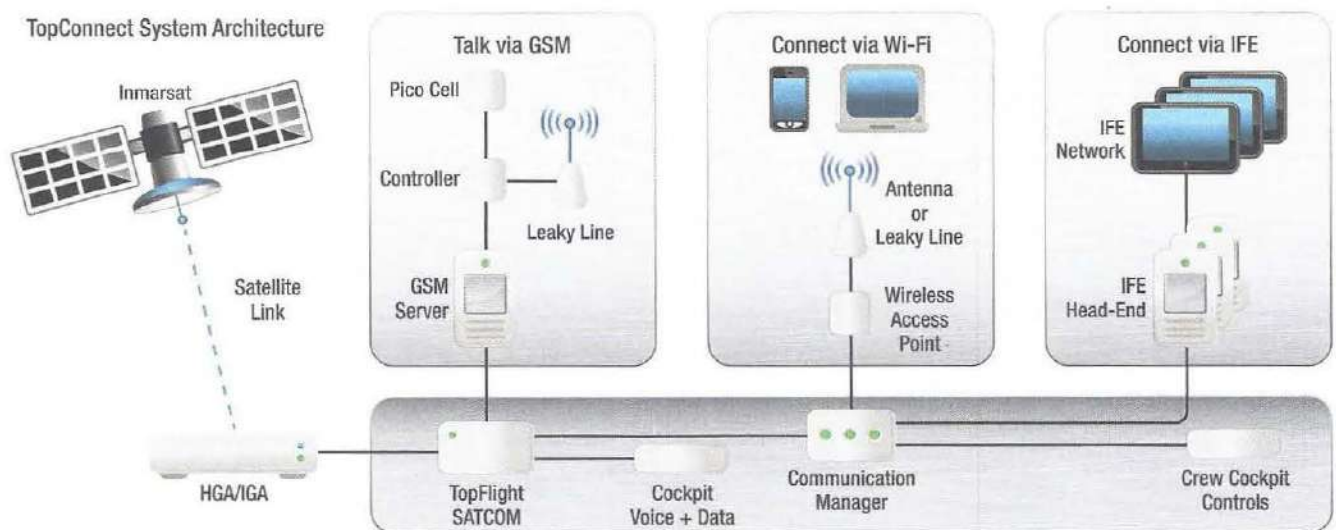


Figure 15-17. TopConnect cabin electronics system.

Question: 15-1

What are the advantages of Integrated Modular Avionics (IMA) over the traditional federated architecture approach?

Question: 15-3

How does the Ring Laser Gyro (RLG) measure angular velocity or rate of turn?

Question: 15-2

What is the Aircraft Communication Addressing and Reporting System (ACARS) and why is it important for airline operations?

Question: 15-4

How does a Global Positioning System (GPS) receiver determine its location?

ANSWERS

Answer: 15-1

The IMA concept provides a more unified approach to avionics design resulting in considerable less volume and weight due to the sharing of resources across a number of Line Replaceable Modules (LRMs). Many of the LRMs have identical hardware whose functionality differs only by the desired software application program installed. This commonality provides a pool of spare resources which improves system availability.

Answer: 15-2

Airlines pay their flight and cabin crews based on the times reported for Out of the gate, Off the ground, On the ground, and In the gate (OOOI). ACARS is a digital data link for transmission of short text messages between aircraft and ground stations to relieve the crew from having to call in their times and to provide more accurate reporting.

Answer: 15-3

Laser gyros measure angular rate by employing the properties of two laser beams inside a triangular ring-shaped tuned cavity. If the gyro was rotated on its axis, the path of one beam would be shortened, while the path for the other beam would be lengthened. The laser beam that travelled the shorter distance would increase in frequency, and the laser beam that travelled the further distance would decrease in frequency. This frequency difference, as measured by the photocell detectors at one end of the triangle, is directly proportional to angular rate of turn about the gyro's axis.

Answer: 15-4

A GPS receiver computes its distance from the satellites by measuring the travel time of the satellite's signal. By using the distances from at least three satellites, the GPS receiver can triangulate the user's current position. With measurements from four satellites, the GPS receiver can determine elevation as well.

Question: 15-5

How does the Flight Management Computer (FMC) determine the optimum flight path?

Question: 15-7

Explain how pitch, roll and yaw control is achieved in flight.

Question: 15-6

What action should the pilot take when the Traffic Alert and Collision Avoidance System (TCAS) issues a Resolution Advisory (RA)?

Question: 15-8

What is a Fly-By-Wire Flight Control System?

ANSWERS

Answer: 15-5

Prior to take-off, the flight crew inputs their initial geographic location (latitude and longitude) and flight plans. The FMS receives navigation and guidance information from the air data, inertial navigation, and global positioning system, in addition to ground-based radio navigational aids, and uses that information to compute ground speed, track, wind direction and velocity. The FMS then computes the optimum flight path, using a stored digital map terrain data base, to guide the aircraft to its final destination.

Answer: 15-6

If a collision or near miss is imminent, the TCAS computer issues a RA. This is an aural and visual command to the pilot to take a specific evasive action. The computer is programmed such that the pilot in the encroaching aircraft receives an RA for evasive action in the opposite direction.

Answer: 15-7

Pitch control is exercised by the elevators located on the horizontal stabilizer to change the pitch of the aircraft. Pitch is exercised by moving the control column forward to pitch down (dive) and pulling aft to pitch up (climb). Roll control is provided by ailerons on the outboard section of the trailing edge of the wings and move in opposite directions. Roll is achieved by moving the control column to the right to drop the right wing and to the left to drop the left wing. Yaw control is provided by the rudder on the vertical stabilizer. Pushing the left peddle will yaw the aircraft to the left, while pushing the right pedal will yaw the aircraft to the right. The roll and yaw control are used simultaneously to perform a coordinated turn to change the heading without slipping the tail.

Answer: 15-8

A Fly-By-Wire system replaces the hydro-mechanical flight control system in its entirety with an electrical interface. The movements of the pilot's controls are converted to electrical signals and transmitted by wires to the flight control computers which determine how much to move the actuators at each control surface to provide the expected response. Commands from the flight control computers are input to the actuators without the pilot's intervention in order to stabilize the aircraft during flight.

AC	/	Alternating Current
ACARS	/	Aircraft Communication Addressing and Reporting System
ACE	/	Actuator Control Electronics (flight controls)
A/D	/	Analog-to-Digital
ADC	/	Analog-to-Digital Converter
ADFCS	/	Automatic Digital Flight Control System
ADI	/	Attitude Direction Indicator
ADF	/	Automatic Direction Finder (navigation)
AFCAS	/	Automatic Flight Control Augmentation System
AFDC	/	Automatic Flight Director Computer
AFDX	/	Avionics Full-Duplex Switched Network
AIMS	/	Airplane Information Management System
ALU	/	Arithmetic Logic Unit (computer)
AMLCD	/	Active-Matrix Liquid Crystal Diode
APU	/	Auxiliary Power Unit
ARINC	/	Aeronautical Radio Incorporated
ATC	/	Air Traffic Control
BC	/	Bus Controller
BCD	/	Binary Coded Decimal
BIT	/	Binary Digit
BITE	/	Built-In-Test Equipment
BM	/	Bus Monitor
CDU	/	Control Display Unit
CPM	/	Core Processing Module
CNS	/	Communication, Navigation, and Surveillance
CMOS	/	Complementary Metal Oxide Semiconductor
CPU	/	Central Processing Unit
CRT	/	Cathode Ray Tube
D/A	/	Digital-to-Analog
DAC	/	Digital-to-Analog Converter
DC	/	Direct Current
DIP	/	Dual In-line Package (integrated circuit)
DME	/	Distance Measuring Equipment (navigation)
EADI	/	Electronic Attitude Direction Indicator
EASA	/	European Aviation Safety Agency
ECAM	/	Electronic Centralized Aircraft Monitor
EFIS	/	Electronic Flight Instrument System
EHA	/	Electro-Hydrostatic Actuator (flight controls)
EHSI	/	Electronic Horizontal Situation Indicator
EICAS	/	Engine Indication and Crew Alerting System
EIS	/	Electronic Instrument System
EMC	/	Electro-Magnetic Compatibility
EMI	/	Electro-Magnetic Interference
EMP	/	Electro-Magnetic Pulse
EPR	/	Engine Pressure Ratio
EPROM	/	Erasable Programmable Read-Only Memory

ESD	/	Electro-Static Discharge
EUROCAE	/	European Organization for Civil Aviation Equipment
FAA	/	Federal Aviation Administration
FBW	/	Flu-By-Wire (flight control system)
FCS	/	Flight Control System
FMC	/	Flight Management Computer
FMS	/	Flight Management System
GB	/	Giga-Byte
GHz	/	Giga-Hertz
GPS	/	Global Positioning System (navigation)
HF	/	High Frequency
HIRF	/	High-Intensity Radiated Field
HSI	/	Horizontal Direction Indicator
HW	/	Hardware
KB	/	Kilo-Byte
I/O	/	Input and Output
IC	/	Integrated Circuit
IEEE	/	Institute of Electrical and Electronic Engineers
IFE	/	In-Flight Entertainment
IFR	/	Instrument Flight Rules
ILS	/	Instrument Landing System
IMA	/	Integrated Modular Avionics
IMU	/	Inertial Measuring Unit
INS	/	Inertial Navigation System
IRS	/	Inertial Reference System
ITO	/	Indium Tin Oxide (AMLCD)
LCD	/	Liquid Crystal Display
LED	/	Light Emitting Diode
LRM	/	Line Replaceable Module
LRU	/	Line Replaceable Unit
LSB	/	Least Significant Bit
MAT	/	Maintenance Access Terminal
MB	/	Mega-Byte
Mbps	/	Mega-bits per second
MEMS	/	Micro-Electro-Mechanical System
MFD	/	Multi-Function Display
MSB	/	Most Significant Bit
ND	/	Navigation Display
ONP	/	Operational Flight Program
OOOI	/	Out-of-the-gate, Off-the-ground, On-the-ground, In-the-gate (ACARS)
PCB	/	Printed Circuit Board
PCU	/	Power Control Unit (flight controls)
PFC	/	Primary Flight Computer
PFD	/	Primary Flight Display
PN	/	Positive-Negative (transistor junction)

PROM	/	Programmable Read-Only Memory
RA	/	Resolution Advisory (TCAS)
RAM	/	Random Access memory
RF	/	Radio Frequency
RGB	/	Read, Green, Blue (displays)
RLG	/	Ring-Laser Gyro
ROM	/	Read-Only Memory
RT	/	Remote Terminal
RTCA	/	Radio Technical Commission for Aeronautics
SATCOM	/	Satellite Communications
SELCAL	/	Selective Calling
SMA	/	Sub-Miniature version A (connector)
SW	/	Software
TA	/	Traffic Advisory (TCAS)
TCAS	/	Traffic Alert and Collision Avoidance System
TDR	/	Time Division Multiplexing
TFT	/	Thin-Film Transistor
TMS	/	Thrust Management System
TTL	/	Transistor-Transistor Logic
VHF	/	Very High Frequency
VOR	/	Visual Omnidirectional (navigation)
VOIP	/	Voice-Over-Internet Protocol
XPDR	/	Transponder (surveillance)
XOR	/	EXCLUSIVE OR (gate)

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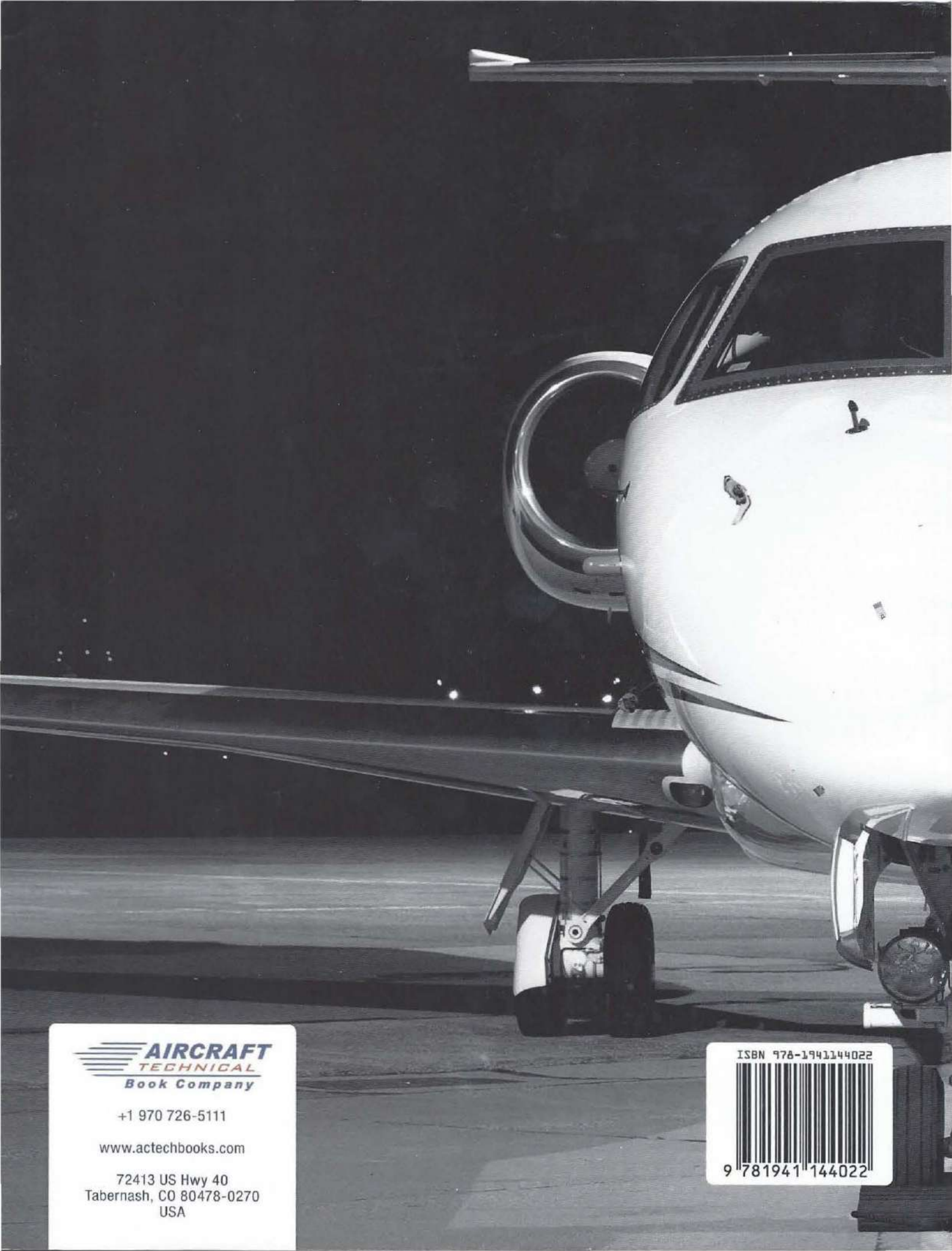
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